

# am<sup>u</sup> CMV4000

## Datasheet

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# CMV4000 Global shutter CMOS image sensor for machine vision

## 1 General description

The CMV4000 is a high sensitivity, pipelined global shutter CMOS image sensor with 2048 x 2048 pixel resolution capable of HD format. Pipelining allows exposure during read out. The state-of-the-art pixel architecture offers true correlated double sampling (CDS) reducing the fixed pattern noise and dark noise significantly. The imager features 16 LVDS channels each running at 480 Mbps resulting in a 180 fps frame rate at full resolution at 10-bit per pixel. A 12-bit mode is available at reduced frame rate. Driving and read-out are programmed over a serial peripheral interface. An internal timing generator produces the signals needed for read-out and exposure control of the image sensor. External exposure triggering remains possible.

### 1.1 Key benefits & features

The benefits and features of CMV4000, Global shutter CMOS image sensor for machine vision are listed below:

Table 1: Added value of using CMV4000

| Benefits  | Features  |
|---|---|
| Freeze moving objects   | Global shutter with excellent parasitic light sensitivity of 1/50000            |
| Track moving objects accurately and high inspection rate                    | High speed 180 fps  |
| Easy HW design  | Pin compatible to CMV2000   |
| Choose between maximum frame rate (10-bit) or better image quality (12-bit) | Selectable ADC resolution   |
| See bright and dark objects at the same time                                | High dynamic range mode with dual exposure and piecewise linear response option |

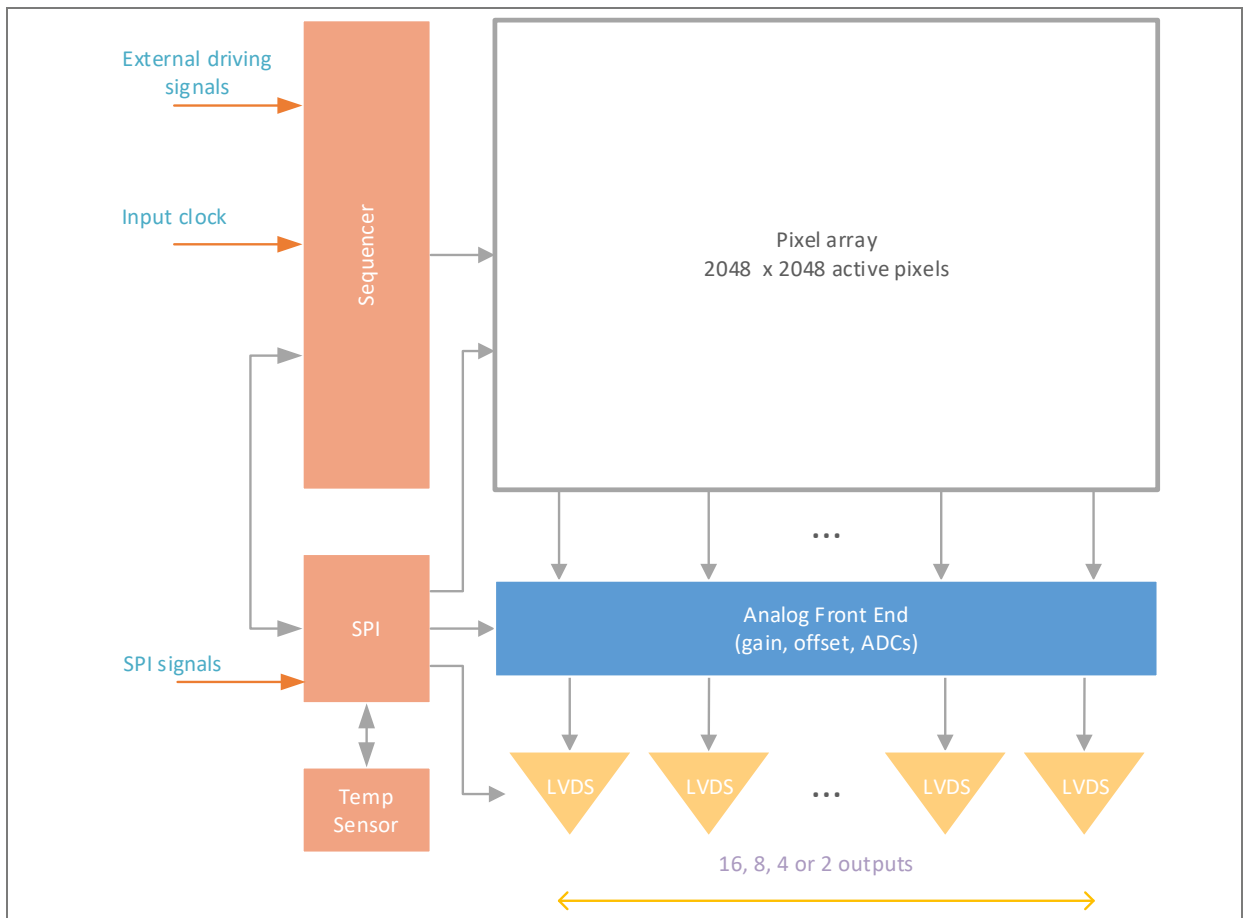
## 1.2 Applications

- Machine Vision
- 3D Imaging
- Motion Capture
- Bar and 2D Code Scanning
- Intelligent traffic systems
- Video and Broadcast
- Biometrics

## 1.3 Block diagram

The functional blocks of this device are shown below:

Figure 1: Functional blocks of CMV4000



## 2 Ordering information

| Product type/Marking | Ordering code | Mono/Color | Glass type      | Package | Delivery quantity |
|----------------------|---------------|------------|-----------------|---------|-------------------|
| CMV4000-2E12M1PP     | Q65114A0013   | Mono       | Plain glass     | PGA     | 40 pcs/tray       |
| CMV4000-2E5M1PA      | Q65114A0020   | Mono       | AR coated       | PGA     | 40 pcs/tray       |
| CMV4000-2E5C1PA      | Q65114A0016   | Color      | AR coated       | PGA     | 40 pcs/tray       |
| CMV4000-2E5C1PP      | Q65114A0017   | Color      | Plain glass     | PGA     | 40 pcs/tray       |
| CMV4000-2E5M1LP      | Q65114A0019   | Mono       | Plain glass     | LGA     | 40 pcs/tray       |
| CMV4000-2E5C1LP      | Q65114A0015   | Color      | Plain glass     | LGA     | 40 pcs/tray       |
| CMV4000-2E5M1PP      | Q65114A0021   | Mono       | Plain glass     | PGA     | 40 pcs/tray       |
| CMV4000-2E12M1LP     | Q65114A0012   | Mono       | Plain glass     | LGA     | 40 pcs/tray       |
| CMV4000-3E12M1LP     | Q65114A0041   | Mono       | Plain glass     | LGA     | 40 pcs/tray       |
| CMV4000-3E12M1PP     | Q65114A0042   | Mono       | Plain glass     | PGA     | 40 pcs/tray       |
| CMV4000-3E5C1CA      | Q65114A0034   | Color      | AR coated       | LCC     | 40 pcs/tray       |
| CMV4000-3E5C1LP      | Q65114A0032   | Color      | Plain glass     | LGA     | 40 pcs/tray       |
| CMV4000-3E5C1PP      | Q65114A0033   | Color      | Plain glass     | PGA     | 40 pcs/tray       |
| CMV4000-3E5M0PN      | Q65114A0035   | Mono       | Removable glass | PGA     | 40 pcs/tray       |
| CMV4000-3E5M1CA      | Q65114A0040   | Mono       | AR coated       | LCC     | 40 pcs/tray       |
| CMV4000-3E5M1LP      | Q65114A0036   | Mono       | Plain glass     | LGA     | 40 pcs/tray       |
| CMV4000-3E5M1PA      | Q65114A0037   | Mono       | AR coated       | PGA     | 40 pcs/tray       |
| CMV4000-3E5M1PN      | Q65114A0038   | Mono       | Removable glass | PGA     | 40 pcs/tray       |
| CMV4000-3E5M1PP      | Q65114A0039   | Mono       | Plain glass     | PGA     | 40 pcs/tray       |

Figure 2: Ordering code information

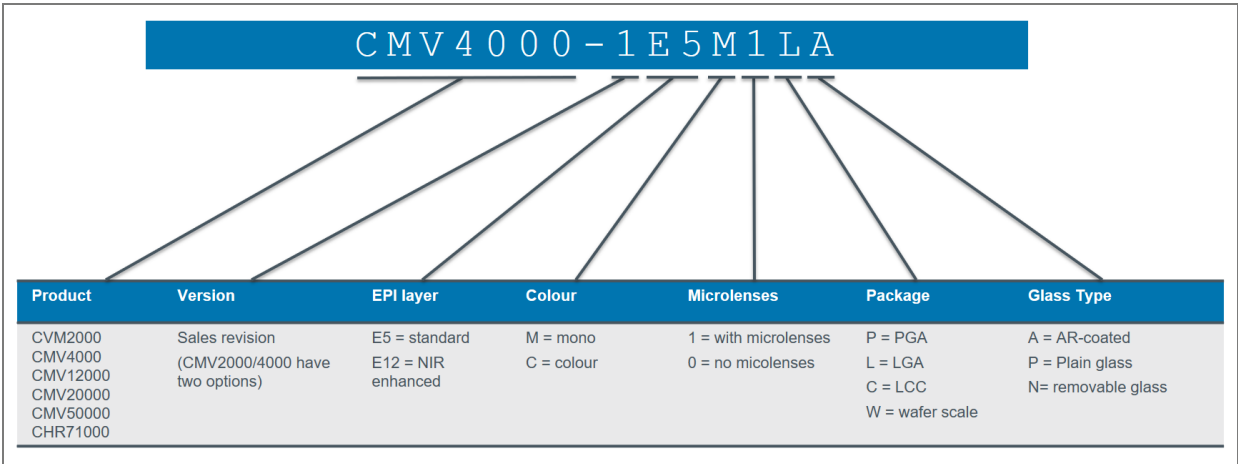


Table 2: Differences between versions

| Topic  | Version2  | Version3   |
|--|---|--|
| PGA  |   | Additional gain steps  |
| Horizontal line effect                                       | There shall not be a line read out when exposure starts   | Horizontal line effect can be avoided by inserting dummy lines at the moment the exposure of the next frame is started.  |
| Black sun effect   | Avoiding effect with reduction of the brightness of light falling on the sensor   | Actively removing effect   |
| Electrical black columns                                     |   | Enable by setting the appropriate SPI register for reducing the row noise.   |
| Register settings  | The registers addresses and contents are different from version to version. See chapter 8 "Register Description". Version 3 has different recommended register settings than version 2. |  |
| Integration in single shot mode                              |   | Improved integration single shot mode to reduce horizontal line artifact.  |
| PRNU pattern   |   | The pattern will only be visible in grey images starting from around 150DN.<br>Correction can be done with applying a gain correction to each column, which compensates the FPN. |
| Column patterns in the non-linear part of the response curve |   | This can be solved by increasing gain to clip the response in its linear part.<br>But setting it too high can cause a drop in saturation value and full well capacity.           |

### 3 Pin out

Pins that are marked as optional are not strictly required for sensor operation, they are test pins or pins that are only needed for using a certain feature. When these pins are not used, they can be left floating.

When all 16 LVDS channels are not used, and the sensor is configured for multiplexing, the unused output channels can also be left floating.

#### 3.1 µPGA and LGA pinout

This is the pin layout as seen from the top.

Table 3: µPGA and LGA pinout

|   | 1              | 2              | 3          | 4           | 5             | 6          | 7           | 8           | 9           | 10          | 11           | 12           |
|---|----------------|----------------|------------|-------------|---------------|------------|-------------|-------------|-------------|-------------|--------------|--------------|
| H | VDD33          | TDIG1          | T_EX<br>P1 | SPI_CL<br>K | SYS_R<br>ES_N | VDD33      | GND         | Vres_L      | Vtf_I3      | COL_P<br>C  | LVDS         | DIO2         |
| G | VDDPI<br>X     | TDIG2          | T_EX<br>P2 | SPI_EN      | CMD_P         | CMD_<br>N  | Tana        | Vtf_I1      | Col_am<br>p | ADC         | Vbgap        | VDDPIX       |
| F | GND            | FRAME_<br>REQ  | SPI_I<br>N | SPI_OU<br>T | CMD_P<br>_INV | Vpch_<br>H | Vres_H      | Vtf_I2      | Col_load    | Ramp        | DIO1         | GND          |
| E | CLK_I<br>N     | VDD33          | GND        | VDD20       | GND           | VDDPI<br>X | VDD20       | VDD20       | GND         | SG_AD<br>C  | Vramp1       | Vramp2       |
| D | LVDS_<br>CLK_P | LVDS_CL<br>K_N | OUT<br>3_N | OUT3_<br>P  | OUT8_<br>N    | OUT8_<br>P | OUT9_N      | OUT9_P      | OUT14_<br>N | OUT14_<br>P | VREF         | REF_AD<br>C  |
| C | GND            | OUT1_N         | OUT<br>1_P | OUT6_<br>N  | OUT6_<br>P    | GND        | VDD20       | OUT11_<br>N | OUT11_<br>P | OUT16_<br>N | OUT16_<br>P  | GND          |
| B | OUTC<br>TR_N   | OUTCTR<br>_P   | OUT<br>4_N | OUT4_<br>P  | OUT7_<br>N    | OUT7_<br>P | OUT10_<br>N | OUT10_<br>P | OUT13_<br>N | OUT13_<br>P | OUTCL<br>K_N | OUTCLK<br>_P |
| A |                | OUT2_N         | OUT<br>2_P | OUT5_<br>N  | OUT5_<br>P    | GND        | VDD20       | OUT12_<br>N | OUT12_<br>P | OUT15_<br>N | OUT15_<br>P  | GND          |





### 3.3 Pining list

The pin list of the CMV4000 can be found below for the  $\mu$ PGA and LCC packages. The pin list for the LGA package is the same as for the  $\mu$ PGA package.

Table 4: Pinout in detail

| $\mu$ PGA | LCC | Pin name  | Description  | Type          |
|-----------|-----|-----------|--|---------------|
| G7        | 60  | Tana      | Test pin for analog signals (optional)                     | Analog output |
| D12       | 42  | REF_ADC   | Reference for ADC testing (decouple with 100 nF to ground) | Bias          |
| E10       | 41  | SG_ADC    | Signal for ADC testing (decouple with 100 nF to ground)    | Bias          |
| E11       | 40  | Vramp1    | Start voltage first ramp (decouple with 100 nF to ground)  | Bias          |
| E12       | 39  | Vramp2    | Start voltage second ramp (decouple with 100 nF to ground) | Bias          |
| F6        | 62  | Vpch_H    | Precharge high voltage (decouple with 100 nF to ground)    | Bias          |
| H8        | 57  | Vres_L    | Reset low voltage (decouple with 100 nF to ground)         | Bias          |
| F8        | 54  | Vtf_I2    | Transfer low voltage 2 (decouple with 100 nF to ground)    | Bias          |
| H9        | 53  | Vtf_I3    | Transfer low voltage 3 (decouple with 100 nF to ground)    | Bias          |
| D11       | 43  | VREF      | Reference for column amps (decouple with 100 nF to ground) | Bias          |
| F9        | 51  | Col_load  | Decouple with 100 nF to ground                             | Bias          |
| G9        | 52  | Col_amp   | Decouple with 100 nF to ground                             | Bias          |
| G6        | 63  | CMD_N     | Decouple with 100 nF to ground                             | Bias          |
| G11       | 45  | Vbgap     | Decouple with 100 nF to ground                             | Bias          |
| H10       | 50  | COL_PC    | Decouple with 100 nF to ground                             | Bias          |
| H11       | 44  | LVDS      | Decouple with 100 nF to ground                             | Bias          |
| G5        | 66  | CMD_P     | Decouple with 100 nF to VDD33                              | Bias          |
| F5        | 65  | CMD_P_INV | Decouple with 100 nF to VDD33                              | Bias          |
| F10       | 48  | ramp      | Decouple with 100 nF to VDD33                              | Bias          |
| G10       | 49  | ADC       | Decouple with 100 nF to VDD33                              | Bias          |
| G8        | 55  | Vtf_I1    | Transfer low voltage 1 (connect to ground)                 | Bias          |
| H5        | 67  | SYS_RES_N | Input pin for sequencer reset                              | Digital input |
| E1        | 80  | CLK_IN    | Master input clock   | Digital input |
| F2        | 76  | FRAME_REQ | Frame request pin  | Digital input |
| G3        | 72  | T_EXP2    | Input pin for external exposure mode (optional)            | Digital input |

| μPGA | LCC  | Pin name   | Description                                     | Type           |
|------|------|------------|---|----------------|
| H3   | 75   | T_EXP1     | Input pin for external exposure mode (optional) | Digital input  |
| G4   | 69   | SPI_EN     | SPI enable input pin                            | Digital input  |
| H4   | 70   | SPI_CLK    | SPI clock input pin                             | Digital input  |
| F3   | 71   | SPI_IN     | SPI data input pin                              | Digital input  |
| F4   | 68   | SPI_OUT    | SPI data output pin                             | Digital output |
| G2   | N.E. | TDIG2      | Test pin for digital signals (optional)         | Digital output |
| H2   | 77   | TDIG1      | Test pin for digital signals (optional)         | Digital output |
| A6   | 8    | GND        | Ground pin                                      | Ground         |
| A12  | 22   | GND        | Ground pin                                      | Ground         |
| C1   | 28   | GND        | Ground pin                                      | Ground         |
| C6   | 38   | GND        | Ground pin                                      | Ground         |
| C12  | 47   | GND        | Ground pin                                      | Ground         |
| E3   | 56   | GND        | Ground pin                                      | Ground         |
| E5   | 64   | GND        | Ground pin                                      | Ground         |
| E9   | 73   | GND        | Ground pin                                      | Ground         |
| F1   | 81   | GND        | Ground pin                                      | Ground         |
| F12  | 87   | GND        | Ground pin                                      | Ground         |
| H7   | 92   | GND        | Ground pin                                      | Ground         |
| D1   | 79   | LVDS_CLK_P | LVDS positive input clock                       | LVDS input     |
| D2   | 78   | LVDS_CLK_N | LVDS negative input clock                       | LVDS input     |
| B11  | 25   | OUTCLK_N   | LVDS negative clock output channel              | LVDS output    |
| B12  | 26   | OUTCLK_P   | LVDS positive clock output channel              | LVDS output    |
| B1   | 2    | OUTCTR_N   | LVDS negative control output channel            | LVDS output    |
| B2   | 3    | OUTCTR_P   | LVDS positive control output channel            | LVDS output    |
| C2   | 4    | OUT1_N     | LVDS negative data output channel 1             | LVDS output    |
| C3   | 5    | OUT1_P     | LVDS positive data output channel 1             | LVDS output    |
| A2   | 6    | OUT2_N     | LVDS negative data output channel 2             | LVDS output    |
| A3   | 7    | OUT2_P     | LVDS positive data output channel 2             | LVDS output    |
| D3   | 91   | OUT3_N     | LVDS negative data output channel 3             | LVDS output    |
| D4   | 90   | OUT3_P     | LVDS positive data output channel 3             | LVDS output    |
| B3   | 89   | OUT4_N     | LVDS negative data output channel 4             | LVDS output    |
| B4   | 88   | OUT4_P     | LVDS positive data output channel 4             | LVDS output    |
| A4   | 10   | OUT5_N     | LVDS negative data output channel 5             | LVDS output    |
| A5   | 11   | OUT5_P     | LVDS positive data output channel 5             | LVDS output    |
| C4   | 86   | OUT6_N     | LVDS negative data output channel 6             | LVDS output    |
| C5   | 85   | OUT6_P     | LVDS positive data output channel 6             | LVDS output    |

| µPGA | LCC                | Pin name | Description                          | Type        |
|------|--------------------|----------|--------------------------------------|-------------|
| B5   | 12                 | OUT7_N   | LVDS negative data output channel 7  | LVDS output |
| B6   | 13                 | OUT7_P   | LVDS positive data output channel 7  | LVDS output |
| D5   | 83                 | OUT8_N   | LVDS negative data output channel 8  | LVDS output |
| D6   | 82                 | OUT8_P   | LVDS positive data output channel 8  | LVDS output |
| D7   | 36                 | OUT9_N   | LVDS negative data output channel 9  | LVDS output |
| D8   | 35                 | OUT9_P   | LVDS positive data output channel 9  | LVDS output |
| B7   | 15                 | OUT10_N  | LVDS negative data output channel 10 | LVDS output |
| B8   | 16                 | OUT10_P  | LVDS positive data output channel 10 | LVDS output |
| C8   | 17                 | OUT11_N  | LVDS negative data output channel 11 | LVDS output |
| C9   | 18                 | OUT11_P  | LVDS positive data output channel 11 | LVDS output |
| A8   | 34                 | OUT12_N  | LVDS negative data output channel 12 | LVDS output |
| A9   | 33                 | OUT12_P  | LVDS positive data output channel 12 | LVDS output |
| B9   | 19                 | OUT13_N  | LVDS negative data output channel 13 | LVDS output |
| B10  | 20                 | OUT13_P  | LVDS positive data output channel 13 | LVDS output |
| D9   | 32                 | OUT14_N  | LVDS negative data output channel 14 | LVDS output |
| D10  | 31                 | OUT14_P  | LVDS positive data output channel 14 | LVDS output |
| A10  | 30                 | OUT15_N  | LVDS negative data output channel 15 | LVDS output |
| A11  | 29                 | OUT15_P  | LVDS positive data output channel 15 | LVDS output |
| C10  | 23                 | OUT16_N  | LVDS negative data output channel 16 | LVDS output |
| C11  | 24                 | OUT16_P  | LVDS positive data output channel 16 | LVDS output |
| A7   | 9                  | VDD20    | 2.1 V supply                         | Supply      |
| C7   | 21                 | VDD20    | 2.1 V supply                         | Supply      |
| E4   | 37                 | VDD20    | 2.1 V supply                         | Supply      |
| E7   | 59                 | VDD20    | 2.1 V supply                         | Supply      |
| E8   | 84                 | VDD20    | 2.1 V supply                         | Supply      |
| E6   | 14                 | VDDPIX   | 3.0 V supply                         | Supply      |
| G1   | 46                 | VDDPIX   | 3.0 V supply                         | Supply      |
| G12  | 74                 | VDDPIX   | 3.0 V supply                         | Supply      |
| F7   | 58                 | Vres_H   | 3.3 V supply                         | Supply      |
| E2   | 1                  | VDD33    | 3.3 V supply                         | Supply      |
| H1   | 27                 | VDD33    | 3.3 V supply                         | Supply      |
| H6   | 61                 | VDD33    | 3.3 V supply                         | Supply      |
| F11  | N.E <sup>(1)</sup> | DIO1     | Diode 1 for test (not connected)     | Test        |
| H12  | N.E <sup>(1)</sup> | DIO2     | Diode 2 for test (not connected)     | Test        |

(1) Not equipped.

## 4 Absolute maximum ratings

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under “Operating Conditions” is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 5: Absolute maximum ratings of CMV4000

| Symbol  | Parameter                          | Min | Max | Unit | Comments           |
|---|------------------------------------|-----|-----|------|--------------------|
| <b>Electrical Parameters</b>  |                                    |     |     |      |                    |
| VDD20   | Digital supply LVDS, ADC           | 2.0 | 2.2 | V    |                    |
| VDD33   | Analog supply ADC, PGA             | 3.0 | 3.6 | V    |                    |
| VDDPIX  | Analog pixel supply                | 2.3 | 3.6 | V    |                    |
| Vres_h  | Analog pixel reset supply          | 3.0 | 3.6 | V    |                    |
| <b>Continuous power dissipation (<math>T_A = 70\text{ °C}</math>)</b> |                                    |     |     |      |                    |
| P <sub>T</sub>  | Continuous power dissipation       |     | 4.2 | W    | At max. frame rate |
| <b>Electrostatic Discharge</b>  |                                    |     |     |      |                    |
| ESD <sub>HBM</sub>  | Electrostatic discharge HBM        | ± 2 |     | kV   | JS-001-2014        |
| <b>Temperature ranges and storage conditions</b>                      |                                    |     |     |      |                    |
| T <sub>J</sub>  | Operating junction temperature     | -30 | 70  | °C   |                    |
| T <sub>STRG</sub>   | Storage temperature range          | 20  | 40  | °C   |                    |
| RH <sub>NC</sub>  | Relative humidity (non-condensing) | 30  | 60  | %    |                    |

## 5 Electrical characteristics

All limits are guaranteed. The parameters with Min and Max values are guaranteed with production tests or SQC (Statistical Quality Control) methods.

Table 6: Electrical characteristics of CMV4000

| Symbol                         | Parameter                 | Conditions                             | Min  | Typ | Max   | Unit |
|--------------------------------|---------------------------|--|------|-----|-------|------|
| <b>Power supplies</b>          |                           |  |      |     |       |      |
| VDD20                          | Digital supply LVDS, ADC  | Version2                               | 2.05 | 2.1 | 2.15  | V    |
|                                |                           | Version3                               | 2.0  | 2.0 | 2.15  | V    |
| VDD33                          | Analog supply ADC, PGA    |  | 3.2  | 3.3 | 3.4   | V    |
| VDDPIX                         | Analog pixel supply       |  | 2.9  | 3.0 | 3.1   | V    |
| Vres_h                         | Analog pixel reset supply |  | 3.2  | 3.3 | 3.4   | V    |
| IDD20                          | Supply current            | Readout @ Version2                     |      | 380 |       | mA   |
|                                |                           | Readout @ Version3                     |      | 360 |       | mA   |
| IDD33                          | Supply current            | Readout @ Version2                     |      | 65  |       | mA   |
|                                |                           | Readout @ Version3                     |      | 90  |       | mA   |
| IDDPIX                         | Supply current            | Readout @ Version2                     |      | 20  |       | mA   |
|                                |                           | Readout @ Version3                     |      | 20  |       | mA   |
| Ires_h                         | Supply current            | Readout                                |      | 15  |       | mA   |
| P20                            | Power consumption         | Version2                               |      | 790 |       | mW   |
|                                |                           | Version3                               |      | 750 |       | mW   |
| P33                            | Power consumption         | Version2                               |      | 220 |       | mW   |
|                                |                           | Version3                               |      | 300 |       | mW   |
| PPIX                           | Power consumption         |  |      | 60  |       | mW   |
| Pres_h                         | Power consumption         |  |      | 50  |       | mW   |
| <b>Digital I/O CMOS/TTL DC</b> |                           |  |      |     |       |      |
| V <sub>IH</sub>                | High level input voltage  |  | 2.0  |     | VDD33 | V    |
| V <sub>IL</sub>                | Low level input voltage   |  | GND  |     | 0.8   | V    |
| V <sub>OH</sub>                | High level output voltage | VDD = 3.3 V<br>I <sub>OH</sub> = -2 mA | 2.4  |     |       | V    |
| V <sub>OL</sub>                | Low level output voltage  | VDD = 3.3 V<br>I <sub>OH</sub> = -2 mA |      |     | 0.4   | V    |
| C <sub>i</sub>                 | Input load                |  |      |     | 2     | pF   |
| C <sub>o</sub>                 | Output load               |  |      |     | 2     | pF   |
| f <sub>CLK_IN</sub>            | CLK_IN frequency          |  | 5    |     | 48    | MHz  |

| Symbol  | Parameter  | Conditions  | Min  | Typ  | Max  | Unit    |
|---|--|---|------|------|------|---------|
| <b>TIA/EIA-644A LVDS - driver specifications (OUTX_N/P, OUTCLK_N/P, OUTCTR_N/P)</b> |  |   |      |      |      |         |
| $V_{OD}$  | Differential output voltage                                | Steady State, $R_L = 100\ \Omega$                                       | 247  | 350  | 454  | mV      |
| $\Delta V_{OD}$   | Difference in $V_{OD}$ between complementary output states | Steady State, $R_L = 100\ \Omega$                                       |      |      | 50   | mV      |
| $V_{OC}^{(1)}$  | Common mode voltage  | Steady State, $R_L = 100\ \Omega$                                       | 1.26 | 1.37 | 1.50 | V       |
| $\Delta V_{OC}$   | Difference in $V_{OC}$ between complementary output states | Steady State, $R_L = 100\ \Omega$                                       |      |      | 50   | mV      |
| $I_{OS,GND}$  | Output short circuit current to ground                     | $V_{OUTP} = V_{OUTN} = GND$   |      |      | 24   | mA      |
| $I_{OS,PN}$   | Output short circuit current                               | $V_{OUTP} = V_{OUTN}$   |      |      | 12   | mA      |
| <b>TIA/EIA-644A LVDS-receiver specifications (LVDS_CLK_N/P)</b>                     |  |   |      |      |      |         |
| $V_{ID}$  | Differential input voltage                                 | Steady state  | 100  | 350  | 600  | mV      |
| $V_{IC}$  | Receiver input range                                       | Steady state  | 0.0  |      | 2.4  | V       |
| $I_{ID}$  | Receiver input current                                     | $V_{INP INN} = 1.2\ V \pm 50\ mV$ ,<br>$0 \leq V_{INP INN} \leq 2.4\ V$ |      |      | 20   | $\mu A$ |
| $\Delta I_{ID}$   | Receiver input current difference                          | $ I_{INP} - I_{INN} $   |      |      | 6    | $\mu A$ |
| <b>Timing</b>   |  |   |      |      |      |         |
| CLK_IN  |  |   | 5    |      | 48   | MHz     |
| LVDS_CLK_N/P  |  |   | 50   |      | 480  | MHz     |
| SPI_CLK   |  |   |      |      | 48   | MHz     |

(1)  $V_{oc}$  is dependent on the 2.1 V supply voltage; therefore, these values differ from the TIA/EIA-644A spec.

## 6 Specification overview

Below are the typical electro-optical specifications of CMV4000. These are typical values with typical supplies at room temperature.

Table 7: Electro-optical characteristics

| Specification                                       | Value   | Comment   |
|---|---|---|
| Effective pixels                                    | 2048 x 2048                                       |   |
| Pixel pitch   | 5.5 x 5.5 $\mu\text{m}^2$                         |   |
| Optical format                                      | 1"  |   |
| Full well charge                                    | 13.5 ke <sup>-</sup>                              | Pinned photodiode pixel   |
| Conversion gain                                     | 0.075 LSB/e <sup>-</sup>                          | 10-bit mode, unity gain   |
| Sensitivity   | 5.56 V/lux.s<br>0.27 A/W                          | With microlenses @ 550 nm   |
| Temporal noise (analog domain)                      | 13 e <sup>-</sup>                                 | Pipelined global shutter (GS) with correlated double sampling (CDS). Read noise   |
| Dynamic range                                       | 60 dB   |   |
| Pixel type  | Global shutter pixel                              | Allows fixed pattern noise correction and reset (KTC) noise canceling through correlated double sampling.                     |
| Shutter type  | Pipelined global shutter                          | Exposure of next image during read-out of the previous image.   |
| Parasitic light sensitivity -<br>Shutter efficiency | <1/50 000<br>>99.998%                             |   |
| Color filters                                       | Optional  | RGB Bayer pattern   |
| Micro lenses  | Yes   |   |
| Fill factor   | 42%   | W/o micro lens  |
| QE * FF   | 60%   | @ 550 nm with micro lenses.   |
| Dark current signal                                 | 125 e <sup>-</sup> /s                             | @ 25°C die temperature. The dark current doubles with every 6.5 °C increase   |
| DSNU  | 3 LSB/s   | 10-bit mode   |
| Fixed pattern noise                                 | <1 LSB RMS  | <0.1% of full swing, 10-bit mode  |
| PRNU  | <1% RMS of signal                                 |   |
| LVDS Output channel                                 | 16  | Each data output running @ 480 Mbit/s.<br>8, 4 and 2 outputs selectable at reduced frame rate                                 |
| Frame rate  | 180 frames/s                                      | Using a 10 bit/pixel and 480 Mbit/s LVDS.<br>Higher frame rate possible in row windowing mode.                                |
| Timing generation                                   | On-chip   | Possibility to control exposure time through external pin.  |
| PGA   | Yes   | 4 analog gain settings  |
| Programmable registers                              | Sensor parameters                                 | Window coordinates, Timing parameters, Gain & offset, Exposure time, flipped read-out in X and Y direction ...                |
| Supported HDR modes                                 | Multi-frame read-out with different exposure time | Successive frames are read out with increasing exposure times. The final image is a combination (externally) of these frames. |



| Specification    | Value                            | Comment   |
|------------------|----------------------------------|---|
|                  | Interleaved integration times    | Interleaved exposure times for different rows: Odd rows (double rows for color) have a different exposure compared to even rows (double rows for color). Final image is a combination of the two (through interpolation). |
|                  | Piecewise linear response        | Response curve with two knee points.  |
| ADC              | 10-bit/12-bit                    | Column ADC  |
| Interface        | LVDS                             | Serial output data + synchronization signals  |
| I/O logic levels | LVDS = 1.8 V<br>Dig. I/O = 3.3 V |   |
| Supply voltages  | 2.0 V                            | LVDS, ADC   |
|                  | 3.0 V                            | Pixel array supply  |
|                  | 3.3 V                            | Dig. I/O, SPI, PGA  |
| Clock inputs     | CLK_IN                           | Between 5 and 48 MHz  |
|                  | LVDS_CLK_N/P                     | Between 50 and 480 MHz, LVDS  |
|                  | SPI_CLK                          | Max. 48 MHz   |
| Power            | 550 mW to 1200 mW                | Actual wattage is dependent on the used configuration   |
| Package          | Custom ceramic package           | µPGA (95 pins)  |
|                  |                                  | LGA (95 pins)   |
|                  |                                  | LCC (92 pins)   |
| Operating range  | -30 °C to 70 °C                  | Dark current and noise performance will degrade at higher temperature   |
| Cover glass      | D263                             | Plain or AR glass, no IR cut-off filter on color devices  |
| ESD              | Class 1A HBM                     |   |
|                  | Class 4C CDM                     |   |
| RoHS             | Compliant                        |   |

## 6.1 Spectral characteristics

The cover glass of the CMV4000 is plain D263 glass with a transmittance as shown in Figure 4. Refraction index of the glass is 1.52.

When a color sensor is used an IR-cutoff filter should be placed in the optical path of the sensor.

Figure 4: Transmittance curve offer D263 cover plain glass

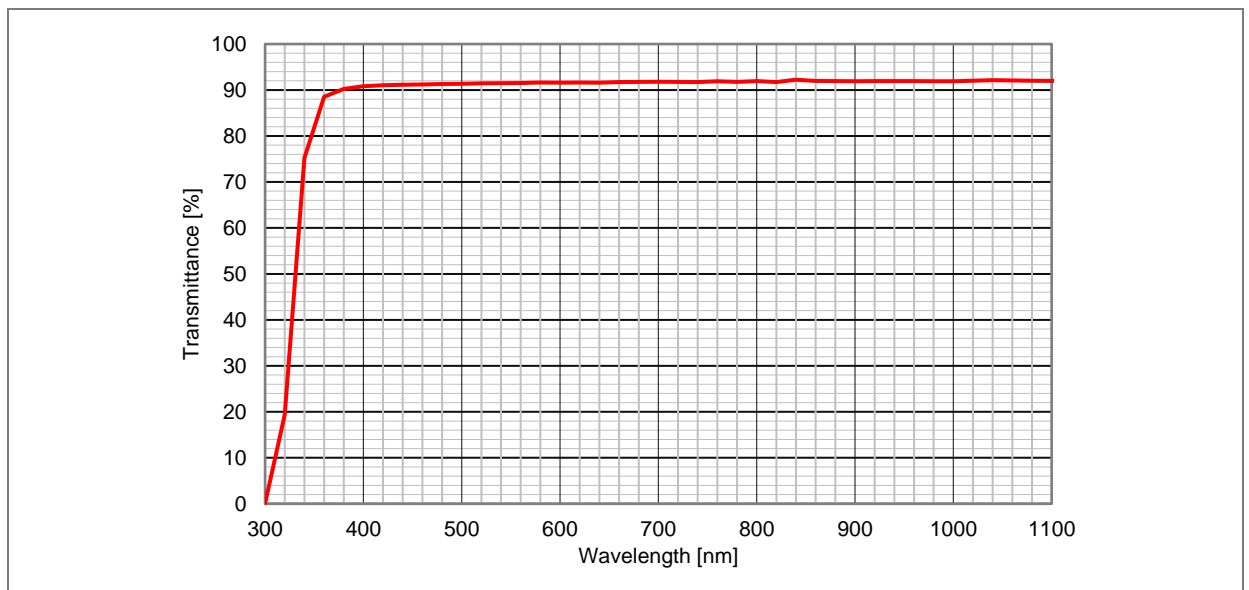
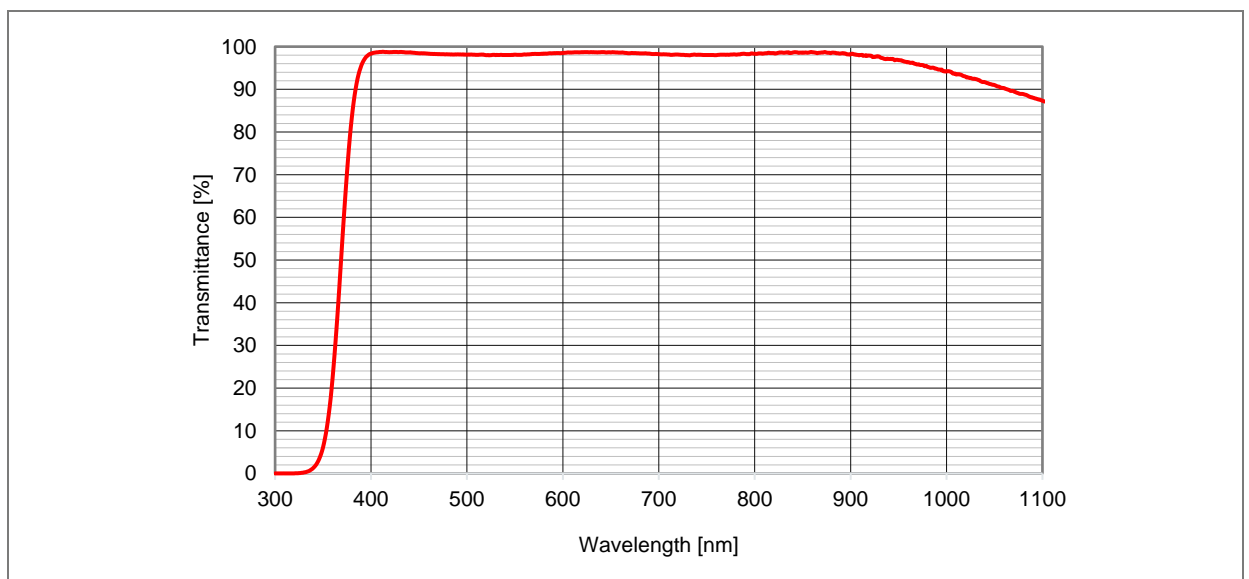
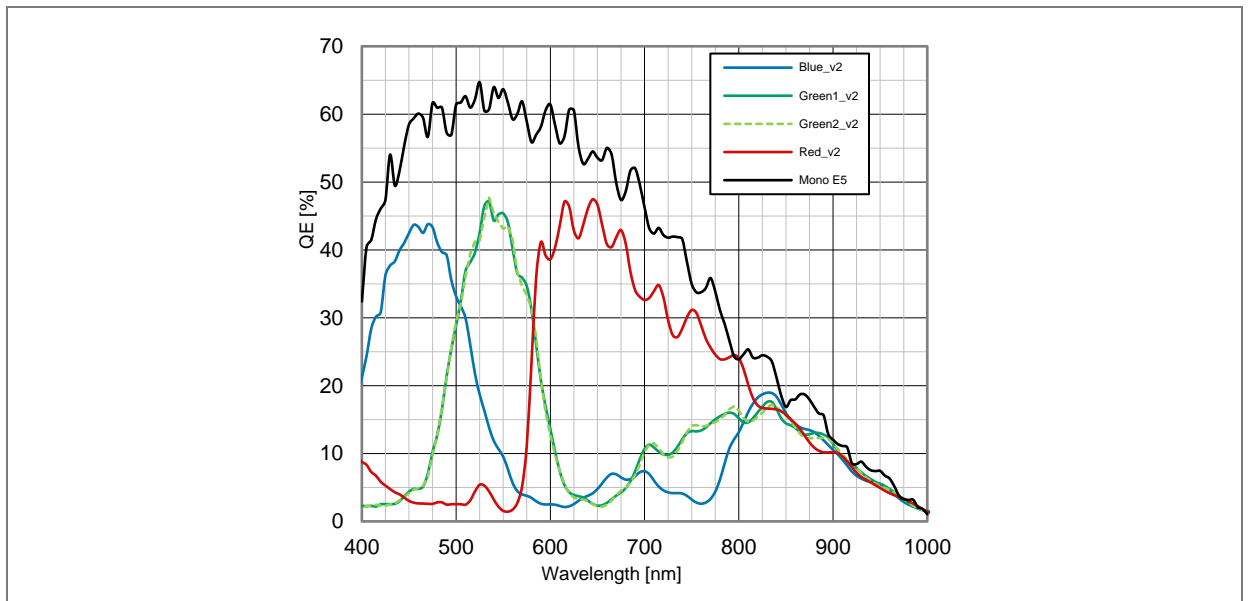


Figure 5: Transmittance curve for D263 AR coated glass



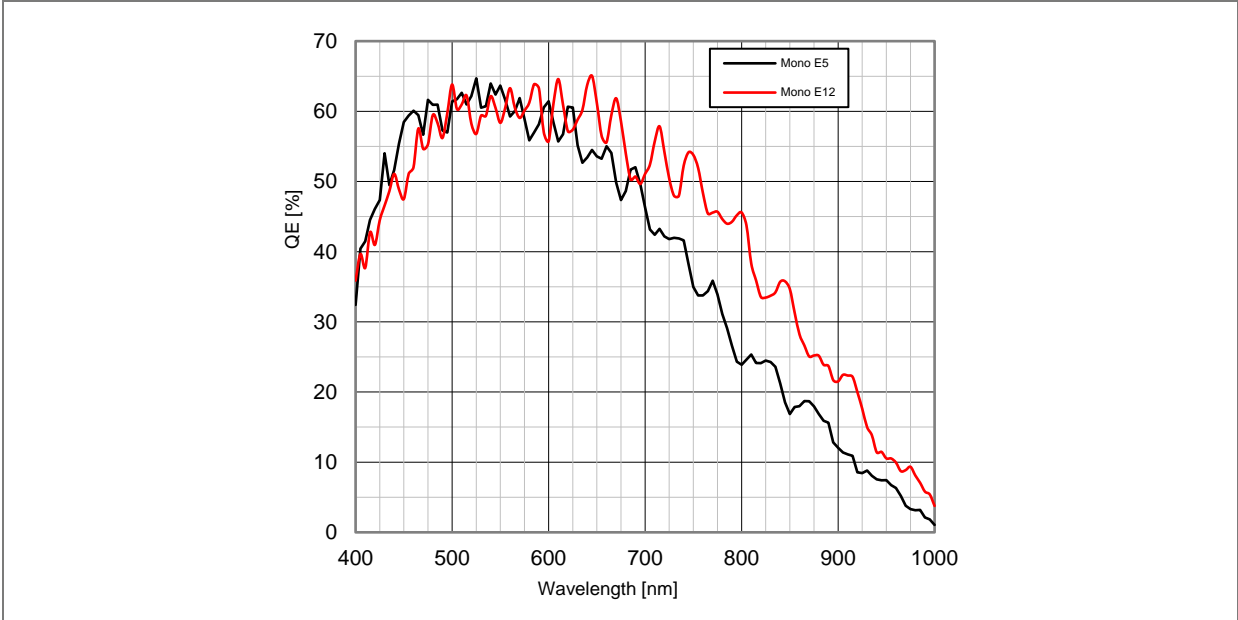
When a color version of the CMV4000 is used, the color filters are applied in a Bayer pattern. The color version of the CMV4000 always has microlenses. The typical spectral response of the CMV with color filters and D263 cover glass is shown in Figure 10. The use of an IR cut-off filter in the optical path of the CMV4000 image sensor is necessary to obtain good color separation when using light with an NIR component. The typical spectral response of a monochrome CMV4000 with microlenses can be found in Figure 10 as well.

Figure 6: Typical spectral response of CMV4000 with RGB color filters and D263 cover glass



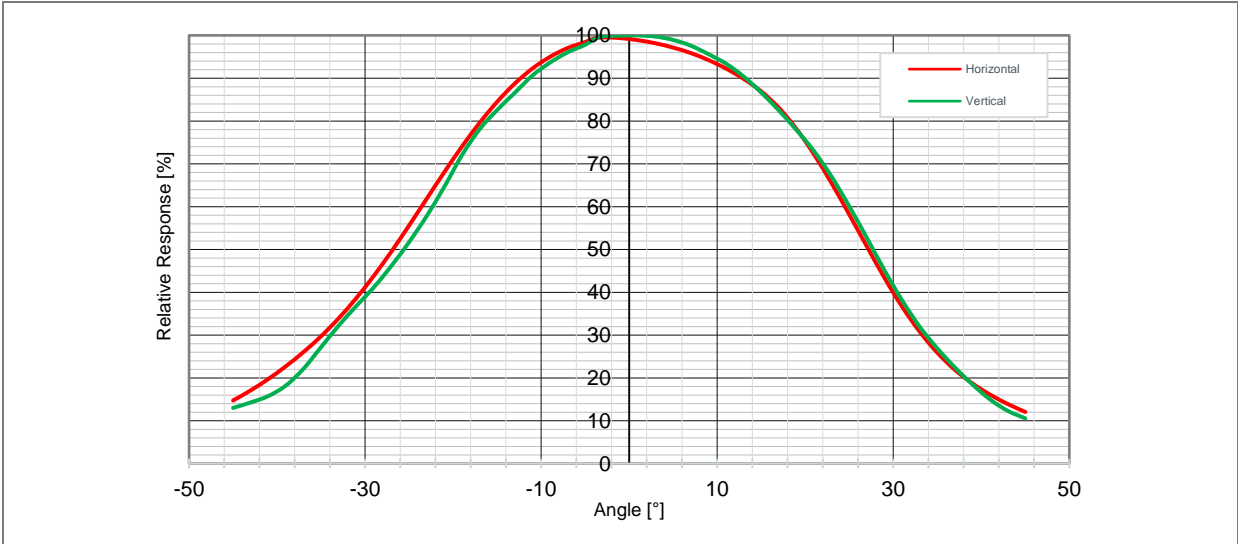
A variation from the standard CMV4000 image sensors is processed on 12  $\mu\text{m}$  epi (E12) Si wafers. The thicker epi-layer wafer starting material increases significantly the QE for wavelengths above 600 nm. Around 900 nm the QE is about doubled and increases from 8% to 16%. This is shown in Figure 7.

Figure 7: Response of E12 devices and normal devices



The typical angular response for a CMV4000 sensor can be seen in Figure 8. The data includes the horizontal and vertical angles.

Figure 8: Horizontal and vertical angular response



## 7 Functional description

### 7.1 Sensor architecture

Figure 1 shows the image sensor architecture. The internal sequencer generates the necessary signals for image acquisition. The image is stored in the pixel (global shutter) and is then read out sequentially, row-by-row. On the pixel output, an analog gain is possible. The pixel values then pass to a column ADC cell, in which ADC conversion is performed. The digital signals are then read out over multiple LVDS channels. Each LVDS channel reads out 128 adjacent columns of the array. In the Y-direction, rows of interest are selected through a row-decoder which allows a flexible windowing. Control registers are foreseen for the programming of the sensor. These register parameters are uploaded via a four-wire SPI interface. A temperature sensor which can be read out over the SPI interface is also included.

#### 7.1.1 Pixel array

The pixel array consists of 2048 x 2048 square global shutter pixels with a pitch of 5.5  $\mu\text{m}$  (5.5  $\mu\text{m}$  x 5.5  $\mu\text{m}$ ). This results in an optical area of close to 1 optical inch (16 mm). This means that off-the-shelf C-mount lenses can be used.

The pixels are designed to achieve maximum sensitivity with low noise and low PLS specifications. Micro lenses are placed on top of the pixels for improved fill factor and quantum efficiency (>50%).

#### 7.1.2 Analog front end

The analog front end consists of 2 major parts, a column amplifier block and a column ADC block.

The column amplifier prepares the pixel signal for the column ADC and applies analog gain if desired (programmable using the SPI interface). The column ADC converts the analog pixel value to a 10-bit or 12-bit value. A digital offset can also be applied to the output of the column ADC's. All gain and offset settings can be programmed using the SPI interface.

### 7.1.3 LVDS block

The LVDS block converts the digital data coming from the column ADC into standard serial LVDS data running at maximum 480 Mbps. The sensor has 18 LVDS output pairs:

- 16 Data channels
- 1 Control channel
- 1 Clock channel

The 16 data channels are used to transfer 10-bit or 12-bit data words from sensor to receiver. The output clock channel transports a DDR clock, synchronous to the data on the other LVDS channels. This clock can be used at the receiving end to sample the data. The data on the control channel contains status information on the validity of the data on the data channels, among other useful sensor status information. Details on the LVDS timing can be found in chapter 7.3 of this document.

LVDS requires parallel termination at the receiver side. So between LVDS\_CLK\_P (pin D1) and LVDS\_CLK\_N (pin D2) should be an external 100  $\Omega$  resistor. Also, all the LVDS outputs should all be externally terminated at the receiver side. See the TIA/EIA-644A standard for details.

### 7.1.4 Sequencer

The on-chip sequencer will generate all required control signals to operate the sensor from only a few external control clocks. This sequencer can be activated and programmed through the SPI interface. A detailed description of the SPI registers and sensor (sequencer) programming can be found in chapter 7.4 of this document.

### 7.1.5 SPI interface

The SPI interface is used to load the sequencer registers with data. The data in these registers are used by the sequencer while driving and reading out the image sensor. Features like windowing, subsampling, gain and offset are programmed using this interface. The data in the on-chip registers can also be read back for test and debug of the surrounding system. Chapter 7.2.8 contains more details on SPI programming and timing.

### 7.1.6 Temperature sensor

A 16-bit digital temperature sensor is included in the image sensor and can be controlled by the SPI-interface. The on-chip temperature can be obtained by reading out the registers with address 126 and 127 (in burst mode, see chapter 7.2.8.2 for more details on this mode).

A calibration of the temperature sensor is needed for absolute temperature measurements per device because the offset differs from device to device. The temperature sensor requires a running input clock (CLK\_IN), the other functions of the image sensor can be operational or in standby mode. The output value of the sensor is dependent on the input clock. A typical temperature sensor output vs. temperature curve at 40 MHz can be found in Figure 9. The die temperature will be about 10 °C~15 °C higher than ambient temperature. The ceramic package has about the same temperature as the die.

The typical (offset) value of the temperature sensor at 0 °C would be:  $1000 * (f \text{ [MHz]})/40 \text{ DN}$ . This offset can differ per device. A typical slope would be around  $0.3 * 40/f \text{ [MHz]} \text{ } ^\circ\text{C/DN}$ .

Figure 9: Typical output of the temperature sensor of the CMV4000

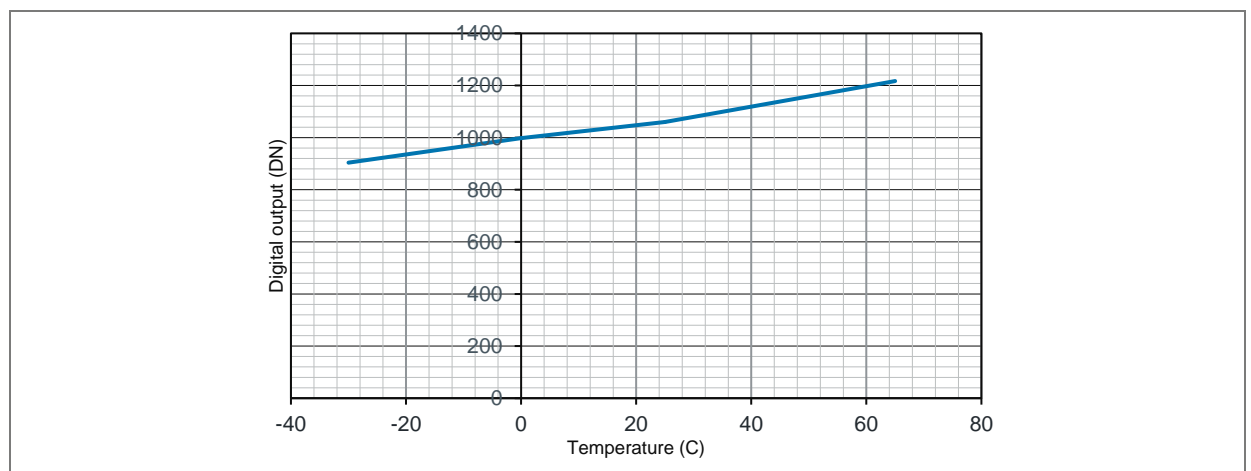
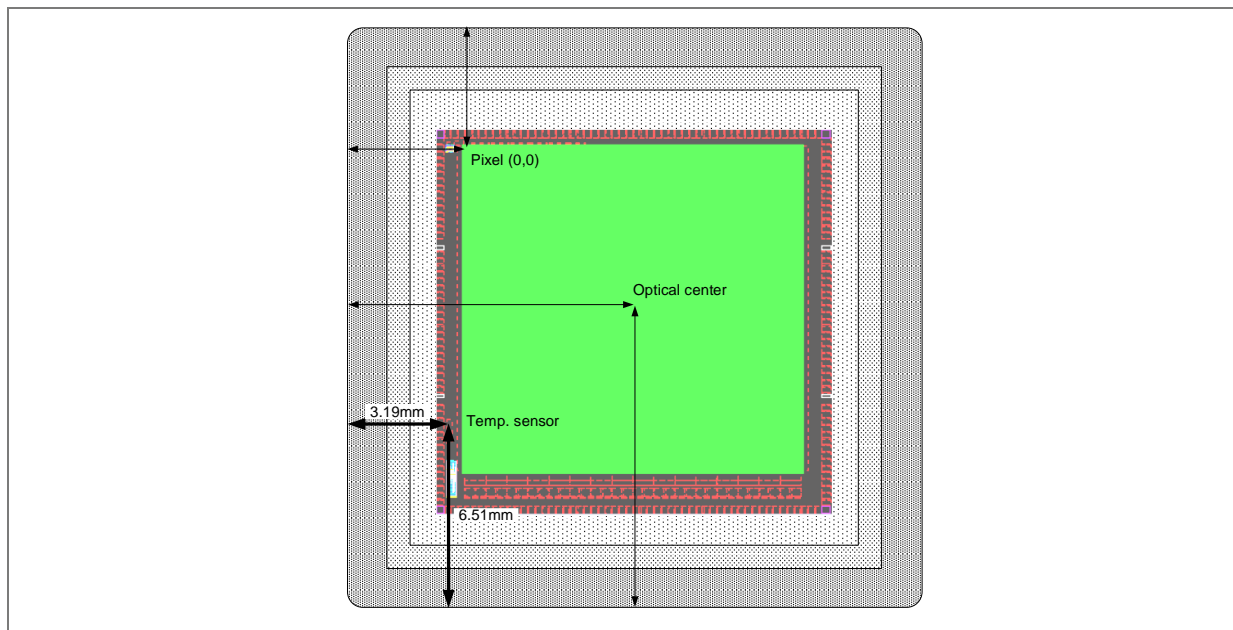


Figure 10: Location of the temperature sensor





## 7.2 Operating the sensor

This section explains how to connect and power the sensor, as well as basic recipes of how to configure the sensor in a certain operation mode.

### 7.2.1 Power supplies

To power the sensor, eight externally generated supplies are required as listed in Table 10.

Table 8: Different power supplies

| Supply name | Usage                    | Description               |
|-------------|--------------------------|---------------------------|
| VDD20       | LVDS, ADC                | Digital supply            |
| VDD33       | Dig. I/O, PGA, SPI, ADC  | Analog supply             |
| VDDPIX      | Pixel array power supply | Analog pixel supply       |
| Vres_h      | Pixel reset pulse        | Analog pixel reset supply |

The power figures are measured at 48 MHz CLK\_IN speed in 16 channels mode while constantly grabbing images. When idle, the sensor will consume about 30% less energy. Reducing the amount of output channels will reduce power consumption of the VDD20 supply and will have the biggest impact on the power consumption.

The recommended values for the different power supplies are shown in Table 10.

All variations on the VDD33 and VDDPIX can contribute to variations (noise) on the analog pixel signal, which is seen as noise in the image. During the camera design, precautions have to be taken to supply the sensor with very stable supply voltages to avoid this additional noise.

Because of the peak currents, decoupling is advised. Place large decoupling capacitors directly at the output of the voltage regulator to filter low noise and improve peak current supply. We advise 1x 330  $\mu$ F electrolytic, 1x 33  $\mu$ F tantalum and a 10  $\mu$ F ceramic capacitor per supply, directly at the output of the regulator.

Place small decoupling capacitors as close as possible to the sensor between supply pins and ground. We advise 1x 4.7  $\mu$ F and 1x 100 nF ceramic capacitor per power supply pin (see pin list) and 1x 100  $\mu$ F ceramic capacitor per power supply plane (VDD20, VDDPIX, VDD33). Vres\_h does not need a 100  $\mu$ F capacitor. See pin list for exact pin numbers for every supply. Analog and digital ground can be tied together.

### 7.2.2 Biasing

For optimal performance, some pins need to be decoupled to ground or to VDD. Please refer to the pin list for a detailed description for every pin and the appropriate decoupling if applicable.

### 7.2.3 Digital input pins

Table 9 gives an overview of the external pins used to drive the sensor. The digital signals are sampled on the rising edge of the CLK\_IN, therefore the length of the signal applied to an input should be at least 1 CLK\_IN period to assure it has been detected. All digital I/O's have a capacitance of 2 pF max.

Table 9: Digital input pins description

| Pin name     | Description   |
|--------------|---|
| CLK_IN       | Master input clock, frequency range between 5 and 48 MHz.   |
| LVDS_CLK_N/P | High speed LVDS input clock, frequency range between 50 and 480 MHz.  |
| SYS_RES_N    | System reset pin, active low signal. Resets the on-board sequencer and must be kept low during start-up. This signal should be at least one period of CLK_IN long to assure detection on the rising edge of CLK_IN.                         |
| FRAME_REQ    | Frame request pin. When a high level is detected on this pin the programmed number of frames is captured and sent by the sensor. This signal should be at least one period of CLK_IN long to assure detection on the rising edge of CLK_IN. |
| SPI_IN       | Data input pin for the SPI interface. The data to program the image sensor is sent over this pin.   |
| SPI_EN       | SPI enable pin. When this pin is high the data should be written/read on the SPI.   |
| SPI_CLK      | SPI clock. This is the clock on which the SPI runs.   |
| T_EXP1       | Input pin to program the exposure time externally. Optional   |
| T_EXP2       | Input pin to program the exposure time externally in HDR mode. Optional   |

7.2.4 Input clock

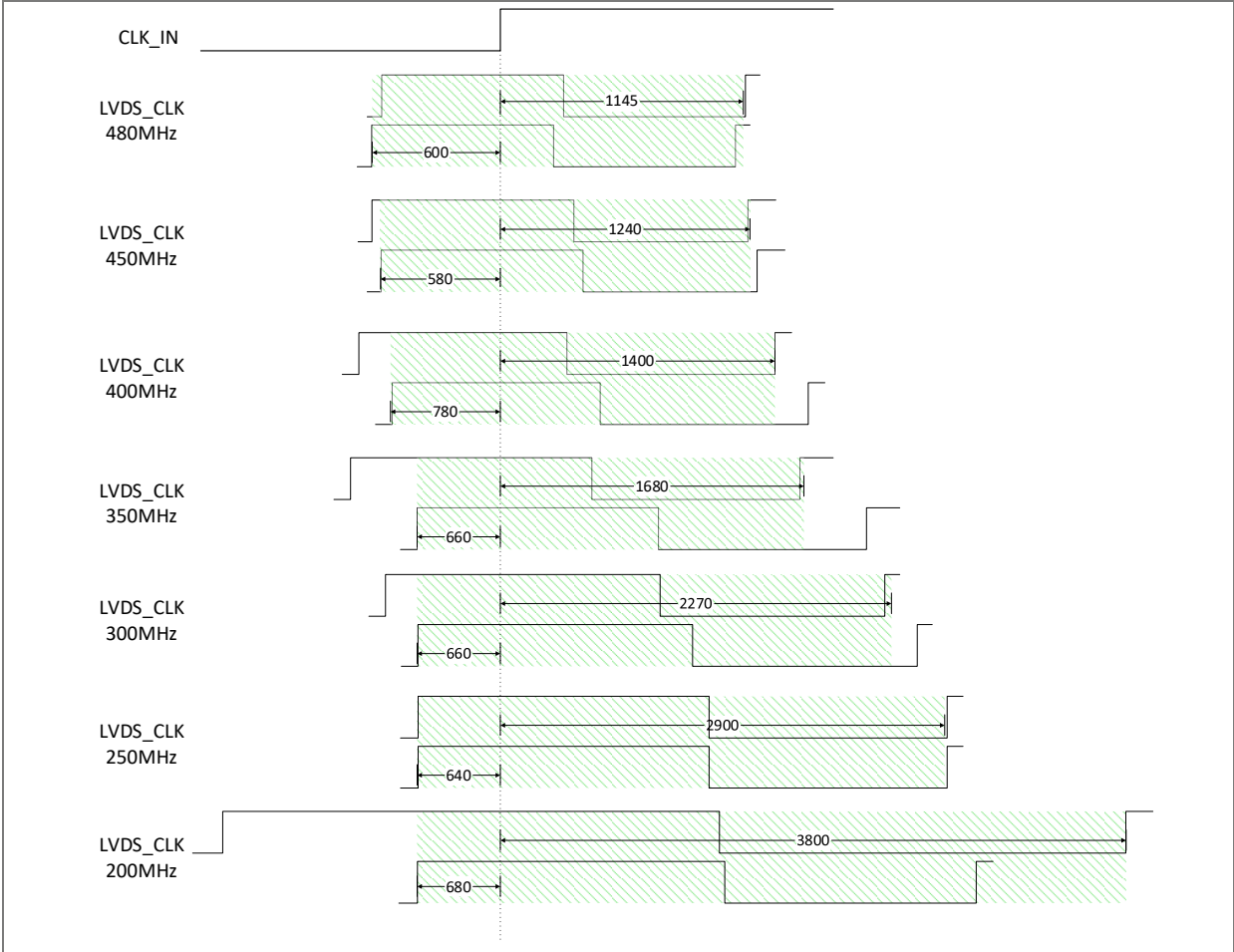
The high-speed LVDS input clock (LVDS\_CLK\_N/P) defines the output data rate of the CMV4000. The master clock (CLK\_IN) must be 10 or 12 times slower depending on the programmed bit mode setting. The maximum data rate of the output is 480 Mbps which results in a LVDS\_CLK\_N/P of 480 MHz and a CLK\_IN of 48 MHz in 10-bit mode and 40 MHz in 12-bit mode. The minimum frequencies are 5 MHz for CLK\_IN and 50 MHz for LVDS\_CLK\_N/P. Any frequency between the minimum and maximum can be applied by the user and will result in a corresponding output data rate, like shown in Table 10.

Table 10: Output data rate depending on the CLK\_IN and bit mode

| CLK_IN | LVDS_CLK 10-bit | LVDS_CLK 12-bit |
|--------|-----------------|-----------------|
| 5 MHz  | 50 MHz          | 60 MHz          |
| 40 MHz | 400 MHz         | 480 MHz         |
| 48 MHz | 480 MHz         | N/A             |

For the version 2 of the image sensor, the rising edge LVDS input clock can have a limited delay with respect to the rising edge of the master input clock, depending on clock speed. In Figure 11, the skew limits are shown for different clock speeds and for an LVDS clock that rises before and after the master input clock. To assure proper working of the sensor, the skew of the LVDS clock should always fall within these limits, shown as the green area.

Figure 11: LVDS clock delay versus master clock – applicable for V2 of the sensor



### 7.2.5 Frame rate calculation

The frame rate is defined by 2 main factors:

- Exposure time
- Read-out time

To simplify the calculation, we will assume that the exposure time is shorter than the read-out time and that the sensor is operating at default settings, taking a full resolution 10-bit image at 48 MHz through 16 outputs. This means that the frame rate will be defined only by the read-out time because the exposure time happens in parallel with the read-out. The read-out time is defined by:

- Output clock speed: Max 240 MHz
- ADC mode: 10-bit or 12-bit
- Number of lines read-out
- Number of LVDS outputs used: Max 16 outputs

If any of these parameters is changed, it will have an impact on the frame rate. In default operation this will result in 180 fps. The total read-out time is composed of two parts: FOT (frame overhead time) and image read-out time.

The FOT is defined as shown in Equation 1:

Equation 1:

$$FOT = \left( fot\_length + \left( 2 * \frac{16}{\#outputs\ used} \right) \right) * 129 * master\ clock\ period$$

With fot\_length (register 73) at its default value of 20, this results in 59.125 µs frame overhead time.

The image read-out time is defined as shown in Equation 2:

Equation 2:

$$Image\_readout\_time = \left( 129 * master\ clock\ period * \frac{16}{\#outputs\ used} \right) * nr\_lines$$

Reading out a full resolution image, this results in 5.504 ms image read-out time.

The total read-out time is now the sum of the FOT and the image read-out time, which results in 59.125 µs + 5.504 ms or 5.5631 ms to read out a single full resolution image. The frame rate is thus 180 fps.

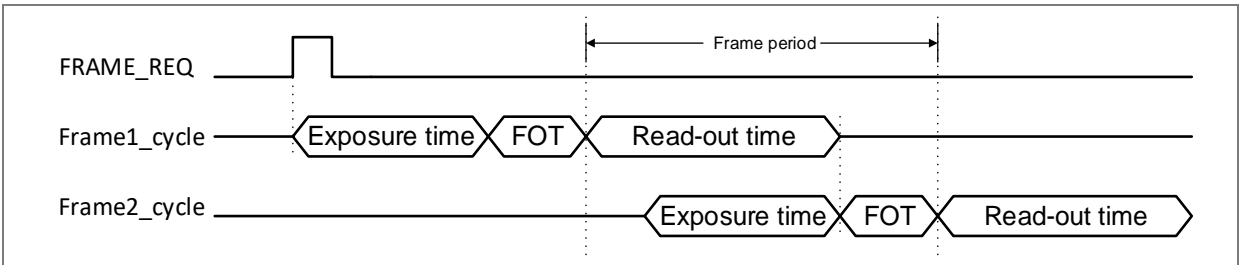
Table 11 gives some examples of how the frame rate increases when reading out a smaller frame in 10-bit mode.

Table 11: Frame rate for different frame size

| Number of columns | Number of lines | Frame rate |
|-------------------|-----------------|------------|
| 2048              | 2048            | 180        |
| 2048              | 1024            | 356        |
| 2048              | 70              | 4044       |

Figure 12 shows the frame period for 2 consecutive frame cycle.

Figure 12: Frame period

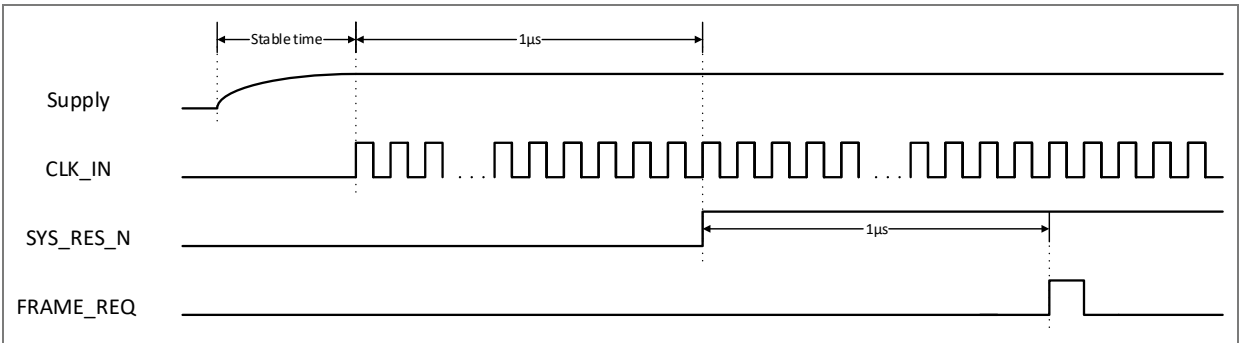


When the exposure time is greater than the read-out time, the frame rate is mostly defined by the exposure time itself (because the exposure time would be much longer than the FOT).

7.2.6 Start-up sequence

The sequence, shown in Figure 13 should be followed when the CMV4000 is started up in default output mode (480 Mbps, 10-bit resolution). There is no specific startup sequence for the power supplies needed.

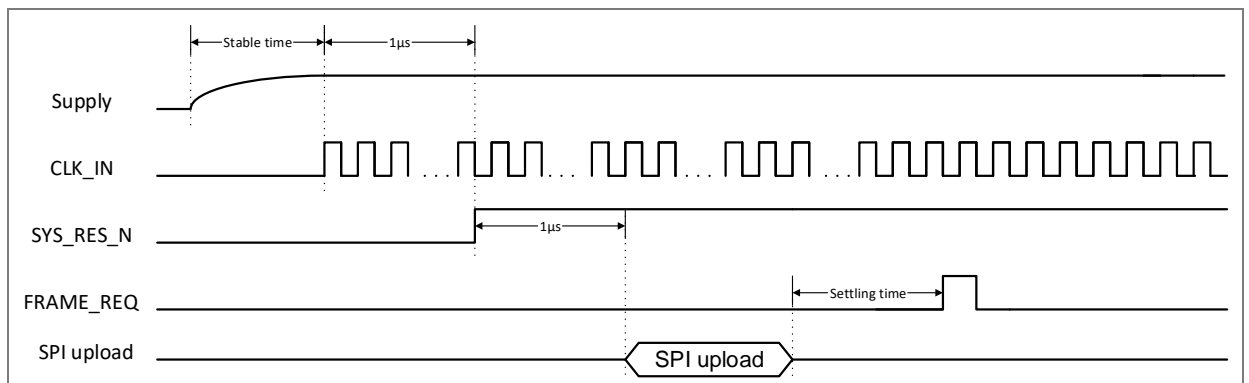
Figure 13: Start-up sequence for 480 Mbps @ 10-bit



The master clock CLK\_IN (48 MHz for 480 Mbps in 10-bit mode) should start after the rise time of the supplies. The external reset pin should be released at least 1  $\mu$ s after the supplies are stable. The first frame can be requested 1  $\mu$ s after the reset pin has been released.

If the register settings need to be changed (e.g. when using 12-bit mode), this can be done through an SPI upload 1  $\mu$ s after the rising edge on the SYS\_RES\_N pin, as described in Figure 14. In this case the FRAME\_REQ pulse must not be sent until after the SPI upload is completed, plus a settling time. This settling time is to ensure that the changes programmed in the SPI upload have taken effect before an image is captured. The main factor that determines this settling time is a change in ADC gain, because the voltage over the ramp capacitor has to settle. For typical applications, where the ADC gain is changed from the default value of 32 to a value that saturates the ADC output (40 to 45 at 48 MHz), the settling time is 7 ms. In extreme cases, when the ADC gain is changed from default to maximum, the settling time can increase to 20 ms.

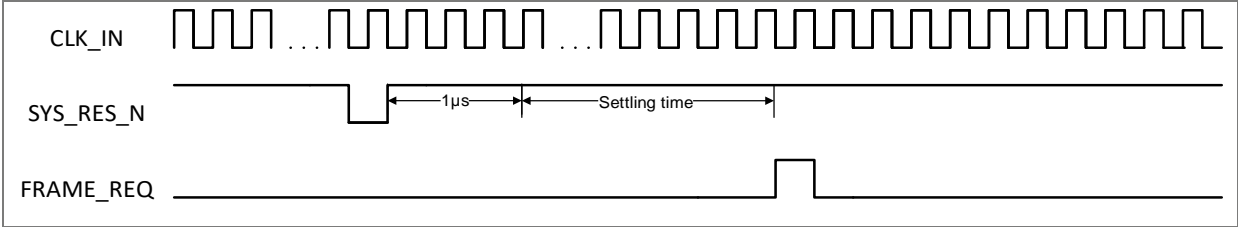
Figure 14: Start-up sequence for 12-bit mode



### 7.2.7 Reset sequence

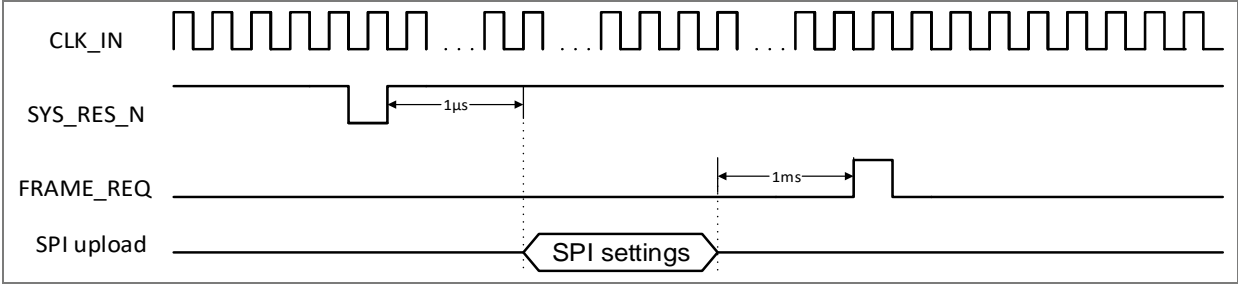
If a sensor reset is necessary while the sensor is running, the sequence in Figure 19 should be followed. The on-board sequencer will be reset and all programming registers will return to their default start-up values when a falling edge is detected on the SYS\_RES\_N pin. As with the start-up sequence, there is a minimum time of 1  $\mu$ s plus a settling time needed before a FRAME\_REQ pulse can be sent, to allow the gain settings to settle at their default value.

Figure 15: Reset sequence



When register settings are uploaded after the reset (e.g. when changing the bit mode), the sequence of Figure 16 should be followed.

Figure 16: Reset sequence when changing bit mode





## 7.2.8 SPI programming

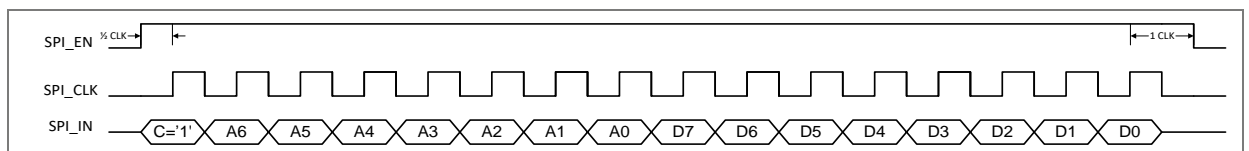
Programming the sensor is done by writing the appropriate values to the on-board registers. These registers can be written over a simple serial interface (SPI). The details of the timing and data format are described below. The data written to the programming registers can also be read out over this same SPI interface.

The details of the timing and data format are described in following points.

### 7.2.8.1 SPI write

The timing to write data over the SPI interface can be found in Figure 17.

Figure 17: SPI write timing



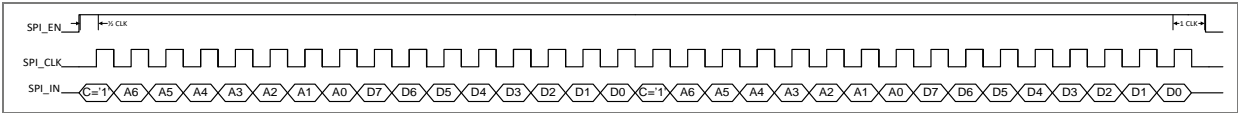
The data is sampled by the CMV4000 on the rising edge of the SPI\_CLK. The SPI\_CLK has a maximum frequency of 48 MHz. The SPI\_EN signal has to be high for half a clock period before the first data bit is sampled. After the last data bit is sent, SPI\_EN has to remain high for 1 clock period and SPI\_CLK has to receive a final falling edge to complete the write operation.

One write action contains 16 bits:

- One control bit: First bit to be sent, indicates whether a read ('0') or write ('1') will occur on the SPI interface.
- 7 address bits: These bits form the address of the programming register that needs to be written. The address is sent MSB first.
- 8 data bits: These bits form the actual data that will be written in the register selected with the address bits. The MSB data is written first.

When several sensor registers need to be written, the timing above can be repeated with SPI\_EN remaining high all the time. See the Figure 18 for an example of 2 registers being written in burst.

Figure 18: SPI write timing for 2 registers in burst



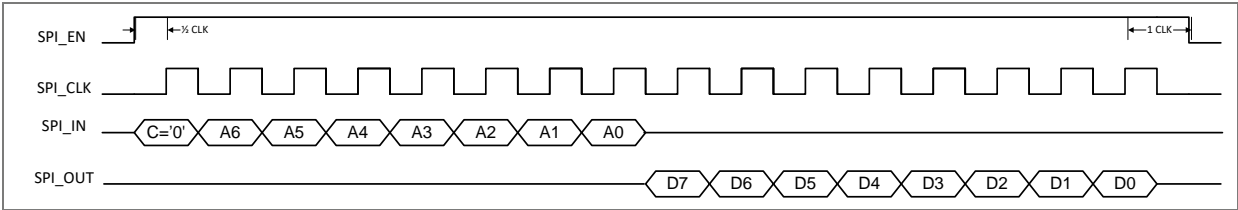
All registers should be updated during IDLE time. The sensor is not IDLE during a frame burst (between start of integration of first frame and read-out of last pixel of last frame).

Registers 35-38, 40-69, 100-103 can be updated during IDLE or FOT. Registers 1-34 and 70-71 can always be updated but it is recommended to update these during IDLE or FOT to minimize image effects. Registers 78-79 can always be updated without disrupting the imaging process.

7.2.8.2 SPI read

The timing to read data from the registers over the SPI interface can be found in Figure 19.

Figure 19: SPI read timing



To indicate a read action over the SPI interface, the control bit on the SPI\_IN pin is made '0'. The address of the register being read out is sent immediately after this control bit (MSB first). After the LSB of the address bits, the data is launched on the SPI\_OUT pin on the falling edge of the SPI\_CLK. This means that the data should be sampled by the receiving system on the rising edge of the SPI\_CLK. The data comes over the SPI\_OUT with MSB first. When reading out the temperature sensor over the SPI, addresses 126 and 127 should be read-out in burst mode (keep SPI\_EN high).

7.2.9 Requesting a frame

After starting up the sensor (see chapter 7.2.6), a number of frames can be requested by sending a FRAME\_REQ pulse. The number of frames can be set by programming the appropriate register (addresses 70 and 71). The default number of frames to be grabbed is 1.

In internal-exposure-time mode, the exposure time will start after this FRAME\_REQ pulse. In the external-exposure-time mode, the read-out will start after the FRAME\_REQ pulse. Both modes are explained into detail in the chapters below.

7.2.9.1 Internal exposure control

In this mode, the exposure time is set by programming the appropriate registers (address 42-44).

After the high state of the FRAME\_REQ pulse is detected, the exposure time will start after a delay of 133 clock cycles, see AN16 – Exposure timings for all timing details. When the exposure time ends (as programmed in the registers), the pixels are being sampled and prepared for read-out. This sequence is called the frame overhead time (FOT). Immediately after the FOT, the frame is read-out automatically. If more than one frame is requested, the exposure of the next frame starts already during the read-out of the previous one (see Figure 20).

Figure 20: Request for 2 frames in internal- exposure-time mode

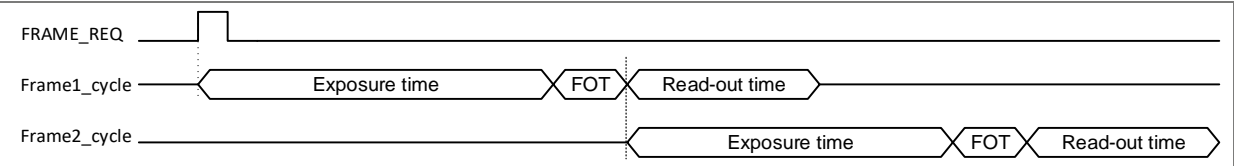
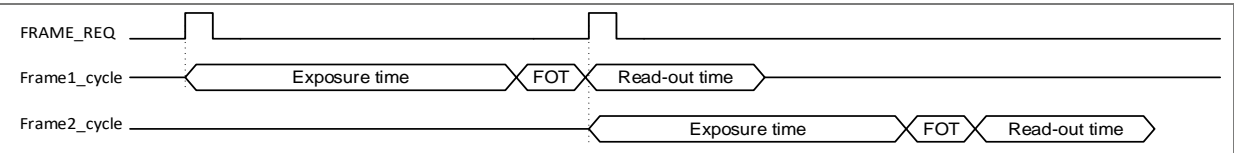


Figure 21: Two requests for 1 frame in internal exposure mode<sup>(1)</sup>



(1) This request form is just applicable to version 3.

When the exposure time is shorter than the read-out time, the FOT and read-out of the next frame will start immediately after the read-out of the previous frame. Keep in mind that the next FRAME\_REQ pulse has to occur after the FOT of the current frame. For an exact calculation of the exposure time, see chapter 7.4.1.

When a new FRAME\_REQ is applied, the exposure of the next frame will be delayed so that the FOT begins right after the read-out time of the current frame.

Figure 22: Request for 2 frames in internal exposure mode with exposure time < read-out time

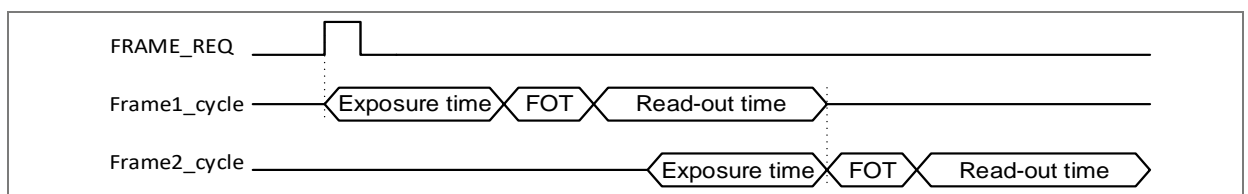
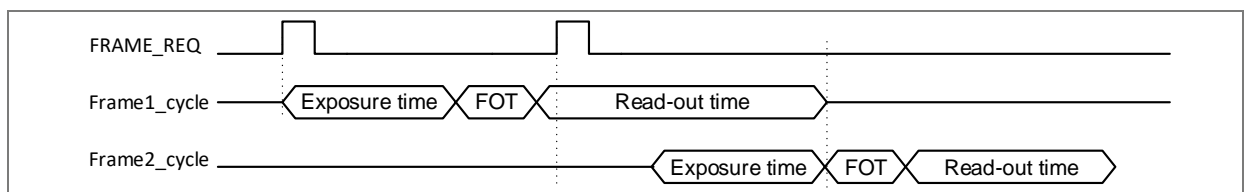


Figure 23: Two requests for 1 frame in internal exposure mode<sup>(1)</sup>



(1) Only applicable for Version 3.

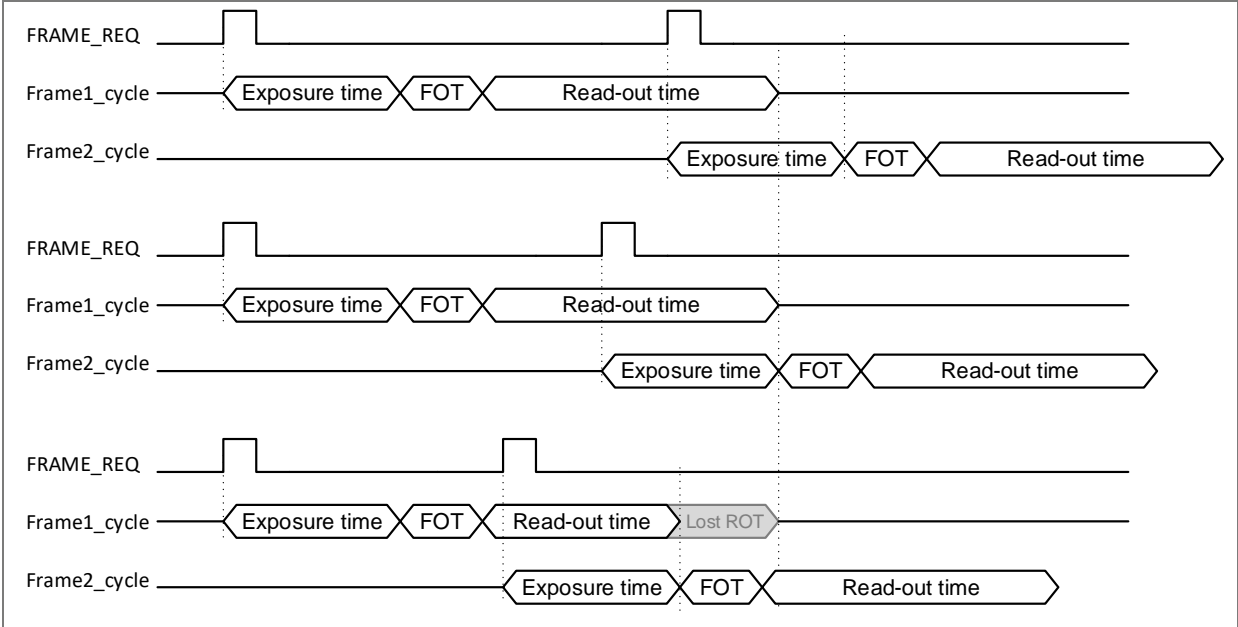
### Timing calculation for version2:

If the exposure time is shorter than the read-out time, keep in mind that when you apply a next FRAME\_REQ pulse during the read-out of the current frame, the exposure of that new frame will start immediately. Therefore, you have to keep enough time between the two FRAME\_REQ pulses so the read-out times do not overlap. If the FOT of the next frame starts during the read-out of the current frame, that read-out will be aborted immediately, as shown in Figure 24. If the exposure time is longer than the read-out time, the read-out times of two consecutive frames cannot overlap and will not cause a problem. The minimum time between two FRAME\_REQ pulses is given by Equation 3:

Equation 3:

$$\text{min. time} = \text{exposure time} + \text{FOT} + (\text{Readout time} - \text{Exposure time}) = \text{FOT} + \text{Readout time}$$

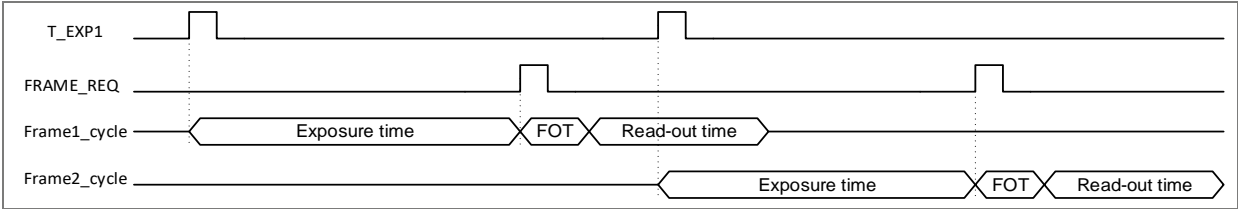
Figure 24: The timing effect of two requests for 1 frame in internal exposure mode



7.2.9.2 External exposure time

The exposure time can also be programmed externally by using the T\_EXP1 input pin. This mode needs to be enabled by setting the appropriate register (address 41). In this case, the exposure starts when a high state is detected on the T\_EXP1 pin. When a high state is detected on the FRAME\_REQ input, the exposure time stops and the read-out will start automatically. A new exposure can start by sending a pulse to the T\_EXP1 pin during or after the read-out of the previous frame. The minimum time between T\_EXP1 and FRAME\_REQ is 1 master clock cycle, the minimum time between FRAME\_REQ and T\_EXP1 pulse is FOT. For an exact calculation of the exposure time see chapter 7.4.1.

Figure 25: Request for 2 frames using external-exposure-time mode



## 7.3 Sensor readout format

### 7.3.1 LVDS data outputs

The CMV4000 has LVDS (low voltage differential signaling) outputs to transport the image data to the surrounding system. Next to 16 data channels, the sensor also has two other LVDS channels for control and synchronization of the image data. In total, the sensor has 18 LVDS output pairs (2 pins for each LVDS channel):

- 16 Data channels
- 1 Control channel
- 1 Clock channel

This means that a total of 36 pins of the CMV4000 are used for the LVDS outputs (32 for data + 2 for LVDS clock + 2 for control channel). See the pin list for the exact pin numbers of the LVDS outputs.

The 16 data channels are used to transfer the 10-bit or 12-bit pixel data from the sensor to the receiver in the surrounding system.

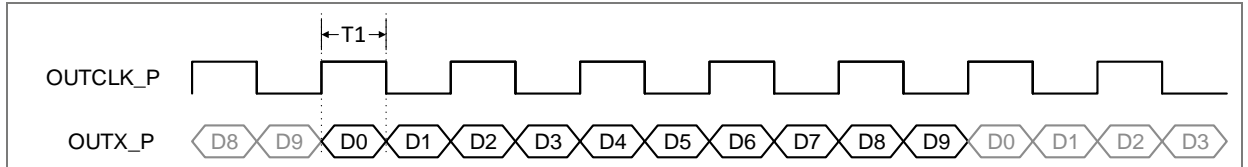
The output clock channel transports a clock, synchronous to the data on the other LVDS channels. This clock can be used at the receiving end to sample the data. This clock is a DDR clock which means that the frequency will be half of the output data rate. When 480 Mbps output data rate is used, the LVDS output clock will be 240 MHz.

The data on the control channel contains status information on the validity of the data on the data channels. Information on the control channel is grouped in 10-bit or 12-bit words that are transferred synchronous to the 16 data channels.

### 7.3.2 Low-level pixel timing

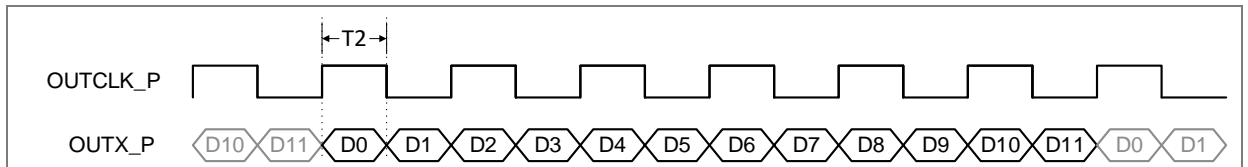
Figure 26 and Figure 27 show the timing for transfer of 10-bit and 12-bit pixel data over one LVDS output. To make the timing more clear, the figures show only the p-channel of each LVDS pair. The data is transferred LSB first, with the transfer of bit D0 during the high phase of the DDR output clock OUTCLK.

Figure 26: 10-bit pixel data on an LVDS channel



The time 'T1' in Figure 26 is  $1/10^{\text{th}}$  of the period of the CLK\_IN input clock. If a frequency of 48MHz is used for CLK\_IN (max in 10-bit mode), this results in a 240 MHz OUTCLK frequency.

Figure 27: 12-bit pixel data on an LVDS channel



The time 'T2' in Figure 27 is  $1/12^{\text{th}}$  of the period of the CLK\_IN input clock. If a frequency of 40MHz is used for CLK\_IN (max in 12-bit mode), this results in a 240 MHz OUTCLK frequency.

### 7.3.3 Read-out timing

The read-out of image data is grouped in bursts of 128 pixels per channel. Each pixel is either 10 or 12 bits of data (see Chapter 7.3.2). One complete pixel period equals one period of the master clock input. For details on pixel remapping and pixel vs. channel location please see chapter 7.3.4 of this document. An overhead time exists between two bursts of 128 pixels. This overhead time has the same length of one pixel read-out (i.e. the length of 10 or 12 bits at the selected data rate or one master clock period). For details on how to program the sequencer for different output modes, see chapter 7.5.1.

7.3.3.1 10-bit mode

In this section, the read-out timing for the default 10-bit mode is explained. In this mode the maximum frame rate of 180 fps can be reached.

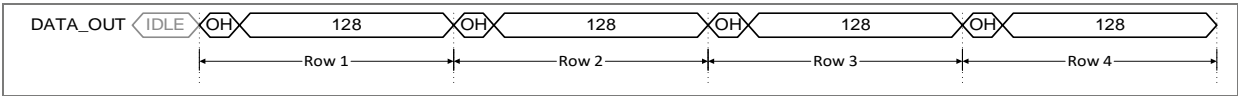
For simplification, the timing for only one LVDS channel is shown in every case in the following paragraphs:

- 16 Output Channels
- 8 Output Channels
- 4 Output Channels
- 2 Output Channels

16 output channels:

By default, all 16 data output channels are used to transmit the image data. This means that an entire row of image data is transferred in one slot of 128 pixel periods ( $16 \times 128 = 2048$ ). This results in a maximum frame rate of 180 fps.

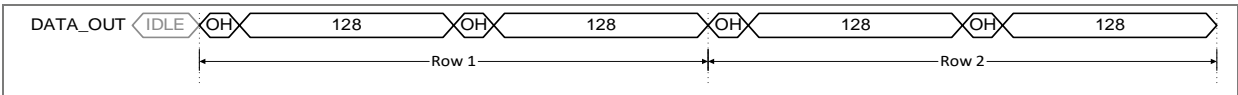
Figure 28: Output timing in default 16 channels mode



8 output channels:

When only 8 LVDS output channels are used, the read-out of one row takes  $(2 \times 128) + (2 \times 1)$  master clock periods. The maximum frame rate is reduced with a factor of 2 compared to 16 channels mode.

Figure 29: Output timing in 8 channels mode

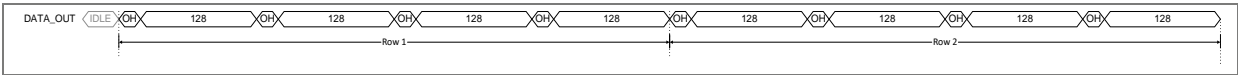




4 output channels:

When only 4 LVDS output channels are used, the read-out of one row takes  $(4 \times 128) + (4 \times 1)$  master clock periods. The maximum frame rate is reduce with a factor of 4 compared to 16 channels mode.

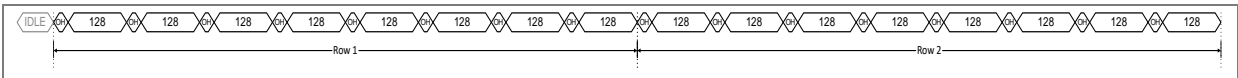
Figure 30: Output timing in 4 channels mode



2 output channels:

When only 2 LVDS output channels are used, the read-out of one row takes  $(8 \times 128) + (8 \times 1)$  master clock periods. The maximum frame rate is reduced with a factor of 8 compared to 16 channels mode.

Figure 31: Output timing in 2 channels mode



7.3.3.2 12-bit mode

In 12-bit mode, the analog-to-digital conversion takes 4x longer to complete. This causes the frame rate to drop to 37.5 fps when 40 MHz is used for CLK\_IN. Due to this extra conversion time, the sensor automatically multiplexes to 4 outputs when 12-bit is used.

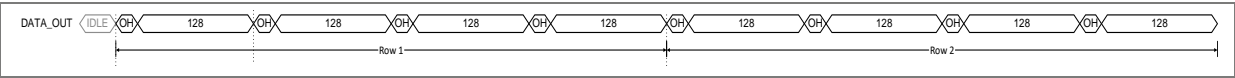
For simplification, the timing for only one LVDS channel is shown in every case in the following paragraphs:

- 4 Output Channels
- 2 Output Channels

4 output channels:

By default, the CMV4000 uses only 4 LVDS output channels in 12-bit mode. This means that the read-out of one row takes 516 (4 x 128) + (4 x 1) master clock periods.

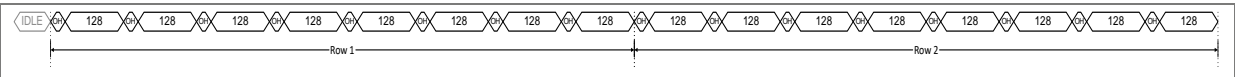
Figure 32: Output timing in 4 channels mode



2 output channels:

When only 2 LVDS output channels are used, the read-out of one row takes (8 x 128) + (8 x 1) master clock periods. The maximum frame rate is reduced with a factor of 2 compared to 4 channels mode.

Figure 33: Output timing in 2 channels mode



7.3.4 Pixel remapping

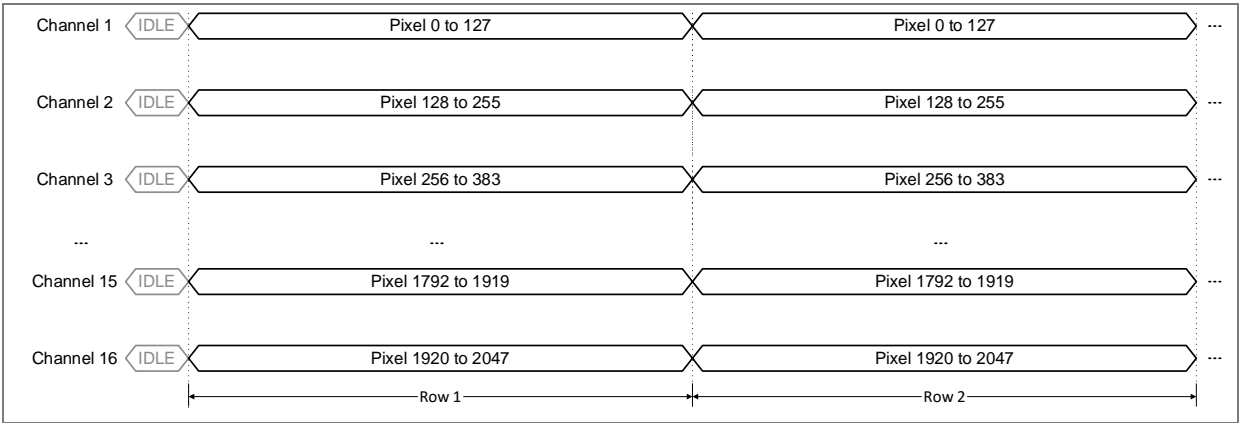
Depending on the number of output channels, the pixels are read out by different channels and come out at a different moment in time. With the details from the next chapters, the end user is able to remap the pixel values at the output to their correct image array location.

7.3.4.1 16 outputs

Figure 34 shows the location of the image pixels versus the output channel of the image sensor.

16 bursts of 128 pixels happen in parallel on the data outputs. This means that one complete row is read out in one burst. The amount of rows that will be read out depends on the value in the corresponding register. By default there are 2048 rows being read out.

Figure 34: Pixel remapping for 16 output channels

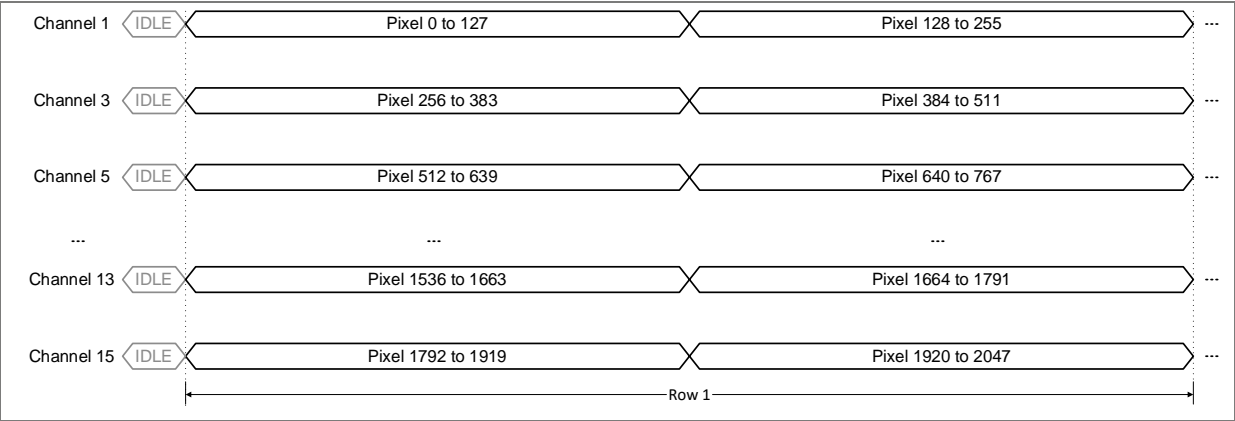


7.3.4.2 8 outputs

When only 8 outputs are used, the pixel data is placed on the outputs as detailed in Figure 35. 8 bursts of 128 pixels happen in parallel on the data outputs. This means that one complete row is read out in two bursts. The time needed to read out one row is doubled compared to when 16 outputs are used. Channel 2, 4, 6...16 are not being used in this mode, so they can be turned off by setting the correct bits in the register with addresses 80-82. Turning off these channels will reduce the power consumption of the chip.

The amount of rows that will be read out can be set in the register. By default 2048 rows are read out.

Figure 35: Pixel remapping for 8 output channels

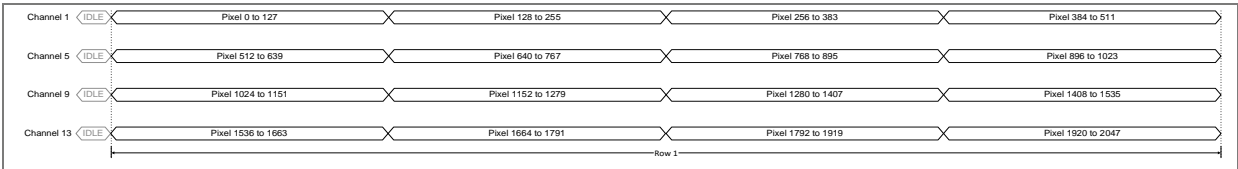


7.3.4.3 4 outputs

When only 4 outputs are used, the pixel data is placed on the outputs as detailed in Figure 36. 4 bursts of 128 pixels happen in parallel on the data outputs. This means that one complete row is read out in four bursts. The time needed to read out one row is 4x longer compared to when 16 outputs are used. Only channel 1, 5, 9 and 13 are being used in this mode, so the remaining channels can be turned off by setting the correct bits in the register with addresses 80-82. Turning off these channels will reduce the power consumption of the chip.

The amount of rows that will be read out can be set in the register. By default 2048 rows are read out.

Figure 36: Pixel remapping for 4 output channels

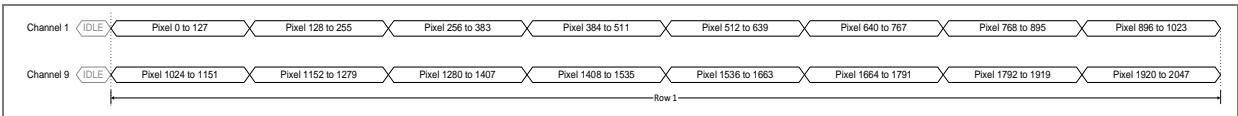


7.3.4.4 2 outputs

When only 2 outputs are used, the pixel data is placed on the outputs as detailed in Figure 37. 2 bursts of 128 pixels happen in parallel on the data outputs. This means that one complete row is read out in 8 bursts. The time needed to read out one row is 8x longer compared to when 16 outputs are used. Only channels 1 and 9 are being used in this mode, so the remaining channels can be turned off by setting the correct bits in the register with addresses 80-82. Turning off these channels will reduce the power consumption of the chip.

The amount of rows that will be read out can be set in the register. By default 2048 rows are read out.

Figure 37: Pixel remapping for 2 output channels



#### 7.3.4.5 Overview

All outputs are always used to send data, but if you use less than 16 channels, some channels will have duplicate data. For example, if you multiplex to 4 channels, outputs 6, 7 and 8 will have identical data as output 5.

Table 12 shows an overview of which channel data is on which output at a certain output mode.

Table 12: Overview channel data – output mode

| MUX to | OUT 1 | OUT 2 | OUT 3 | OUT 4 | OUT 5 | OUT 6 | OUT 7 | OUT 8 | OUT 9 | OUT 10 | OUT 11 | OUT 12 | OUT 13 | OUT 14 | OUT 15 | OUT 16 |
|--------|-------|-------|-------|-------|-------|-------|-------|-------|-------|--------|--------|--------|--------|--------|--------|--------|
| 16     | CH1   | CH2   | CH3   | CH4   | CH5   | CH6   | CH7   | CH8   | CH9   | CH10   | CH11   | CH12   | CH13   | CH14   | CH15   | CH16   |
| 8      | CH1   | CH1   | CH3   | CH3   | CH5   | CH5   | CH7   | CH7   | CH9   | CH9    | CH11   | CH11   | CH13   | CH13   | CH15   | CH15   |
| 4      | CH1   | CH1   | CH1   | CH1   | CH5   | CH5   | CH5   | CH5   | CH9   | CH9    | CH9    | CH9    | CH13   | CH13   | CH13   | CH13   |
| 2      | CH1   | CH1   | CH1   | CH1   | CH1   | CH1   | CH1   | CH1   | CH9   | CH9    | CH9    | CH9    | CH9    | CH9    | CH9    | CH9    |

#### 7.3.5 Control channel

The CMV4000 has one LVDS output channel dedicated for the valid data synchronization and timing of the output channels. The end user must use this channel to know when valid image data or training data is available on the data output channels.

The control channel transfers status information in 10-bit or 12-bit word format. Every bit of the word has a specific function. Next table describes the function of the individual bits, but only the DVAL, LVAL and FVAL signal are necessary to know when to sample the image data.

Table 13: Function of the individual bits

| Bit | Function | Description   |
|-----|----------|---|
| [0] | DVAL     | Indicates valid pixel data on the outputs   |
| [1] | LVAL     | Indicates validity of the read-out of a row   |
| [2] | FVAL     | Indicates the validity of the read-out of a frame                                     |
| [3] | SLOT     | Indicates the overhead period before 128-pixel bursts (*)                             |
| [4] | ROW      | Indicates the overhead period before the read-out of a row <sup>(1)</sup>             |
| [5] | FOT      | Indicates when the sensor is in FOT (sampling of image data in pixels) <sup>(1)</sup> |
| [6] | INTE1    | Indicates when pixels of integration block 1 are integrating <sup>(1)</sup>           |
| [7] | INTE2    | Indicates when pixels of integration block 2 are integrating <sup>(1)</sup>           |
| [8] | '0'      | Constant zero   |

| Bit  | Function | Description   |
|------|----------|---------------|
| [9]  | '1'      | Constant one  |
| [10] | '0'      | Constant zero |
| [11] | '0'      | Constant zero |

(1) The status bits are purely informational. These bits are not required to know when the data is valid. The DVAL, LVAL and FVAL signals are sufficient to know when to sample the image data.

INTE1/2 will be low when FOT is high, so the exposure during the small 0.43\*reg73 overlap (see formulas in 7.4.1), will not be visible in the INTE1/2 bits.

Pins H2 (TDIG1) and G2 (TDIG2) can be programmed to map the state of control channel bits [0] (DVAL), [1] (LVAL), [2] (FVAL), [6] (INTE1) or [7] (INTE2) with registers 108 (T\_dig1) and 109 (T\_dig2).

Table 14: Register 108/109 value

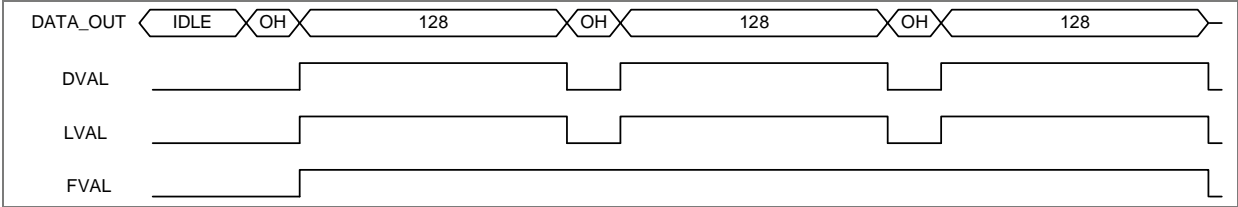
| Register 108/109 value | TDIG1 | TDIG2 |
|------------------------|-------|-------|
| 0                      | INTE1 | INTE1 |
| 1                      | INTE2 | INTE2 |
| 2                      | DVAL  | DVAL  |
| 3                      | LVAL  | LVAL  |
| 4                      | FVAL  | FVAL  |

7.3.5.1 DVAL, LVAL, FVAL

The first three bits of the control word must be used to identify valid data and the read-out status.

Figure 38 shows the timing of the DVAL, LVAL and FVAL bits of the control channel with an example of the read-out of a frame of 3 rows (default is 2048 rows). In the example the default mode of 16 outputs is in 10-bit mode.

Figure 38: DVAL, LVAL and FVAL timing in 16 outputs mode



When only 8 outputs are used, the line read-out time is 2x longer. The control channel takes this into account and the timing in this mode are shown in Figure 39 and Figure 40. The timing extrapolates identically for 4 and 2 outputs.

Figure 39: DVAL, LVAL and FVAL timing in 8 outputs mode

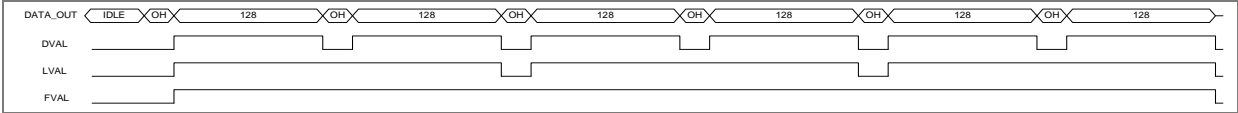
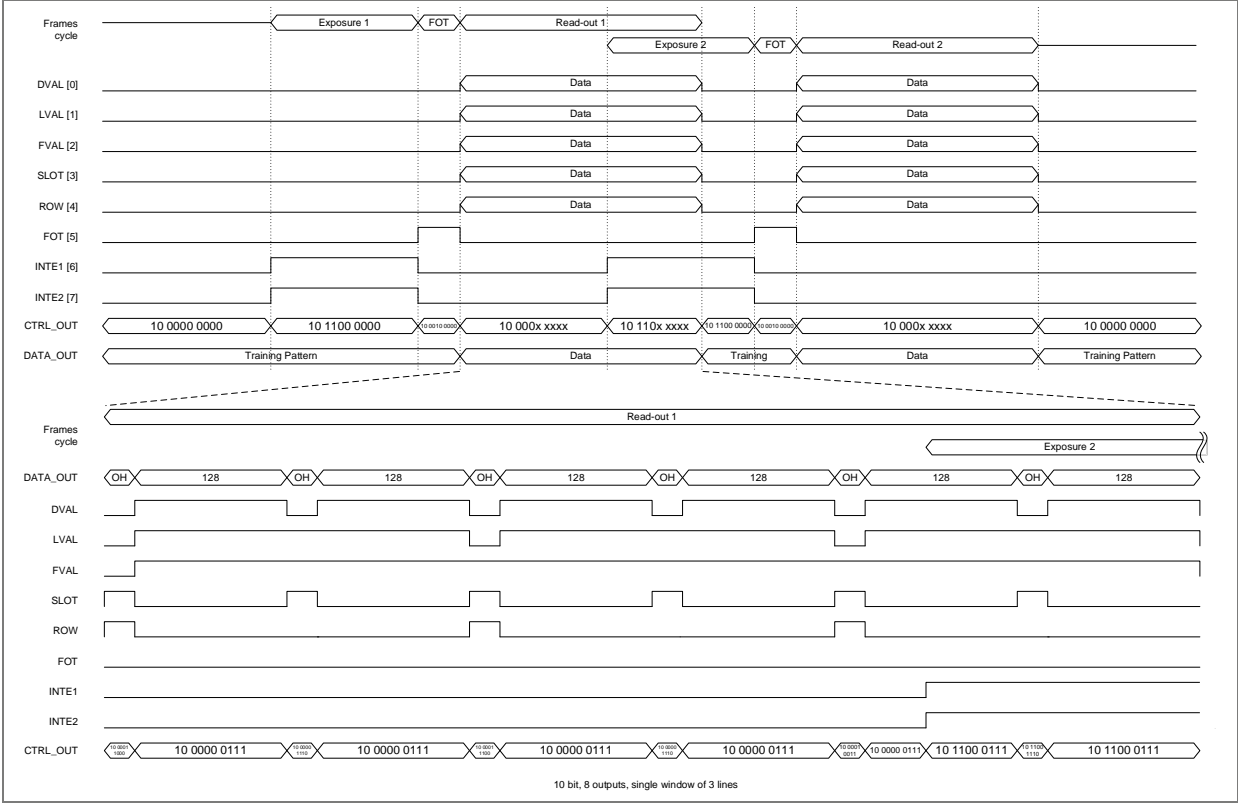


Figure 40: Detailed timings of the control channel (8 outputs, 3 lines window)





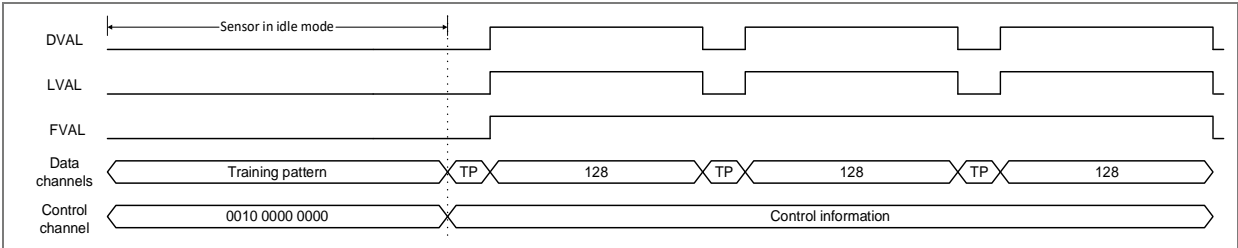
7.3.6 Training data

To synchronize the receiving side with the LVDS outputs of the CMV4000, a known data pattern can be put on the output channels. This pattern “trains” the LVDS receiver of the surrounding system to achieve correct word alignment of the image data. This training pattern is put on all 16 output channels when no valid image data is being sent, even in between bursts of 128 pixels. The training pattern is a 10-bit or 12-bit word that replaces the pixel data. The sensor has a 12-bit sequencer register (address 78-79) that can be used to change the contents of the 12-bit training pattern.

The control channel does not send a training pattern, because it is used to send control information at all time. Word alignment can be done on this channel when the sensor is idle (not exposing or sending image data). In this case all bits of the control word are zero, except for bit [9] (= 0010 0000 0000 or 512 decimal).

Figure 41 shows the location of the training pattern (TP) on the data channels when the sensor is idle and when reading out 3 rows. The default mode of 16 outputs is selected.

Figure 41: Training pattern location in the data and control channels



7.4 Configuring exposure and readout

This section explains how the CMV4000 can be programmed using the on-board sequencer registers.

7.4.1 Exposure modes

The exposure time can be programmed in two ways, externally or internally. Externally, the exposure time is defined as the time between the rising edge of T\_EXP1 and the rising edge of FRAME\_REQ (see External exposure time for more details). Internally, the exposure time is set by uploading the desired value to the corresponding sequencer register.

Table 15: Time settings of exposure mode

| Register name | Register address              | Default value | Description of the value  |
|---------------|-------------------------------|---------------|---|
| Exp_ext       | 41[0]                         | 0             | 0: Value in Exp_time register defines exposure time<br>1: Time between T_EXP1 and FRAME_REQ pulses defines exposure time  |
| Exp_time      | 42[7:0]<br>43[7:0]<br>44[7:0] | 2048          | If Exp_ext = 0:<br>Defines the exposure time according to the following formula:<br>$129 * clk\_per(0.43 * fot\_length + Exp\_time)$<br>Where clk_per is the period of the master input clock and fot_length is the value in register 73. |
|               |                               |               | If Exp_ext = 1:<br>The exposure time is:<br>$129 * clk\_per(0.43 * fot\_length) + external\ exposure\ time$<br>Where external exposure time is the time between T_EXP1 and FRAME_REQ.   |

To calculate back from actual exposure time to the register value for internal exposure can use the following formula (exposure time and clk\_per should have the same time unit):

$$Exp\_time = \frac{exposure\ time}{129 * clk\_per} - 0.43 * fot\_length$$

For very short integration times, the fot\_length should be lowered to 10 and the maximum clock speed should be used. In internal exposure mode, the shortest exposure time is limited by the exp\_time register, when this is set to 1, the shortest exposure time is 25.8  $\mu$ s, or 14.24  $\mu$ s for fot\_length = 10.

In external exposure mode, the time between T\_EXP1 and FRAME\_REQ can be as short as one clock cycle, reducing the shortest exposure time even more to 23.14  $\mu$ s, or 11.58  $\mu$ s for fot\_length = 10.

7.4.2 High dynamic range modes

- The sensor has different ways to achieve high optical dynamic range in the grabbed image.
- Interleaved read-out: The odd and even rows have a different exposure time.
  - Piecewise linear response: Pixels respond to light with a piecewise linear response curve.
  - Multi-frame read-out: Different frames are read-out with increasing exposure time.

All the HDR modes mentioned above can be used in both the internal and external exposure time mode.

7.4.2.1 Interleaved read-out

In this HDR mode, the odd and even rows of the image sensors will have a different exposure time. This mode can be enabled by setting the register Exp\_dual.

Table 16: Interleaved read-out – HDR mode enabling

| Register name | Register address | Default value | Description of the value  |
|---------------|------------------|---------------|---|
| Exp_dual      | 41[1]            | 0             | 0: Interleaved exposure mode disabled<br>1: Interleaved exposure mode enabled |

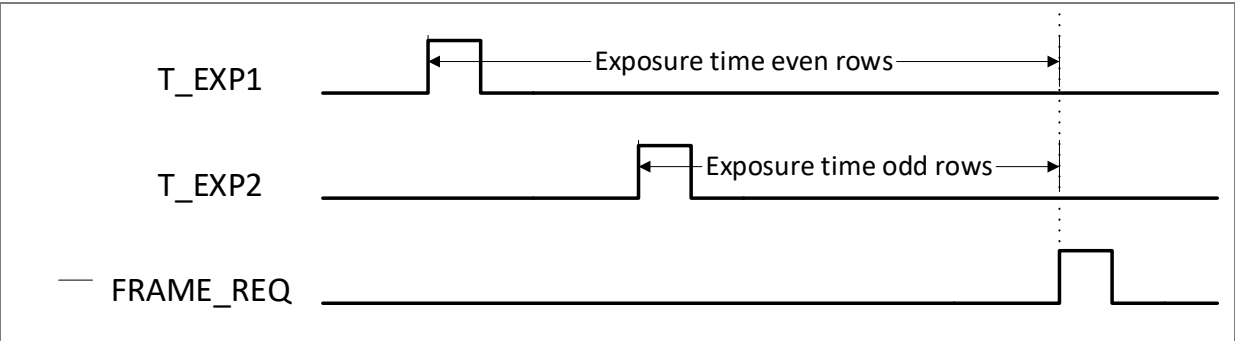
The surrounding system can combine the image of the odd rows with the image of the even rows which results in a high dynamic range image. In this image, very bright and very dark objects are made visible without clipping. The Table 17 gives an overview of the registers involved in the interleaved read-out when the internal exposure mode is selected.

Table 17: Interleaved read-out – HDR mode timing

| Register name | Register address   | Default value | Description of the value   |
|---------------|--------------------|---------------|--|
| Exp_time      | 42[7:0]            | 2048          | <u>If Exp_dual = '1'</u><br>Defines the exposure time for the even rows according following formula:<br>$129 * clk\_per(0.43 * fot\_length + Exp\_time)$<br>Where clk_per is the period of the CLK_IN input clock. |
|               | 43[7:0]<br>44[7:0] |               |  |
| Exp_time2     | 56[7:0]            | 2048          | <u>If Exp_dual = '1'</u><br>Defines the exposure time for the odd rows according following formula:<br>$129 * clk\_per(0.43 * fot\_length + Exp\_time2)$<br>Where clk_per is the period of the CLK_IN input clock. |
|               | 57[7:0]<br>58[7:0] |               |  |

When the external exposure mode and interleaved read-out are selected, the different exposure times are achieved by using the T\_EXP1 and T\_EXP2 input pins. T\_EXP1 defines the exposure time for the even lines, while T\_EXP2 defines the exposure time for the odd lines. See Figure 42 for more details.

Figure 42: Interleaved read-out in external exposure mode



When a color sensor is used, the sequencer should be programmed to make sure it takes the Bayer pattern into account when doing interleaved read-out. This can be done by setting the appropriate register to '0'.

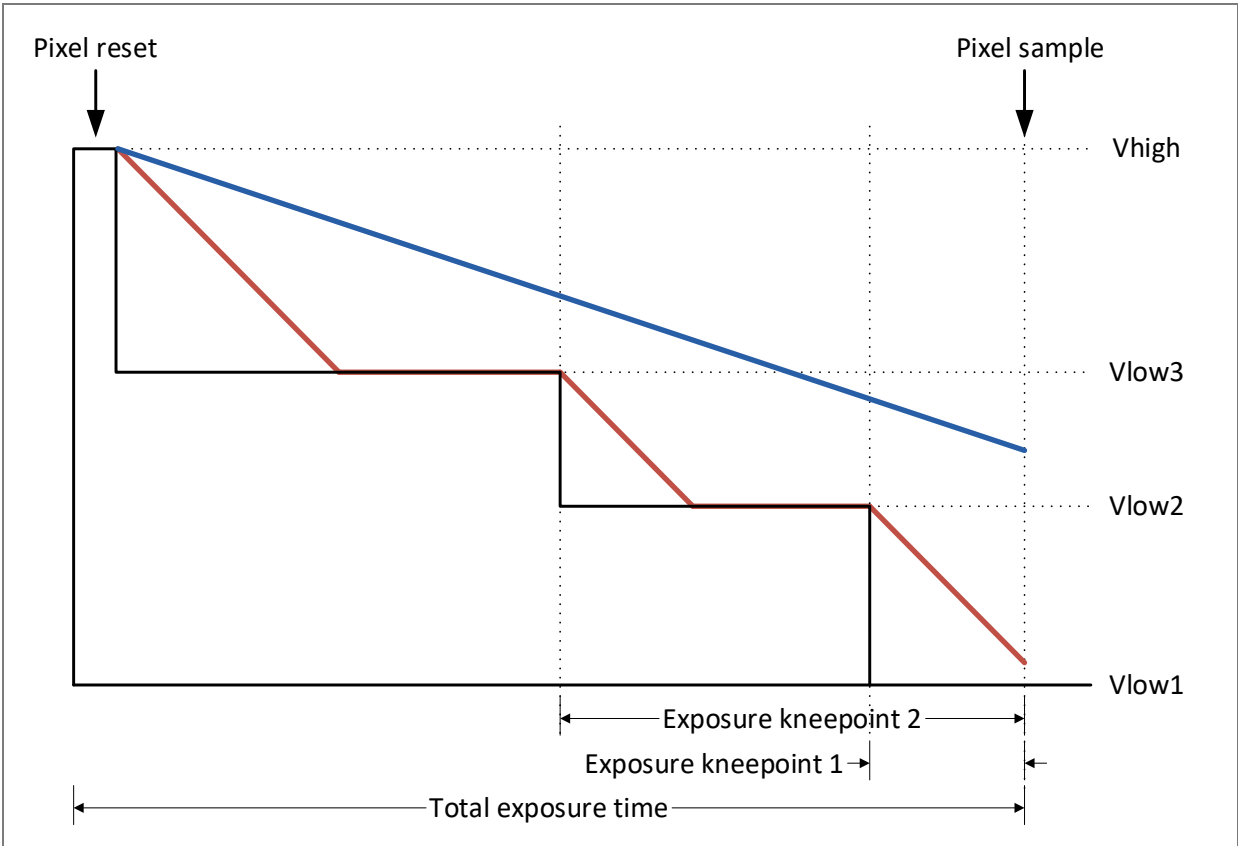
Table 18: Mono or color register selection

| Register name | Register address | Default value | Description of the value                                |
|---------------|------------------|---------------|---|
| mono          | 39[0]            | 1             | 0: Color sensor is used<br>1: Monochrome sensor is used |

7.4.2.2 Piecewise linear response

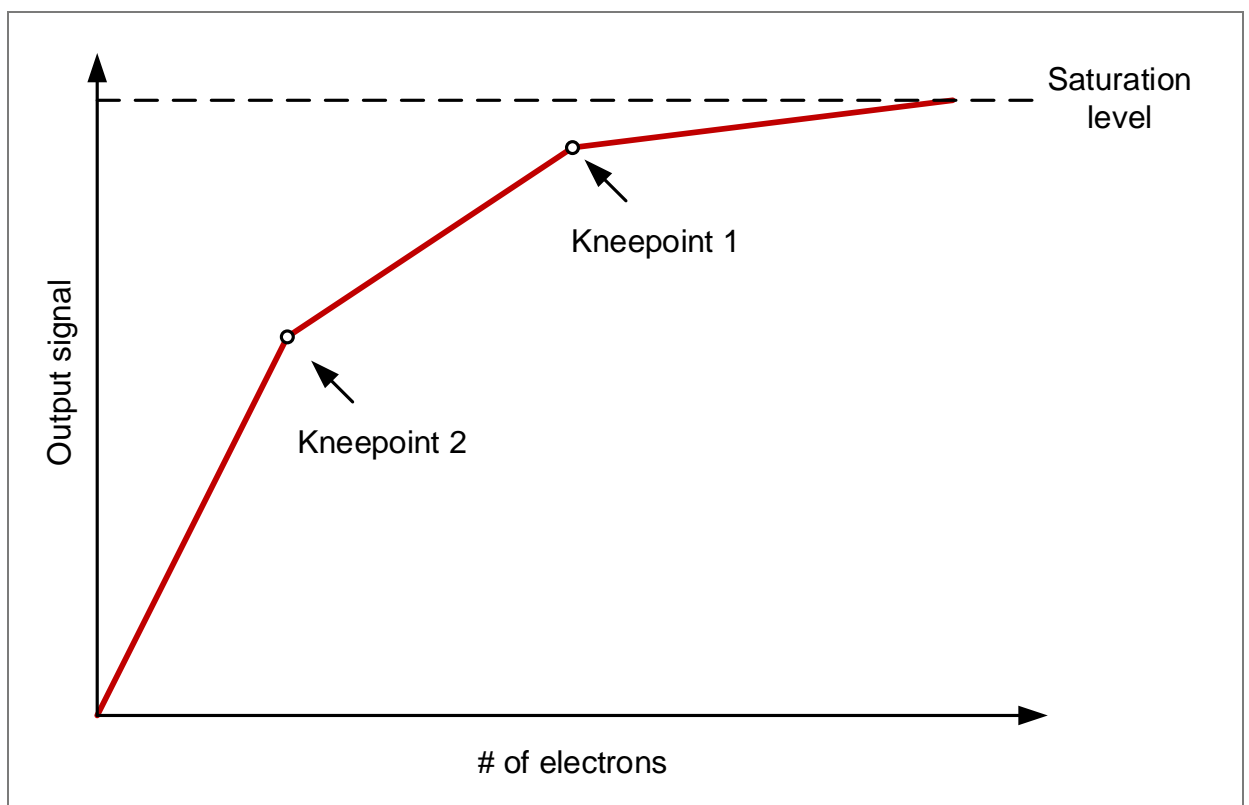
The CMV4000 has the possibility to achieve a high optical dynamic range by using a piecewise linear response. This will clip illuminated pixels which reach a programmable voltage, while leaving the darker pixels untouched. The clipping level can be adjusted 2 times within one exposure time to achieve a maximum of 3 slopes in the response curve, as shown in Figure 43.

Figure 43: Piecewise linear response details



In Figure 43, the red lines represent a pixel on which a large amount of light is falling. The blue line represents a pixel on which less light is falling. The bright pixel is held to a programmable voltage for a programmable time during the exposure time. This happens two times to make sure that at the end of the exposure time the pixel is not saturated. The darker pixel is not influenced and will have a normal response. The Vlow voltages and different exposure times are programmable using the sequencer registers. Using this feature, a response as detailed in Figure 44 can be achieved. The placement of the knee points on the X-axis is controlled by the Vlow programming, while the slope of the segments is controlled by the programmed exposure times.

Figure 44: Piecewise linear response



#### Piecewise linear response with internal exposure mode:

The following registers need to be programmed when a piecewise linear response in internal exposure mode is desired.

Table 19: Piecewise linear response with internal exposure mode register settings

| Register name | Register address | Default value | Description of the value   |
|---------------|------------------|---------------|--|
| Exp_time      | 42[7:0]          | 2048          | Defines the total exposure time according following formula:<br><br>$129 * clk\_per(0.43 * fot\_length + Exp\_time)$<br><br>Where clk_per is the period of the CLK_IN input clock. |
|               | 43[7:0]          |               |  |
|               | 44[7:0]          |               |  |
|               |                  |               |  |
| Nr_slopes     | 54[1:0]          | 1             | Defines the number of slopes (min=1, max=3).   |
| Exp_kp1       | 48[7:0]          | 1             | Defines the exposure time of kneepoint 1. Formula:<br><br>$129 * clk\_per(0.43 * fot\_length + Exp\_kp1)$<br><br>Where clk_per is the period of the CLK_IN input clock.            |
|               | 49[7:0]          |               |  |
|               | 50[7:0]          |               |  |
|               |                  |               |  |
| Exp_kp2       | 51[7:0]          | 1             | Defines the exposure time of kneepoint 2. Formula:<br><br>$129 * clk\_per(0.43 * fot\_length + Exp\_kp2)$<br><br>Where clk_per is the period of the CLK_IN input clock.            |
|               | 52[7:0]          |               |  |
|               | 53[7:0]          |               |  |
|               |                  |               |  |
| Vlow3         | 90[6:0]          | 96            | Defines the Vlow3 voltage (DAC setting).<br>Bit [6] = Enable<br>Bit[5:0] = Vlow3 value   |
| Vlow2         | 89[6:0]          | 96            | Defines the Vlow2 voltage (DAC setting).<br>Bit [6] = Enable<br>Bit[5:0] = Vlow2 value   |

### Piecewise linear response with external exposure mode:

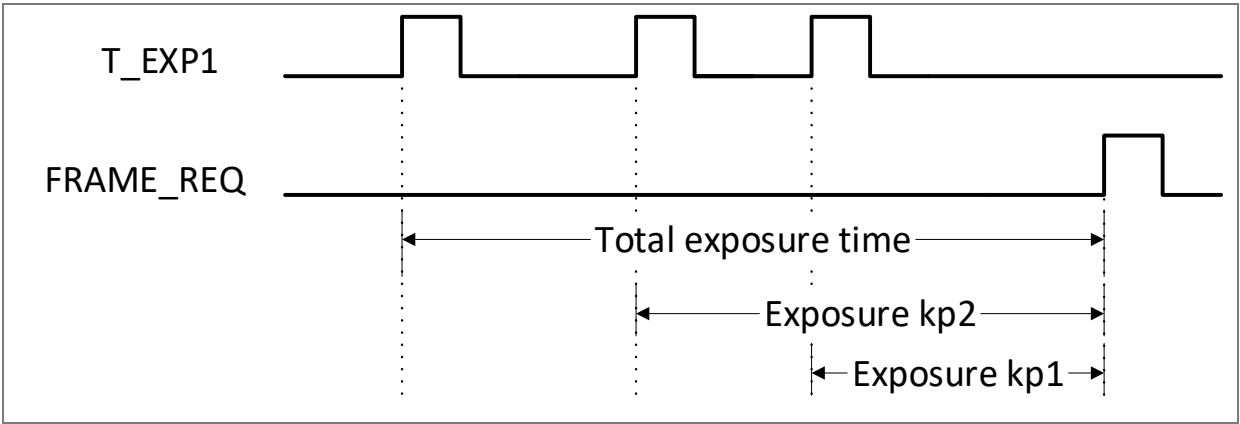
When external exposure time is used and a piecewise linear response is desired, the following registers should be programmed. Note that the combination of the piecewise linear response and interleaved read-out is not possible.

Table 20: Piecewise linear response with external exposure mode register settings

| Register name | Register address | Default value | Description of the value                     |
|---------------|------------------|---------------|--|
| Nr_slopes     | 54[1:0]          | 1             | Defines the number of slopes (min=1, max=3). |
| Vlow3         | 90[6:0]          | 96            | Defines the Vlow3 voltage (DAC setting).     |
| Vlow2         | 89[6:0]          | 96            | Defines the Vlow2 voltage (DAC setting).     |

The timing that needs to be applied in this external exposure mode looks like the one shown in Figure 45.

Figure 45: Timing of external exposure mode



7.4.2.3 Multi-frame read-out

The sensor has the possibility to read-out multiple frames with increasing exposure time for each frame. The exposure time step and number of frames can be programmed using the appropriate registers. The frames grabbed in this mode, can be combined to create one high dynamic range image. This combination needs to be made by the receiving system.

The following registers should be used when this multi-frame read-out is selected. This mode only works with internal exposure time setting.

Table 21: Multi-frame read-out mode register settings

| Register name | Register address | Default value | Description of the value   |
|---------------|------------------|---------------|--|
| Exp_time      | 42[7:0]          | 2048          | Defines the exposure time of the first frame in the sequence. Formula: |
|               | 43[7:0]          |               | $129 * clk\_per(0.43 * fot\_length + Exp\_time)$                       |
|               | 44[7:0]          |               | Where $clk\_per$ is the period of the CLK_IN input clock.              |



| Register name | Register address | Default value | Description of the value   |
|---------------|------------------|---------------|--|
| Exp_step      | 45[7:0]          | 0             | <p>Defines the step size for the increasing exposure times in multi-frame read-out. This value will be added to Exp_time per frame. So the exposure time for the <math>n^{\text{th}}</math> frame is:</p> $129 * clk\_per(0.43 * fot\_length + Exp\_time + (n - 1) * Exp\_step)$ <p>Where clk_per is the period of the CLK_IN input clock and n is the <math>n^{\text{th}}</math> frame.</p> |
|               | 46[7:0]          |               |  |
|               | 47[7:0]          |               |  |
| Exp_seq       | 55[7:0]          | 1             | Defines the number of frames to be read-out in multi-frame mode (min = 1, max = 255).  |

### 7.4.3 Windowing

To limit the amount of data or to increase the frame rate of the sensor, windowing in Y direction is possible. The number of lines and start address can be set by programming the appropriate registers. The CMV4000 has the possibility to read-out multiple (max = 8) predefined sub windows in one read-out cycle. The default mode is to read-out one window with the full frame size (2048 x 2048).

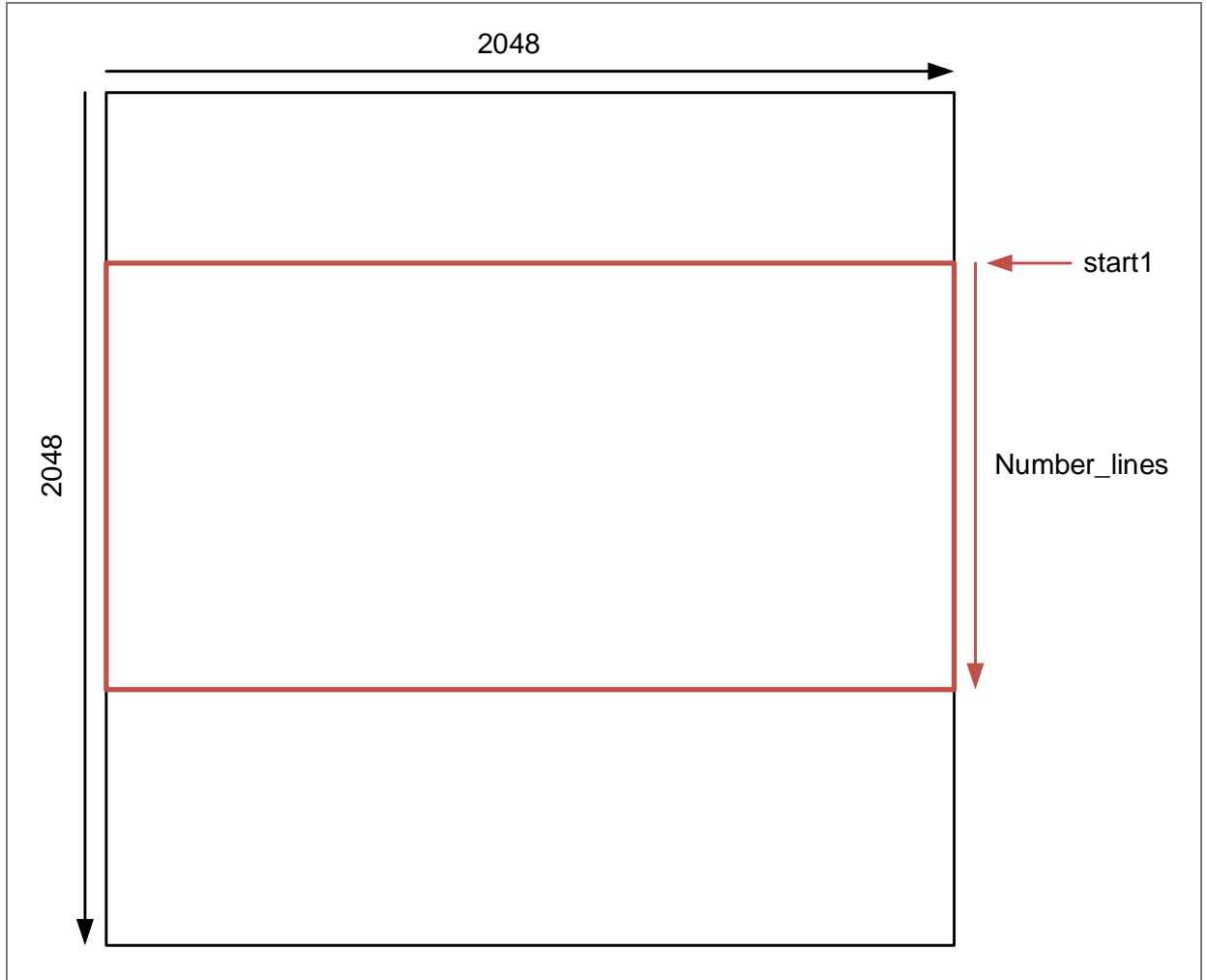
#### 7.4.3.1 Single window

When a single window is read out, the start address and size can be uploaded in the corresponding registers. The default start address is 0 and the default size is 1088 (full frame), like shown in Table 22 and Figure 46.

Table 22: Single window register settings

| Register name | Register address | Default value | Description if the value   |
|---------------|------------------|---------------|--|
| start1        | 3[7:0]           | 0             | Defines the start address of the window in Y (min=0, max=2047)       |
|               | 4[7:0]           |               |  |
| Number_lines  | 1[7:0]           | 2048          | Defines the number of lines read-out by the sensor (min=1, max=2048) |
|               | 2[7:0]           |               |  |

Figure 46: Window structure



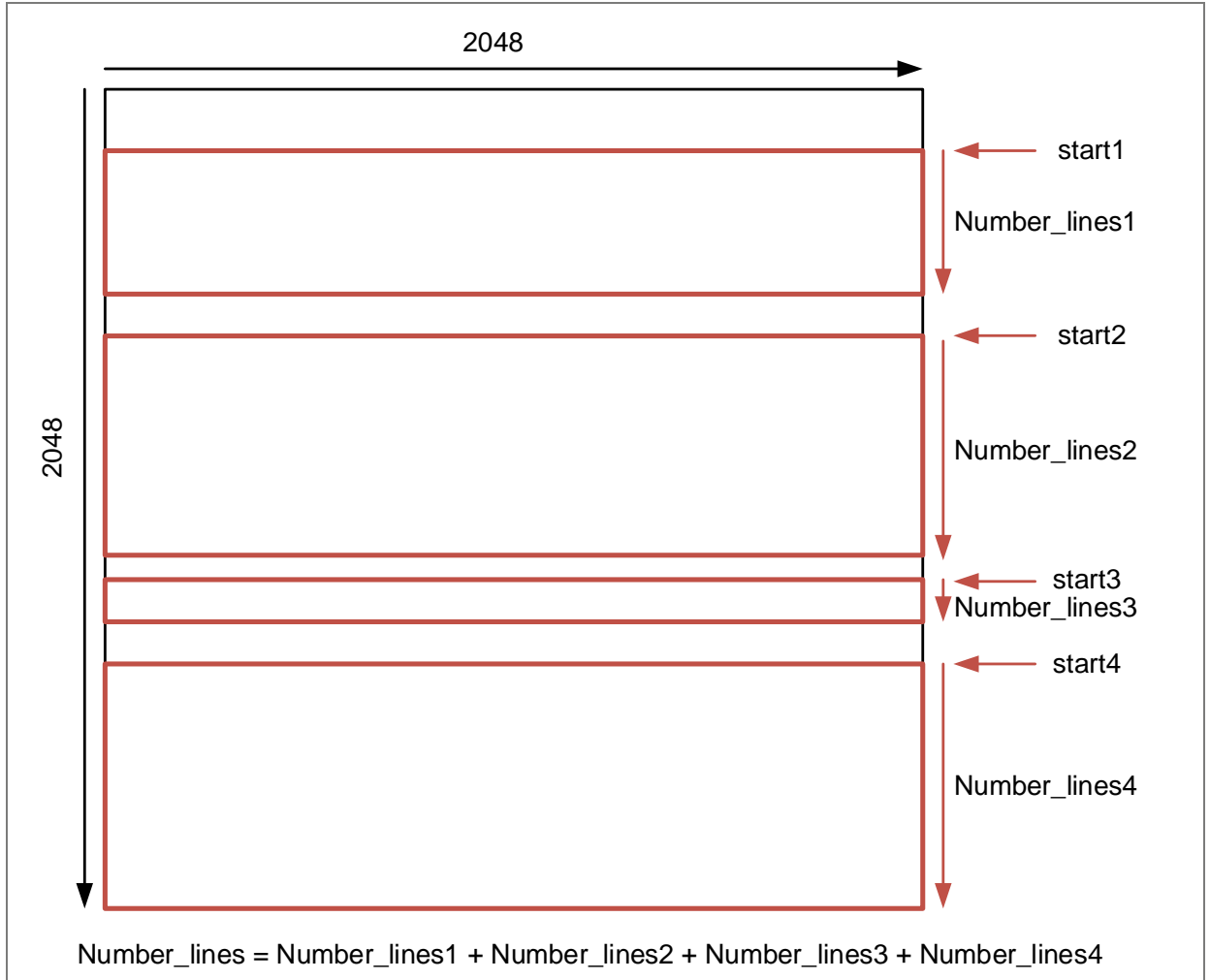
#### 7.4.3.2 Multiple window

The CMV4000 can read out a maximum of 8 different sub windows in one read-out cycle. The location and length of these sub windows must be programmed in the correct registers. The total number of lines to be read-out (sum of all windows) needs to be specified in the Number\_lines register. The registers which need to be programmed for the multiple windows can be found in Table 23. The default values will result in one window with 2048 lines to be read out.

Table 23: Multiple window register settings

| Register name | Register address   | Default value | Description of the value   |
|---------------|--------------------|---------------|--|
| Number_lines  | 1[7:0]<br>2[7:0]   | 2048          | Defines the total number of lines read-out by the sensor (min = 1, max = 2048) |
| start1        | 3[7:0]<br>4[7:0]   | 0             | Defines the start address of the first window in Y (min = 0, max = 2047)       |
| Number_lines1 | 19[7:0]<br>20[7:0] | 0             | Defines the number of lines of the first window (min = 1, max = 2048)          |
| start2        | 5[7:0]<br>6[7:0]   | 0             | Defines the start address of the second window in Y (min = 0, max = 2047)      |
| Number_lines2 | 21[7:0]<br>22[7:0] | 0             | Defines the number of lines of the second window (min = 1, max = 2048)         |
| start3        | 7[7:0]<br>8[7:0]   | 0             | Defines the start address of the third window in Y (min = 0, max = 2047)       |
| Number_lines3 | 23[7:0]<br>24[7:0] | 0             | Defines the number of lines of the third window (min = 1, max = 2048)          |
| start4        | 9[7:0]<br>10[7:0]  | 0             | Defines the start address of the fourth window in Y (min = 0, max = 2047)      |
| Number_lines4 | 25[7:0]<br>26[7:0] | 0             | Defines the number of lines of the fourth window (min = 1, max = 2048)         |
| start5        | 11[7:0]<br>12[7:0] | 0             | Defines the start address of the fifth window in Y (min = 0, max = 2047)       |
| Number_lines5 | 27[7:0]<br>28[7:0] | 0             | Defines the number of lines of the fifth window (min = 1, max = 2048)          |
| start6        | 13[7:0]<br>14[7:0] | 0             | Defines the start address of the sixth window in Y (min = 0, max = 2047)       |
| Number_lines6 | 29[7:0]<br>30[7:0] | 0             | Defines the number of lines of the sixth window (min = 1, max = 2048)          |
| start7        | 15[7:0]<br>16[7:0] | 0             | Defines the start address of the seventh window in Y (min = 0, max = 2047)     |
| Number_lines7 | 31[7:0]<br>32[7:0] | 0             | Defines the number of lines of the seventh window (min = 1, max = 2048)        |
| start8        | 17[7:0]<br>18[7:0] | 0             | Defines the start address of the eighth window in Y (min = 0, max = 2047)      |
| Number_lines8 | 33[7:0]<br>34[7:0] | 0             | Defines the number of lines of the eighth window (min = 1, max = 2048)         |

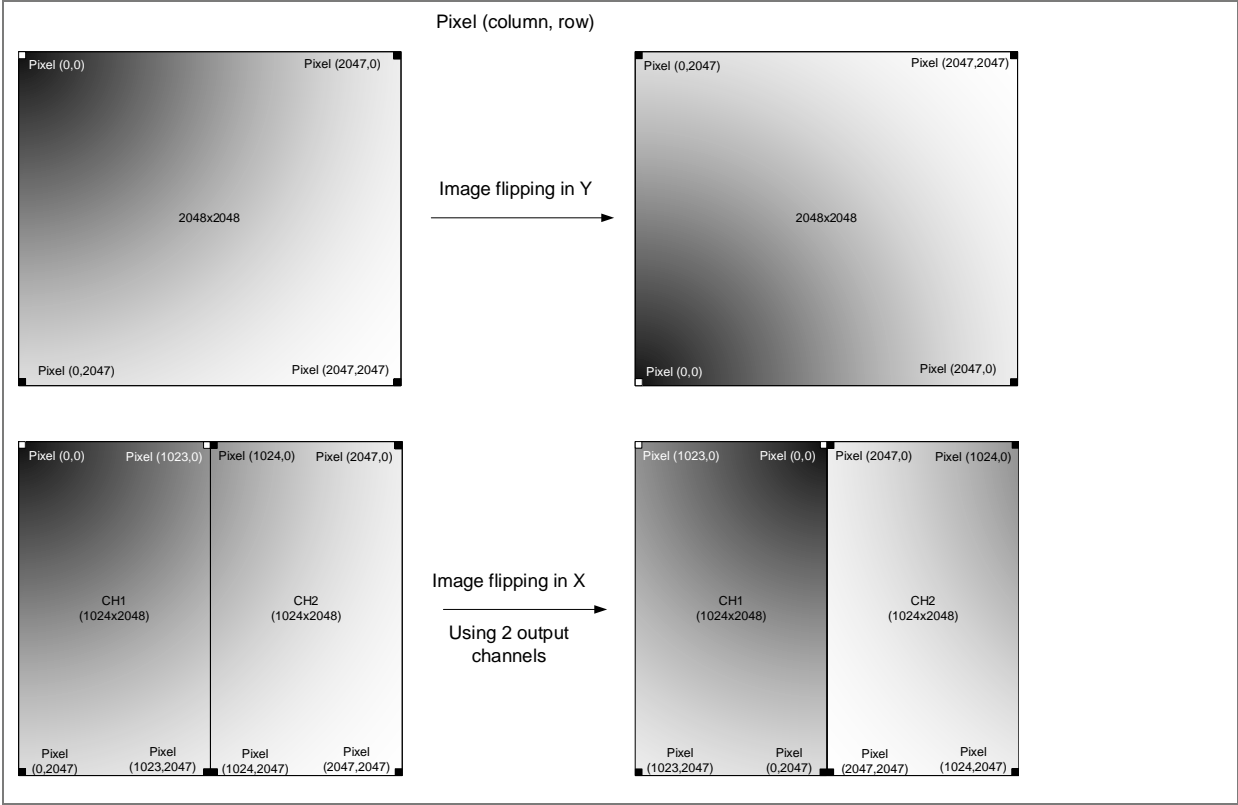
Figure 47: Example of 4 multiple frames read-out



#### 7.4.4 Image flipping

The image coming out of the image sensor can be flipped in X (per channel) and/or Y direction. When no flipping is enabled, the pixel in the upper left corner of the screen - (pixel (0,0) - is read out first. When flipping in Y is enabled, the bottom left pixel (0,2047) is read out first instead of the top left pixel (0,0). When flipping in X is enabled, only the pixels within a channel are mirrored, not the channels themselves. Therefore, the first row to be read out is pixel (1023,0) to pixel (0,0) in channel 1 and pixel (2047,0) to pixel (1024,0) in channel 2.

Figure 48: Image flipping



The following registers are involved in image flipping:

Table 24: Image flipping register settings

| Register name  | Register address | Default value | Description of the value   |
|----------------|------------------|---------------|--|
| Image_flipping | 40[1:0]          | 0             | 0: No image flipping<br>1: Image flipping in X<br>2: Image flipping in Y<br>3: Image flipping in X and Y |

7.4.5 Image subsampling

To maintain the same field of view but reduce the amount of data coming out of the sensor, a subsampling mode is implemented on the chip. Different subsampling schemes can be programmed by setting the appropriate registers. These subsampling schemes can take into account whether a color or monochrome sensor is used to preserve the Bayer pattern information. A distinction is made between a simple and advanced mode (can be used for color devices). Subsampling can be enabled in every windowing mode.

The following paragraphs describe the registers involved in subsampling in detail.

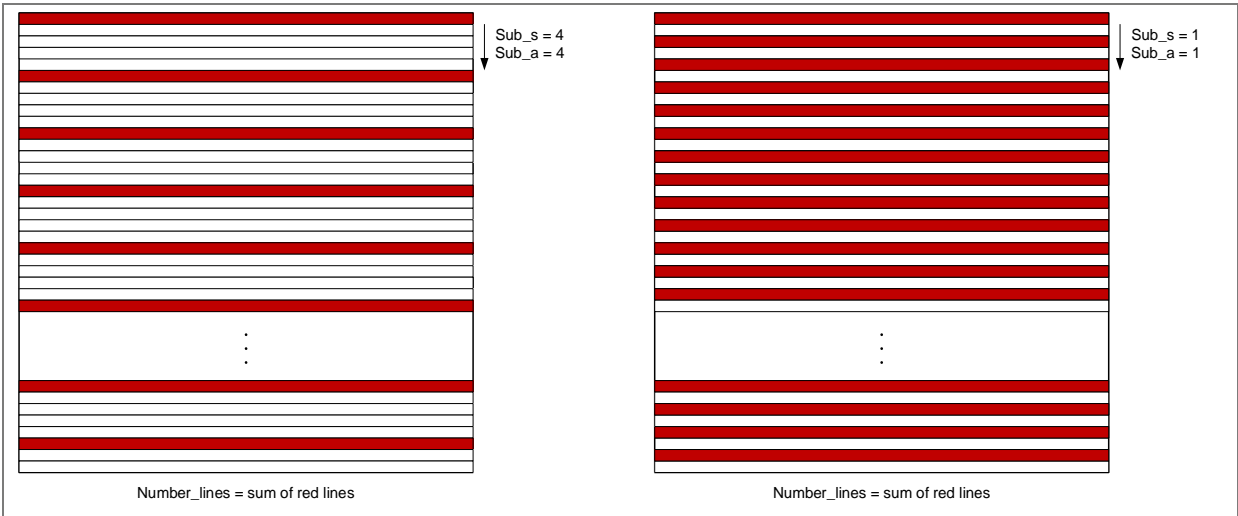
7.4.5.1 Simple subsampling

Table 25: Simple subsampling register settings

| Register name | Register address   | Default value | Description of the value   |
|---------------|--------------------|---------------|--|
| Number_lines  | 1[7:0]<br>2[7:0]   | 2048          | Defines the total number of lines read-out by the sensor (min=1, max=2048) |
| Sub_s         | 35[7:0]<br>36[7:0] | 0             | Number of rows to skip (min=0, max=2048)                                   |
| Sub_a         | 37[7:0]<br>38[7:0] | 0             | Identical to Sub_s   |

Figure 49 shows two subsampling examples (skip 4x and skip 1x).

Figure 49: Subsampling examples (skip 4x and skip 1x)



7.4.5.2 Advanced subsampling

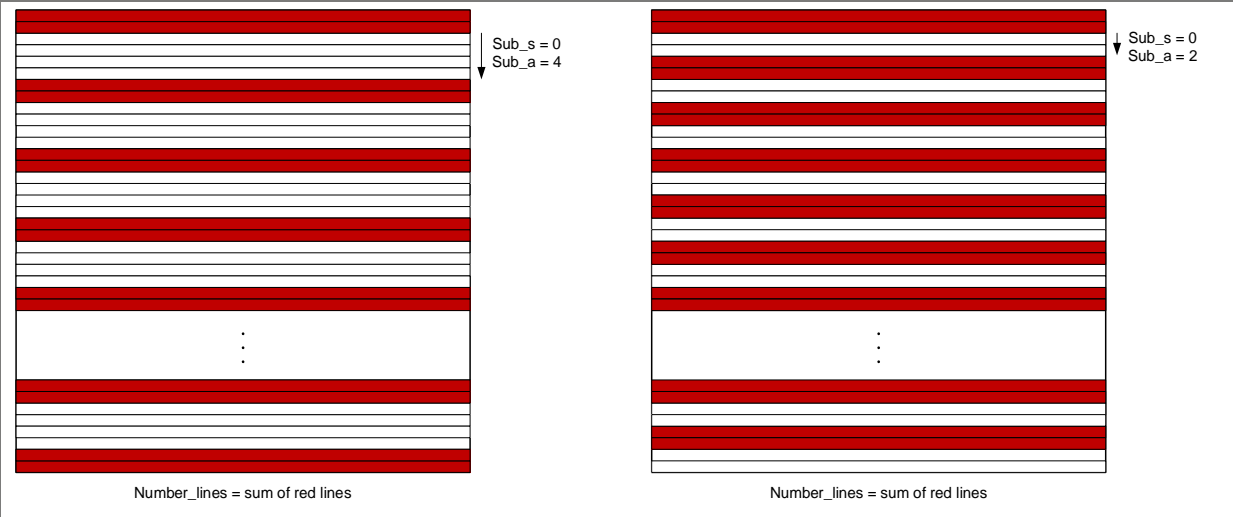
When a color sensor is used, the subsampling scheme should take into account that a Bayer color filter is applied on the sensor. This Bayer pattern should be preserved when subsampling is used. This means that the number of rows to be skipped should always be a multiple of two. An advanced subsampling scheme can be programmed to achieve these requirements. Of course, this advanced subsampling scheme can also be programmed in a monochrome sensor. See Table 26 for more details.

Table 26: Advanced subsampling register settings

| Register name | Register address   | Default value | Description of the value   |
|---------------|--------------------|---------------|--|
| Number_lines  | 1[7:0]<br>2[7:0]   | 2048          | Defines the total number of lines read-out by the sensor (min = 1, max = 2048) |
| Sub_s         | 35[7:0]<br>36[7:0] | 0             | Should be '0' at all times   |
| Sub_a         | 37[7:0]<br>38[7:0] | 0             | Number of rows to skip, it should be an even number between (0 and 2046).      |

Figure 50 shows two subsampling examples (skip 4x and skip 2x) in advanced mode.

Figure 50: Subsampling examples in advanced mode (skip 4x and skip 2x)



7.4.6 Number of frames

When internal exposure mode is selected, the number of frames sent by the sensor after a frame request can be programmed in the corresponding sequencer register.

Table 27: Number of frames register settings

| Register name | Register address   | Default value | Description of the value  |
|---------------|--------------------|---------------|---|
| Number_frames | 70[7:0]<br>71[7:0] | 1             | Defines the number of frames grabbed and sent by the image sensor in internal exposure mode (min =1, max = 65535) |

7.5 Configuring output data format

7.5.1 Output modes

The number of LVDS channels can be selected by programming the appropriate sequencer register. The pixel remapping scheme and the read-out timing for each mode can be found in chapter 7.3 of this document.

Table 28: Different output modes register settings

| Register name | Register address | Default value | Description of the value                                      |
|---------------|------------------|---------------|---|
| Output_mode   | 72[1:0]          | 0             | 0: 16 outputs<br>1: 8 outputs<br>2: 4 outputs<br>3: 2 outputs |



## 7.5.2 Training patterns

As detailed in chapter 7.3.6, a training pattern is sent over the LVDS data channels whenever no valid image data is sent. This training pattern can be programmed using the sequencer register. The training pattern register settings are shown in the following table:

Table 29: Training pattern register settings

| Register name    | Register address   | Default value | Description of the value  |
|------------------|--------------------|---------------|---|
| Training_pattern | 78[7:0]<br>79[3:0] | 85            | The 12 LSBs of this 16-bit word are sent in 12-bit mode. In 10-bit mode the 10 LSBs are sent. |

## 7.5.3 10-bit or 12-bit mode

The CMV4000 has the possibility to send 12 bits or 10 bits per pixel. The end user can select the desired resolution by programming the corresponding sequencer register. Always keep Bit\_mode and ADC\_Resolution in the same bit mode. This is shown in Table 30.

Table 30: Bit mode and ADC resolution register settings for version 2

| Register name  | Register address | Default value | Description of the value   |
|----------------|------------------|---------------|--|
| Bit_mode       | 111[0]           | 1             | 0: 12 bits per pixel<br>1: 10 bits per pixel                         |
| ADC_Resolution | 112[1:0]         | 0             | 0: 10 bits per pixel<br>1: 11 bits per pixel<br>2: 12 bits per pixel |

Version 3 of this image sensor offers an ADC resolution of 11 bits. The bit mode must be changed like shown in Table 31.

Table 31: Bit mode and ADC resolution register settings for version 3

| Register name  | Register address | Default value | Description of the value |
|----------------|------------------|---------------|--------------------------|
| Bit_mode       | 111[0]           | 1             | 0: 12 bits per pixel     |
|                |                  |               | 1: 10 bits per pixel     |
| ADC_Resolution | 112[1:0]         | 0             | 0: 10 bits per pixel     |
|                |                  |               | 1: 11 bits per pixel     |
|                |                  |               | 2: 12 bits per pixel     |
|                | 117[7:0]         | 8             | 10-bit: Set to 8         |
|                |                  |               | 12-bit: Set to 4         |
|                | 116[3:0]         | 9             | 10-bit: Set to 9         |
|                |                  |               | 12-bit: Set to 11        |

7.5.4 Data rate

**Information:**  
This is only applicable for Version 2.

During start-up or after a sequencer reset, the data rate can be changed if a lower speed than 480 Mbps is desired. This can be done by applying a lower master input clock (CLK\_IN) and high speed LVDS clock (LVDS\_CLK\_N/P) to the sensor. See chapter 7.2.4 for more details on the input clock and chapter 7.2.5 for details on how the data rate can be changed. No registers have to be changed when using a data rate different from 480 Mbps.

7.5.5 Power control

The power consumption of the CMV4000 can be decreased by disabling the LVDS data channels when they are not used (in 8, 4 or 2 outputs mode). The power will decrease with approximately 18 mW per channel. So, reducing the outputs from 16 to 4 will save you about 216 mW or 33%. This is the main source for power saving. Other settings (such as bitrate, fps, temperature ...) will have very little to no effect on the total power consumption.

Table 32: Power control register settings

| Register name | Register address | Default value | Description of the value                          |
|---------------|------------------|---------------|---|
| Channel_en    | 80[7:0]          | All '1'       | Bits 0-15 enable/disable the data output channels |
|               | 81[7:0]          |               | Bit 16 enables/disables the clock channel         |
|               | 82[2:0]          |               | Bit 17 enables/disables the control channel       |
|               |                  |               | Bit 18 enables/disables the LVDS clock input      |
|               |                  |               | 0: Disabled                                       |
|               |                  |               | 1: Enabled  |

Decreasing the master clock frequency and thereby the LVDS clock frequency will also decrease power consumption albeit little. Decreasing the LVDS\_CLK frequency from 480 MHz to 128 MHz will decrease power consumption with about 25 mW. All power savings will happen on the VDD20 supply. Other settings or factors have little to no effect on the power consumption.

7.6 Configuring on-chip data

7.6.1 Offset and gain

7.6.1.1 Offset

A digital offset can be applied to the output signal. This dark level offset can be programmed by setting the desired value in the sequencer register. The 14-bit register value is a 2's complement number, allowing to have a positive and a negative offset (from 8191 to -8192). The ADC itself has a fixed offset of 70.

So, the dark-level @ output = 70 + Offset (in 2's complement). For example, register value 16323 (11 1111 1100 0011) equals -61 in 2's complement. The default dark-level is thus set at 70-61 = 9 digital numbers.

Table 33: Offset

| Register name | Register address     | Default value | Description of the value  |                   |           |
|---------------|----------------------|---------------|---|-------------------|-----------|
| Offset        | 100[7:0]<br>101[5:0] | 16323         | Defines the dark level offset applied to the output signal (min = 0, max = 16383).<br>The value is in 2's complement: |                   |           |
|               |                      |               | Decimal   | Binary            | 2's Comp. |
|               |                      |               | 0   | 00 0000 0000 0000 | 0         |
|               |                      |               | 1   | 00 0000 0000 0001 | 1         |
|               |                      |               | ...   | ...               | ...       |
|               |                      |               | 8191  | 01 1111 1111 1111 | 8191      |
|               |                      |               | 8192  | 10 0000 0000 0000 | -8192     |
|               |                      |               | 8193  | 10 0000 0000 0001 | -8191     |
|               |                      |               | ...   | ...               | ...       |
|               |                      |               | 16383   | 11 1111 1111 1111 | -1        |

7.6.1.2 Gain

An analog gain and ADC gain can be applied to the output signal. The analog gain is applied by a PGA in every column. The digital gain is applied by the ADC.

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**Information:**

Depending on the sensor version, there is a slight difference in the register settings. Therefore, depending on the sensor version the user should follow Table 34 for version 2 and Table 35 for version 3.

Table 34: Gain settings for version 2

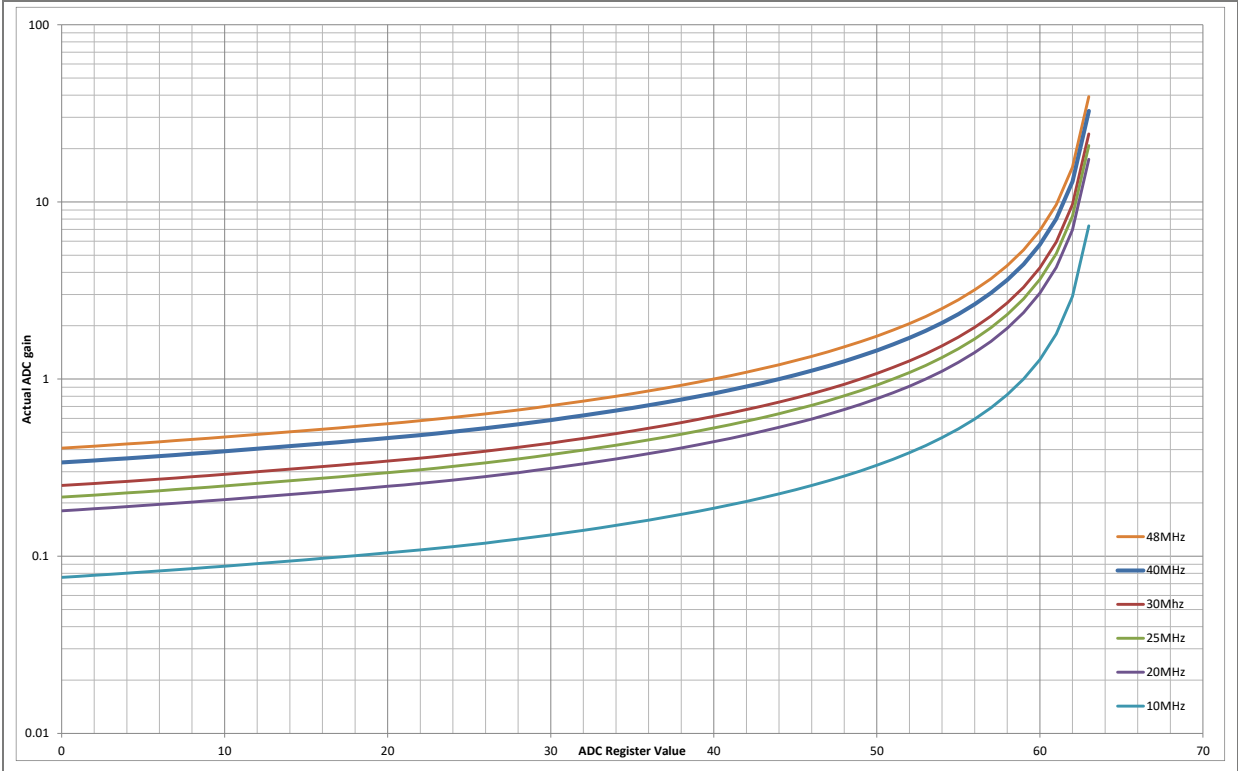
| Register name | Register address | Default value | Description of the value  |
|---------------|------------------|---------------|---|
| PGA_gain      | 102[1:0]         | 0             | <u>102[1:0]</u><br>0: x1 gain<br>1: x1.2 gain<br>2: x1.4 gain<br>3: x1.6 gain |
|               |                  |               |   |
| ADC_gain      | 103[7:0]         | 32            | Defines the slope of the ADC ramp, a higher value equals more gain.           |

Table 35: Gain settings for version 3

| Register name | Register address   | Default value | Description of the value  |
|---------------|--------------------|---------------|---|
| PGA_gain      | 102[1:0]<br>121[0] | 0             | <u>102[1:0]</u><br>0: x1 gain<br>1: x1.2 gain<br>2: x1.4 gain<br>3: x1.6 gain<br><u>121[0]</u><br>0: Gain is defined in 102[1:0]<br>1: Gain in 102[1:0] is amplified by 2 |
|               |                    |               |   |
| ADC_gain      | 103[7:0]           | 32            | Defines the slope of the ADC ramp, a higher value equals more gain.   |

The ADC gain is dependent on the master clock. A slower clock signal means a higher ADC\_gain register value for an actual ADC gain of 1x. Also at higher register values, the actual ADC gain will increase in bigger steps. So, fine-tuning the ADC gain is easier at lower register values.

Figure 51: Typical graphs of gain setting



7.6.2 Black reference columns



Information:

This chapter is just applicable for Version 3.

When the appropriate SPI register is set, the 16 first columns will be put to an electrical black reference. This electrical black reference can be used to reduce the row noise and/or track black level.

Table 36: Black columns

| Register name | Register address | Default value | Description of the value |
|---------------|------------------|---------------|--------------------------|
| Black_col_en  | 121[1]           | 0             | 0: Disable<br>1: Enable  |

### 7.6.3 Horizontal line effect during exposure start



#### Information:

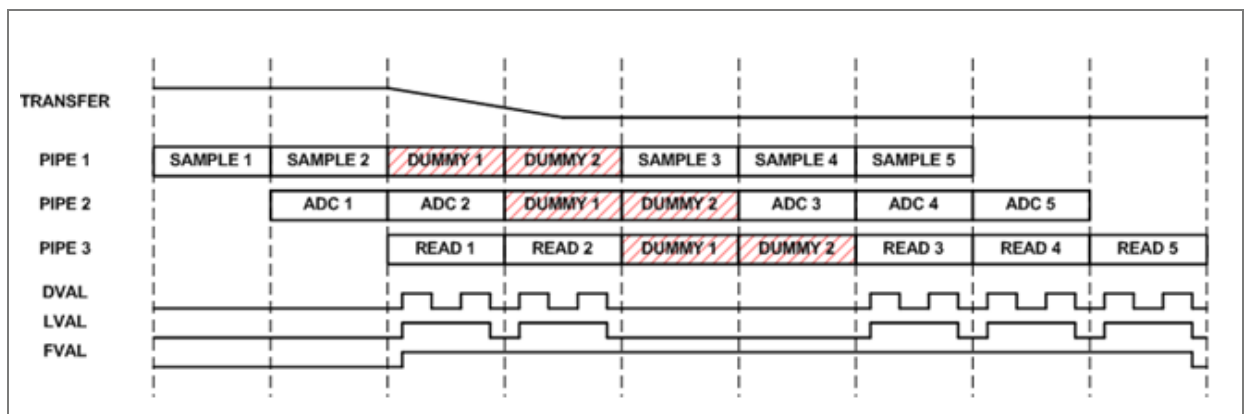
This chapter is just applicable for Version 3.

When the exposure of an image frame is started while a previous image frame is read out this action may become visible in the image frame currently read out. The effect is visible in the line addressed for read-out at the moment the exposure of the next image frame starts. Depending on the moment when the exposure starts within the line read-out time, this will result in a bright or dark offset for the addressed line. This horizontal line artifact is due to the cross-talk of the global transfer gate pulse on the column read-out.

This problem is solved by changing the sequencer timing. At the moment the global transfer is pulsed, a programmable number of dummy rows can be inserted in the read-out. This means that the transfer pulse crosstalk does not influence valid data rows.

The exact internal impact of the new timing depends on the read-out and exposure modes (PLR, internal or external exposure control...). Externally, the only impact is that the DVAL and LVAL outputs are not pulsed for a number of row periods. The external system should always monitor the DVAL, LVAL and FVAL pulses to know when valid pixels, lines and frames become available. Figure 52 shows the timing (in case of 2 dummy rows).

Figure 52: Timing of DVAL, LVAL and FVAL to avoid horizontal line artifact



By default, no dummy rows are inserted in the read-out. The dummy rows are enabled by loading the appropriate values to the register `inte_sync` and `dummy`.

Table 37: Dummy rows

| Register name | Register address | Default value | Description of the value           |
|---------------|------------------|---------------|------------------------------------|
| Inte_sync     | 41[2]            | 0             | Must be set to 1 if Dummy is not 0 |
| Dummy         | 118[7:0]         | 0             | Sets the number of dummy rows      |



**Information:**

Note that the register 'dummy' sets the number of dummy rows (one row corresponds to one LVAL pulse). In multiplex modes, there are several timing slots within a single row read-out. In case dual exposure is used, the dummy rows are generated for both transfer pulse toggles.



# 8 Register description

The Table 38 gives an overview of all the sensor registers. The registers with the remark “Do not change” should not be changed unless advised in chapter 7.4.

## 8.1 Register overview

Table 38: Register overview

| Address | Default | Value  |        |        |                     |        |        |        |        | Remark        |
|---------|---------|--------|--------|--------|---------------------|--------|--------|--------|--------|---------------|
|         |         | bit[7] | bit[6] | bit[5] | bit[4]              | bit[3] | bit[2] | bit[1] | bit[0] |               |
| 0       | 0       |        |        |        |                     |        |        |        |        | Do not change |
| 1       | 0       |        |        |        | Number_lines [7:0]  |        |        |        |        |               |
| 2       | 8       |        |        |        | Number_lines [15:8] |        |        |        |        |               |
| 3       | 0       |        |        |        | Start1[7:0]         |        |        |        |        |               |
| 4       | 0       |        |        |        | Start1[15:8]        |        |        |        |        |               |
| 5       | 0       |        |        |        | Start2[7:0]         |        |        |        |        |               |
| 6       | 0       |        |        |        | Start2[15:8]        |        |        |        |        |               |
| 7       | 0       |        |        |        | Start3[7:0]         |        |        |        |        |               |
| 8       | 0       |        |        |        | Start3[15:8]        |        |        |        |        |               |
| 9       | 0       |        |        |        | Start4[7:0]         |        |        |        |        |               |
| 10      | 0       |        |        |        | Start4[15:8]        |        |        |        |        |               |
| 11      | 0       |        |        |        | Start5[7:0]         |        |        |        |        |               |
| 12      | 0       |        |        |        | Start5[15:8]        |        |        |        |        |               |
| 13      | 0       |        |        |        | Start6[7:0]         |        |        |        |        |               |
| 14      | 0       |        |        |        | Start6[15:8]        |        |        |        |        |               |
| 15      | 0       |        |        |        | Start7[7:0]         |        |        |        |        |               |
| 16      | 0       |        |        |        | Start7[15:8]        |        |        |        |        |               |
| 17      | 0       |        |        |        | Start8[7:0]         |        |        |        |        |               |
| 18      | 0       |        |        |        | Start8[15:8]        |        |        |        |        |               |
| 19      | 0       |        |        |        | Number_lines1[7:0]  |        |        |        |        |               |
| 20      | 0       |        |        |        | Number_lines1[15:8] |        |        |        |        |               |
| 21      | 0       |        |        |        | Number_lines2[7:0]  |        |        |        |        |               |
| 22      | 0       |        |        |        | Number_lines2[15:8] |        |        |        |        |               |
| 23      | 0       |        |        |        | Number_lines3[7:0]  |        |        |        |        |               |
| 24      | 0       |        |        |        | Number_lines3[15:8] |        |        |        |        |               |
| 25      | 0       |        |        |        | Number_lines4[7:0]  |        |        |        |        |               |
| 26      | 0       |        |        |        | Number_lines4[15:8] |        |        |        |        |               |

| Address | Default | Value                   |        |        |        |        |                              |              |             | Remark        |
|---------|---------|-------------------------|--------|--------|--------|--------|------------------------------|--------------|-------------|---------------|
|         |         | bit[7]                  | bit[6] | bit[5] | bit[4] | bit[3] | bit[2]                       | bit[1]       | bit[0]      |               |
| 27      | 0       | Number_lines5[7:0]      |        |        |        |        |                              |              |             |               |
| 28      | 0       | Number_lines5[15:8]     |        |        |        |        |                              |              |             |               |
| 29      | 0       | Number_lines6[7:0]      |        |        |        |        |                              |              |             |               |
| 30      | 0       | Number_lines6[15:8]     |        |        |        |        |                              |              |             |               |
| 31      | 0       | Number_lines7[7:0]      |        |        |        |        |                              |              |             |               |
| 32      | 0       | Number_lines7[15:8]     |        |        |        |        |                              |              |             |               |
| 33      | 0       | Number_lines8[7:0]      |        |        |        |        |                              |              |             |               |
| 34      | 0       | Number_lines8[15:8]     |        |        |        |        |                              |              |             |               |
| 35      | 0       | Sub_s[7:0]              |        |        |        |        |                              |              |             |               |
| 36      | 0       | Sub_s[15:8]             |        |        |        |        |                              |              |             |               |
| 37      | 0       | Sub_a[7:0]              |        |        |        |        |                              |              |             |               |
| 38      | 0       | Sub_a[15:8]             |        |        |        |        |                              |              |             |               |
| 39      | 1       | mono                    |        |        |        |        |                              |              |             |               |
| 40      | 0       | Image_flipping<br>[1:0] |        |        |        |        |                              |              |             |               |
| 41      | 0       |                         |        |        |        |        | Inte_sy<br>nc <sup>(1)</sup> | Exp_<br>dual | Exp_<br>ext | V3:Set to 4   |
| 42      | 0       | Exp_time[7:0]           |        |        |        |        |                              |              |             |               |
| 43      | 8       | Exp_time[15:8]          |        |        |        |        |                              |              |             |               |
| 44      | 0       | Exp_time[23:16]         |        |        |        |        |                              |              |             |               |
| 45      | 0       | Exp_step[7:0]           |        |        |        |        |                              |              |             |               |
| 46      | 0       | Exp_step[15:8]          |        |        |        |        |                              |              |             |               |
| 47      | 0       | Exp_step[23:16]         |        |        |        |        |                              |              |             |               |
| 48      | 1       | Exp_kp1[7:0]            |        |        |        |        |                              |              |             |               |
| 49      | 0       | Exp_kp1[15:8]           |        |        |        |        |                              |              |             |               |
| 50      | 0       | Exp_kp1[23:16]          |        |        |        |        |                              |              |             |               |
| 51      | 1       | Exp_kp2[7:0]            |        |        |        |        |                              |              |             |               |
| 52      | 0       | Exp_kp2[15:8]           |        |        |        |        |                              |              |             |               |
| 53      | 0       | Exp_kp2[23:16]          |        |        |        |        |                              |              |             |               |
| 54      | 1       | Nr_slopes[1:0]          |        |        |        |        |                              |              |             |               |
| 55      | 1       | Exp_seq[7:0]            |        |        |        |        |                              |              |             |               |
| 56      | 0       | Exp_time2[7:0]          |        |        |        |        |                              |              |             |               |
| 57      | 8       | Exp_time2[15:8]         |        |        |        |        |                              |              |             |               |
| 58      | 0       | Exp_time2[23:16]        |        |        |        |        |                              |              |             |               |
| 59      | 0       | Exp_step2[7:0]          |        |        |        |        |                              |              |             |               |
| 60      | 0       | Exp_step2[15:8]         |        |        |        |        |                              |              |             |               |
| 61      | 0       | Exp_step2[23:16]        |        |        |        |        |                              |              |             |               |
| 62      | 1       |                         |        |        |        |        |                              |              |             | Do not change |

| Address | Default         | Value                   |        |        |        |        |        |                                |                              | Remark   |
|---------|-----------------|-------------------------|--------|--------|--------|--------|--------|--------------------------------|------------------------------|--|
|         |                 | bit[7]                  | bit[6] | bit[5] | bit[4] | bit[3] | bit[2] | bit[1]                         | bit[0]                       |  |
| 63      | 0               |                         |        |        |        |        |        |                                |                              | Do not change                                      |
| 64      | 0               |                         |        |        |        |        |        |                                |                              | Do not change                                      |
| 65      | 1               |                         |        |        |        |        |        |                                |                              | Do not change                                      |
| 66      | 0               |                         |        |        |        |        |        |                                |                              | Do not change                                      |
| 67      | 0               |                         |        |        |        |        |        |                                |                              | Do not change                                      |
| 68      | 1               |                         |        |        |        |        |        |                                |                              | Do not change                                      |
| 69      | 1               | Exp2_seq[7:0]           |        |        |        |        |        |                                |                              |  |
| 70      | 1               | Number_frames [7:0]     |        |        |        |        |        |                                |                              |  |
| 71      | 0               | Number_frames[15:8]     |        |        |        |        |        |                                |                              |  |
| 72      | 0               |                         |        |        |        |        |        | Output_mode[1:0]               |                              |  |
| 73      | V2: 0<br>V3: 20 | fot_length[7:0]         |        |        |        |        |        |                                |                              | Can be lowered to 10, see chapter 7.4.1            |
| 74      | 8               |                         |        |        |        |        |        | i_lvds_rec[3:0] <sup>(1)</sup> |                              |  |
| 75      | 8               |                         |        |        |        |        |        |                                |                              | Do not change                                      |
| 76      | 8               |                         |        |        |        |        |        |                                |                              | Do not change                                      |
| 77      | 3               |                         |        |        |        |        |        | Col_cal<br>ib <sup>(1)</sup>   | ADC_c<br>alib <sup>(1)</sup> | V2: Do not change<br>V3: Set to 0                  |
| 78      | 85              | Training_pattern[7:0]   |        |        |        |        |        |                                |                              |  |
| 79      | 0               | Training pattern [11:8] |        |        |        |        |        |                                |                              |  |
| 80      | 255             | Channel_en[7:0]         |        |        |        |        |        |                                |                              |  |
| 81      | 255             | Channel_en[15:8]        |        |        |        |        |        |                                |                              |  |
| 82      | 3               |                         |        |        |        |        |        | Channel_en [18:16]             |                              | V2: Set to 7<br>V3: See chapter 7.5.5 and set to 7 |
| 83      | 8               |                         |        |        |        |        |        | i_lvds[3:0]                    |                              | Can be lowered to 4 for meeting EMC standards      |
| 84      | 8               |                         |        |        |        |        |        | I_col[3:0]                     |                              | Set to 4   |
| 85      | 8               |                         |        |        |        |        |        | I_col_prech[3:0]               |                              | Set to 1   |
| 86      | 8               |                         |        |        |        |        |        |                                |                              | Do not change                                      |
| 87      | 8               |                         |        |        |        |        |        | I_amp[3:0] <sup>(1)</sup>      |                              | V2: Do not change<br>V3: Set to 12                 |
| 88      | 96              |                         |        |        |        |        |        | Vtf_l1[6:0]                    |                              | Set to 64  |
| 89      | 96              |                         |        |        |        |        |        | Vlow2[6:0]                     |                              |  |
| 90      | 96              |                         |        |        |        |        |        | Vlow3[6:0]                     |                              |  |

| Address | Default           | Value         |        |        |        |        |        |             |                      | Remark                                     |
|---------|-------------------|---------------|--------|--------|--------|--------|--------|-------------|----------------------|--|
|         |                   | bit[7]        | bit[6] | bit[5] | bit[4] | bit[3] | bit[2] | bit[1]      | bit[0]               |  |
| 91      | 96                | Vres_low[6:0] |        |        |        |        |        |             |                      | Set to 64                                  |
| 92      | 96                |               |        |        |        |        |        |             |                      | Do not change                              |
| 93      | 96                |               |        |        |        |        |        |             |                      | Do not change                              |
| 94      | 96                | V_prech[6:0]  |        |        |        |        |        |             |                      | Set to 101                                 |
| 95      | 96                | V_ref[6:0]    |        |        |        |        |        |             |                      | Set to 106                                 |
| 96      | 96                |               |        |        |        |        |        |             |                      | Do not change                              |
| 97      | 96                |               |        |        |        |        |        |             |                      | Do not change                              |
| 98      | 96                | Vramp1[6:0]   |        |        |        |        |        |             |                      | See 8.2.1                                  |
| 99      | 96                | Vramp2[6:0]   |        |        |        |        |        |             |                      | See 8.2.1                                  |
| 100     | 195               | Offset[7:0]   |        |        |        |        |        |             |                      | See 8.2.1                                  |
| 101     | 63                | Offset[13:8]  |        |        |        |        |        |             |                      | See 8.2.1                                  |
| 102     | 0                 |               |        |        |        |        |        |             | PGA_gain[1:0]        | V3: Set to 1                               |
| 103     | 32                | ADC_gain[7:0] |        |        |        |        |        |             |                      | See 8.2.1                                  |
| 104     | 8                 |               |        |        |        |        |        |             |                      | Do not change                              |
| 105     | 8                 |               |        |        |        |        |        |             |                      | Do not change                              |
| 106     | 8                 |               |        |        |        |        |        |             |                      | Do not change                              |
| 107     | 8                 |               |        |        |        |        |        |             |                      | Do not change                              |
| 108     | 0                 |               |        |        |        |        |        | T_dig1[3:0] |                      |  |
| 109     | 1                 |               |        |        |        |        |        | T_dig2[3:0] |                      |  |
| 110     | 0                 |               |        |        |        |        |        |             |                      | Do not change                              |
| 111     | 1                 |               |        |        |        |        |        |             | Bit_mode             |  |
| 112     | 0                 |               |        |        |        |        |        |             | ADC_resolution [1:0] |  |
| 113     | 1                 |               |        |        |        |        |        |             |                      | V2: Do not change<br>V3: Set to 0          |
| 114     | 0                 |               |        |        |        |        |        |             |                      | Do not change                              |
| 115     | 0                 |               |        |        |        |        |        |             | Config 2             | Only V2: Set to 1                          |
| 115     | 0                 |               |        |        |        |        |        |             |                      | Only V3: Set to 1                          |
| 116     | V2: 32<br>V3: 217 |               |        |        |        |        |        |             |                      | V2: Do not change<br>V3: See chapter 7.5.3 |
| 117     | 8                 |               |        |        |        |        |        |             | Config 1             | Only V2: Set to 1                          |
| 117     | 8                 |               |        |        |        |        |        |             |                      | Only V3: See chapter 7.5.3                 |

| Address | Default           | Value                          |        |        |        |        |        |                             |                            | Remark                             |
|---------|-------------------|--------------------------------|--------|--------|--------|--------|--------|-----------------------------|----------------------------|------------------------------------|
|         |                   | bit[7]                         | bit[6] | bit[5] | bit[4] | bit[3] | bit[2] | bit[1]                      | bit[0]                     |                                    |
| 118     | 0                 | Dummy[7:0]                     |        |        |        |        |        |                             |                            | V2: Do not change<br>V3: Set to 1  |
| 119     | 0                 |                                |        |        |        |        |        |                             |                            | Do not change                      |
| 120     | 0                 |                                |        |        |        |        |        |                             |                            | Do not change                      |
| 121     | 0                 |                                |        |        |        |        |        | Black_col_en <sup>(1)</sup> | PGA_gain[0] <sup>(1)</sup> | V2: Do not change                  |
| 122     | 0                 |                                |        |        |        |        |        |                             |                            | Do not change                      |
| 123     | V2: 0<br>V3: 64   | V_blacksun[5:0] <sup>(1)</sup> |        |        |        |        |        |                             |                            | V2: Do not change<br>V3: Set to 98 |
| 124     | 0                 |                                |        |        |        |        |        |                             |                            | Do not change                      |
| 125     | xx <sup>(2)</sup> |                                |        |        |        |        |        |                             |                            | Do not change                      |
| 126     | 0                 | Temp[7:0]                      |        |        |        |        |        |                             |                            |                                    |
| 127     | 0                 | Temp[15:8]                     |        |        |        |        |        |                             |                            |                                    |

(1) Only applicable to Version3. Those bits are not existing in Version2 and do not change.  
(2) Register 125 can be used to verify which version of sensor is used.

Table 39: Register 125 – sensor version

| Value | Sensor type |
|-------|-------------|
| 64    | CMV4000 V2  |
| 67    | CMV4000 V3  |

## 8.2 Recommended register settings

The following table gives an overview of the registers, which have a required value that is different from their default start-up value. We strongly recommend to load these register settings after start-up and before grabbing an image.



### Information:

Depending on the sensor version, there is a slight difference in the register settings. Therefore, the user should follow Table 40 for version 2 and Table 41 for version 3.

Table 40: Recommended registers for version 2

| Address | Name        | Required value |
|---------|-------------|----------------|
| 82[2:0] | Channel_en  | 7              |
| 84[3:0] | I_col       | 4              |
| 85[3:0] | I_col_prech | 1              |
| 88[6:0] | Vtf_I1      | 64             |
| 91[6:0] | Vres_low    | 64             |
| 94[6:0] | V_precharge | 101            |
| 95[6:0] | V_ref       | 106            |
| 115[0]  | Config2     | 1              |
| 117[0]  | Config1     | 1              |

Table 41: Recommended registers for version 3

| Address | Name                                 | Required value |
|---------|--------------------------------------|----------------|
| 41[2:0] | Inte_sync      Exp_dual      Exp_ext | 4              |
| 77[1:0] | Col_calib      ADC_calib             | 0              |
| 84[3:0] | I_col                                | 4              |
| 85[3:0] | I_col_prech                          | 1              |
| 86[3:0] | I_adc                                | 14             |
| 87[3:0] | I_amp                                | 12             |
| 88[6:0] | Vtf_I1                               | 64             |
| 91[6:0] | Vres_low                             | 64             |
| 94[6:0] | V_prech                              | 101            |
| 95[6:0] | V_ref                                | 106            |

| Address  | Name       | Required value |
|----------|------------|----------------|
| 102[1:0] | PGA        | 1              |
| 118[7:0] | Dummy      | 1              |
| 123[5:0] | V_blacksun | 98             |

### 8.2.1 Adjusting register for optimal performance

Due to processing differences, the response and optical performance may differ slightly from sensor to sensor. To adjust this difference in response, the following registers in should be tuned from sensor to sensor.



#### Information:

Depending on the sensor version, there is a slight difference in the register settings. Therefore, the user should follow Table 42 for version 2 and Table 43 for version 3.

Table 42: Optical performance registers for version 2

| Address  | Name     | Required value | Valid range |
|----------|----------|----------------|-------------|
| 103[7:0] | ADC_GAIN | 32             | 40 - 55     |
| 98[6:0]  | V_ramp1  | 96             | 102 - 115   |
| 99[6:0]  | V_ramp2  | 96             | 102 - 115   |
| 100[7:0] | Offset   | 16323          | 0 - 16383   |

Table 43: Optical performance registers for version 3

| Address              | Name     | Required value   | Valid range |
|----------------------|----------|------------------|-------------|
| 103[7:0]             | ADC_GAIN | See Gain chapter | 0 - 63      |
| 98[6:0]              | V_ramp1  | 109              | 102 - 115   |
| 99[6:0]              | V_ramp2  | 109              | 102 - 115   |
| 100[7:0]<br>101[5:0] | Offset   | 16323            | 0 - 16383   |

To optimize the sensor response and minimize noise, the following procedure should be followed for each sensor:

1. Start by programming all registers with the recommended values from the datasheet.
2. Take fully dark images with short exposure and calibrate the offset register so no pixel clips in black ( $< 0DN$ ).
3. When column non-uniformities are observed in the dark image, a calibration of the  $V\_ramp1$  and  $V\_ramp2$  registers is necessary. These registers set the starting voltage of the ramp used by the column ramp ADC, so adjusting this value will improve column CDS (correlated double sampling) which will reduce the column FPN. Both values should be adjusted together and should always have the same value.
4. Now take images with light and normal exposure. If the image is not saturated, increase the light or the exposure time until all pixels reach a constant value. If not all pixels saturate at 1023 (meaning that the non-linear part of the pixel voltage is in the ADC input range), increase the ADC gain/range setting until they do. The PGA amplifier can also be used at this stage.
5. The dark offset level may have shifted when doing ADC calibration, so repeat step 2.
6. To compensate gain differences between sensors, choose a fixed light setting or exposure time at which the sensor shows a grey image about 50% of its swing (512 at 10-bit). Now tweak the ADC setting per sensor so that all sensors will have the same average grey value of about 512. This way all sensors will behave about the same to the same amount of light.

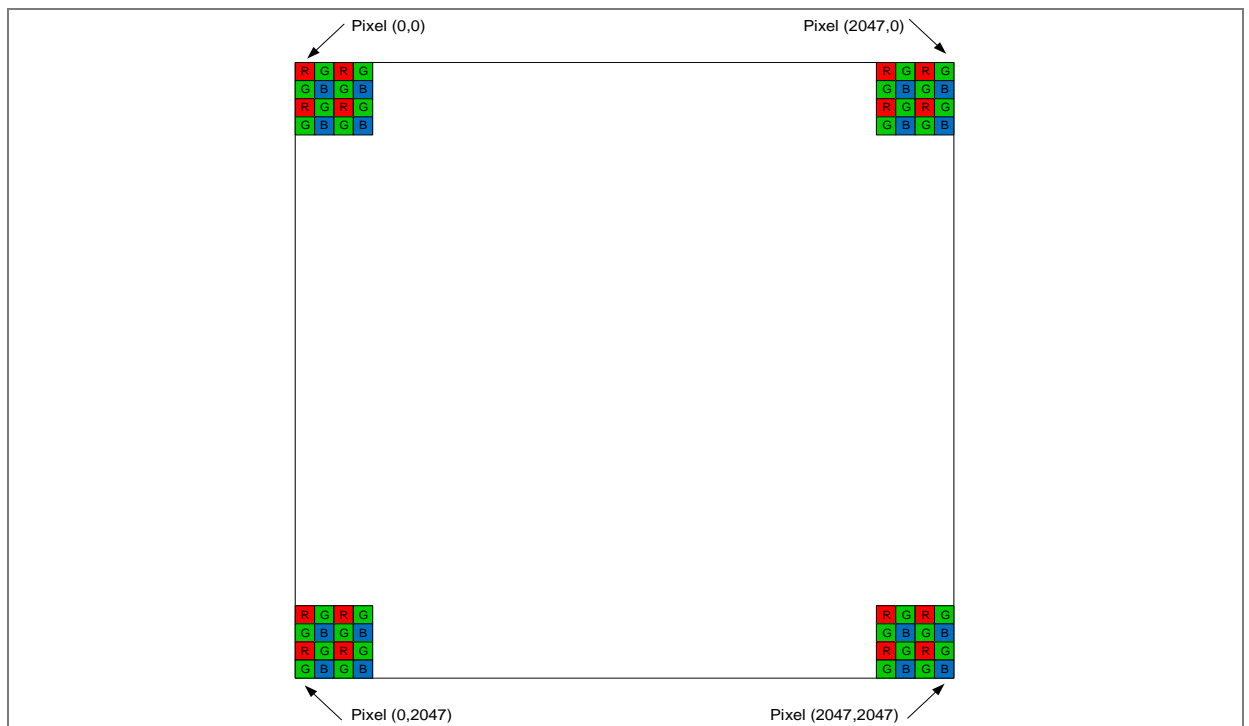


## 9 Application information

### 9.1 Color filter

An RGB Bayer pattern is used on the CMV4000 image sensor. The order of the RGB filter can be found in the drawing below. With Y-flipping off (reg40 = 0), pixel (0,0) at the top left is read out first and has a red filter. When Y-flipping is on, pixel (0,2047) is read out first and has a green filter. For X-flipping the address of the first read pixel depends on the output channels used.

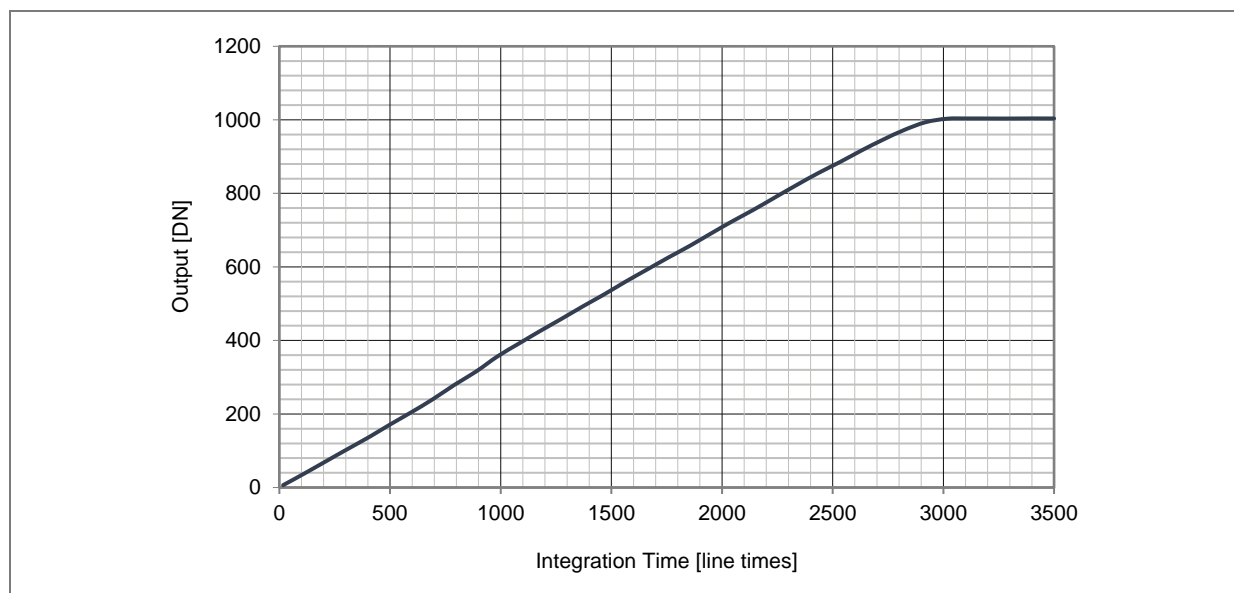
Figure 53: RGB bayer pattern order



## 9.2 Response curve

Figure 54 shows a typical response curve of integration time (or light input) versus the average output value of the sensor.

Figure 54: Typical response curve



## 10 Package drawings & markings

### 10.1 95 pins $\mu$ PGA and LGA

All dimensions are in millimeter. The LGA package (SMD) is identical to the  $\mu$ PGA but without the through-hole pins.

**TOP VIEW**

Dimensions: 16.15±0.16, +0.15, 14.85-0.25, 14.85±0.12, 16.05±0.12, 14.85±0.12, 14.85-0.25, 2.75±0.25

**BOTTOM VIEW**

Dimensions: P 1.27, P 1.27(11)=3.37±0.14 (AT PIN BASE), P 1.27(7)=8.89±0.14 (AT PIN BASE), 12, 11, 10, 9, 8, 7, 6, 5, 4, 3, 2, 1

**Cross-sectional View**

Labels: LAYER-1, LAYER-2 (BA/PAD), LAYER-3 (LAMP), LAYER-4 (LAMP), LAYER-5 (LAMP), LAYER-6 (LAMP), LAYER-7 (D/LAMP), LAYER-8 (PAD, LAMP, PAD), LAYER-9 (PAD, LAMP, PAD), LAYER-10 (LAMP), LAYER-11 (PAD)

**Notes:**

1. POLING (ELECTRODESS):  
M: 1.27 MICRON MIN.  
M: 0.78 MICRON MIN.
2. BONDING TEST: 100% 100% 1.30/-0.20 SECONDS IN OVEN.
3. CROSS-SECTIONAL POLING ON ALUMINUM COAT IS ACCEPTABLE.
4. ELECTRICAL SHORT CHECK OR MICRO-ANALYSIS IS NOT REQUIRED.

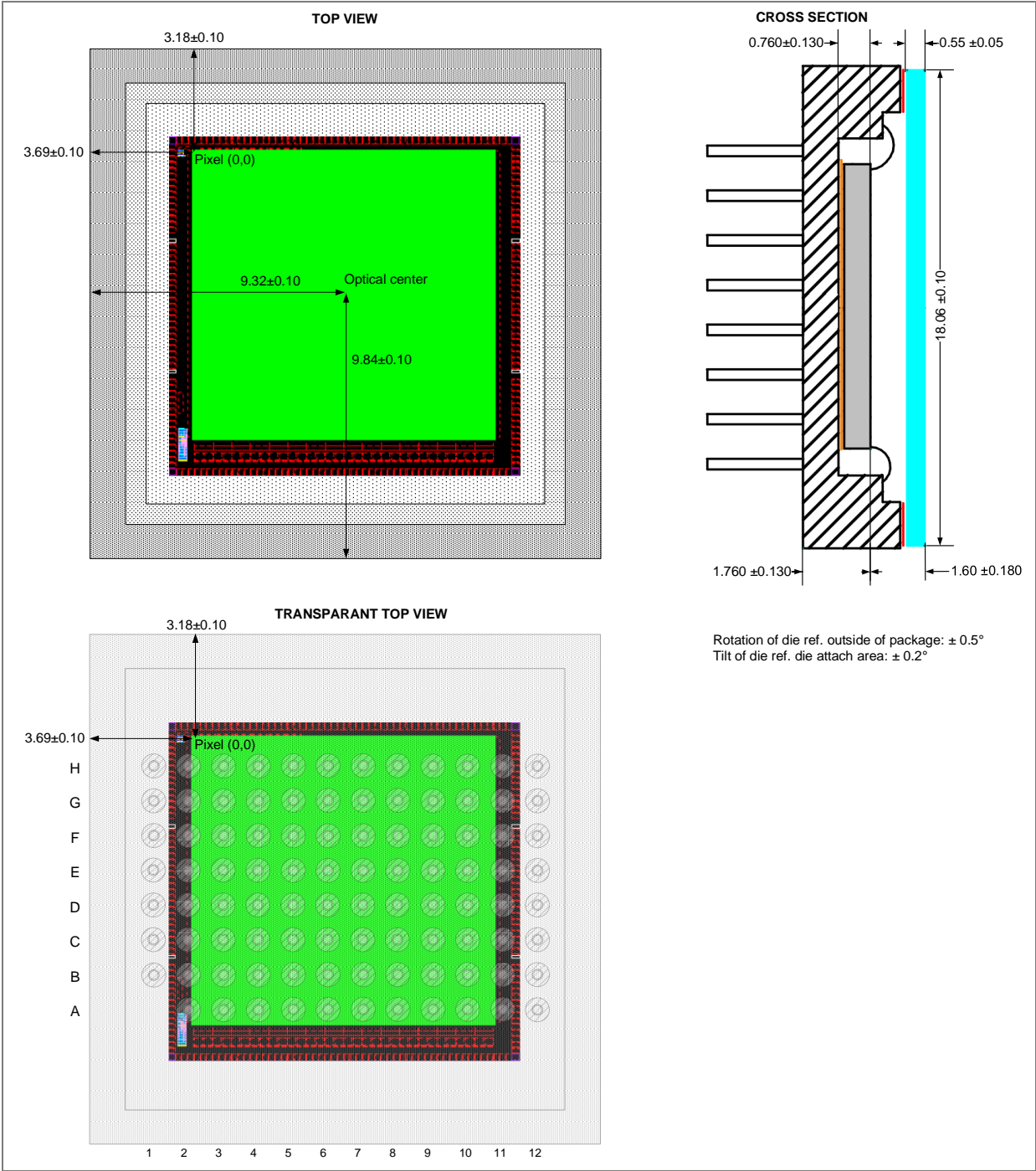
**OSRAM**

**RoHS**

10.1.1 Assembly drawing  $\mu$ PGA

All dimensions are in millimeter.

Figure 56: Assembly drawing  $\mu$ PGA

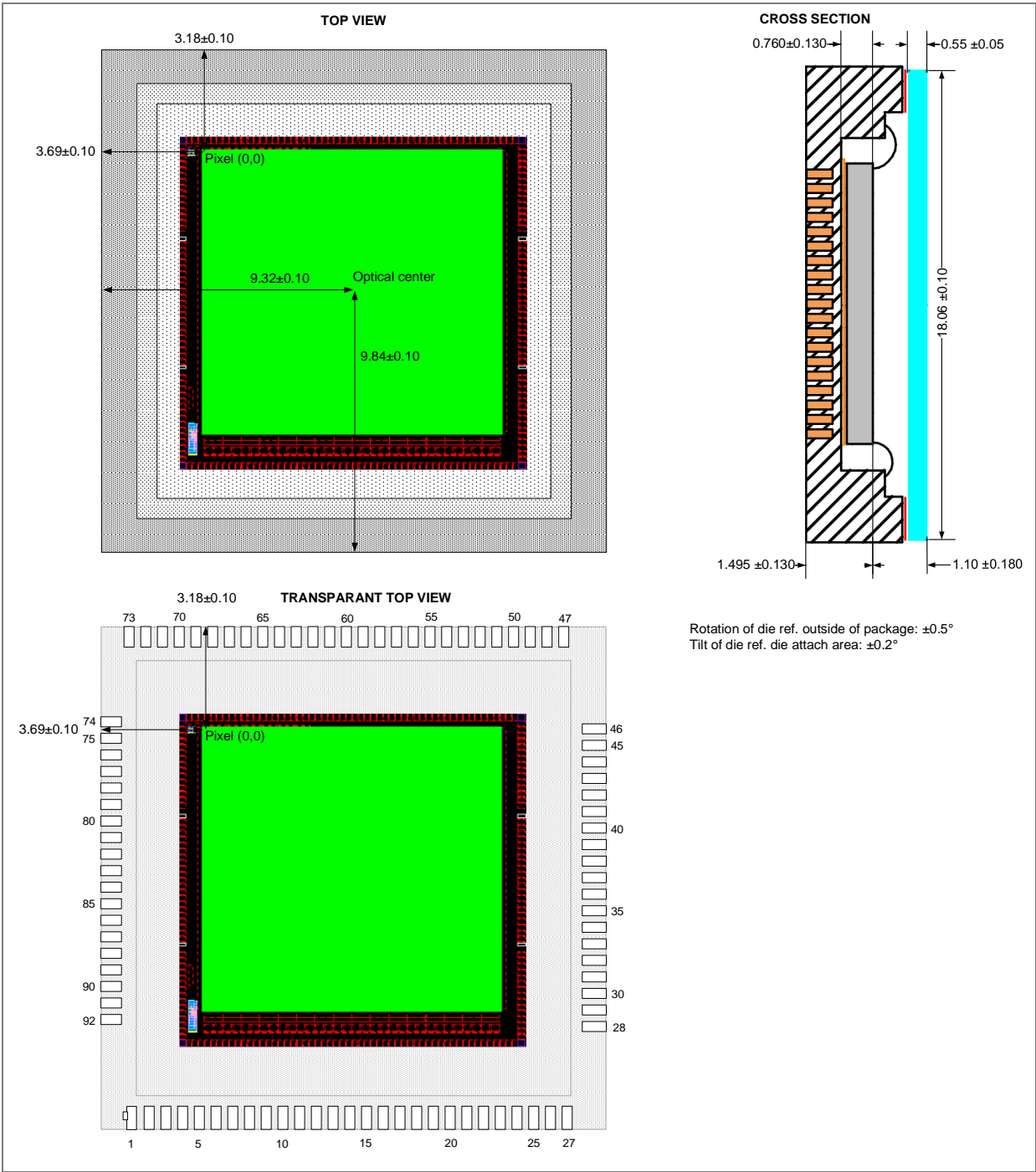




10.2.1 Assembly drawing LCC

All dimensions are in millimeter.

Figure 58: Assembly drawing LCC



## 11 Soldering & storage information

CMV4000 is shipped in a moisture barrier package. We recommend to keep the moisture barrier package closed and stored under the conditions shown in Table 5. Only open the moisture barrier package before the usage of the devices.

When reflow soldering, a dry bake needs to be performed upfront! For soldering information, follow Standard J-STD-020. If the temperature/time profile exceeds these recommendations, damage to the image sensor can occur.

### 11.1 Manual soldering

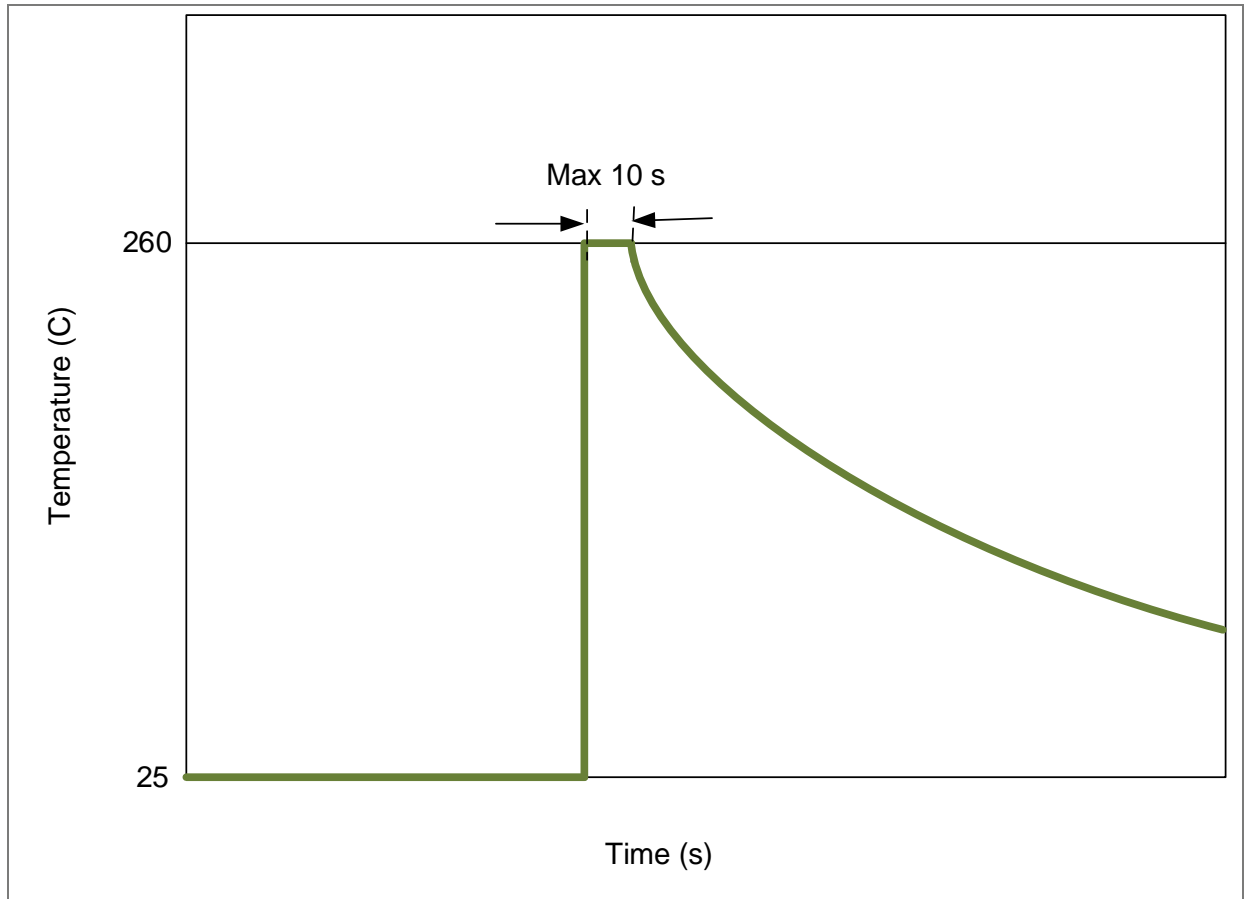
Use partial heating method and use a soldering iron with temperature control. The soldering iron tip temperature is not to exceed 350 °C with 270 °C maximum pin temperature, 2 seconds maximum duration per pin. Avoid global heating of the ceramic package during soldering. Failure to do so may alter device performance and reliability.

### 11.2 Wave soldering

Wave soldering is possible but not recommended. Solder dipping can cause damage to the glass and harm the imaging capability of the device. See Figure 59 for the wave soldering profile.



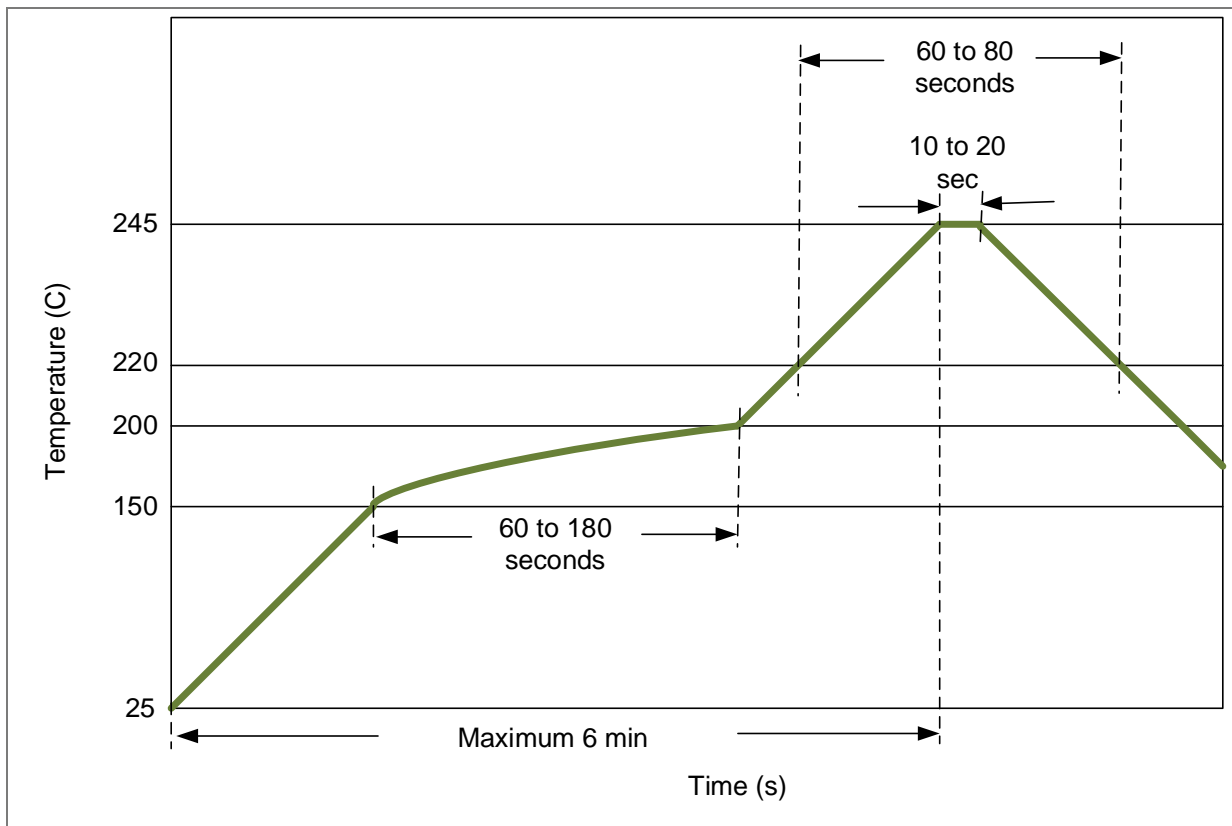
Figure 59: Wave solder profile



### 11.3 Reflow soldering

Figure 60 shows the maximum recommended thermal profile for a reflow soldering system. If the temperature/time profile exceeds these recommendations, damage to the image sensor can occur.

Figure 60: Reflow soldering graph



## 11.4 Additional recommendation

Image sensors with filter arrays (CFA) and micro-lens are especially sensitive to high temperatures. Prolonged heating at elevated temperatures may result in deterioration of the performance of the sensor. Best solution will be flow soldering or manual soldering of a socket (through hole) and plug in the sensor at latest stage of the assembly/test process.

# 12 Revision information

| Document status       | Product status  | Definition  |
|-----------------------|-----------------|---|
| Product Preview       | Pre-development | Information in this datasheet is based on product ideas in the planning phase of development. All specifications are design goals without any warranty and are subject to change without notice   |
| Preliminary Datasheet | Pre-production  | Information in this datasheet is based on products in the design, validation or qualification phase of development. The performance and parameters shown in this document are preliminary without any warranty and are subject to change without notice |
| Datasheet             | Production      | Information in this datasheet is based on products in ramp-up to full production or full production which conform to specifications in accordance with the terms of ams-OSRAM AG standard warranty as given in the General Terms of Trade               |

Other definitions

Draft / Preliminary:  
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- Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.
- Correction of typographical errors is not explicitly mentioned.

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